



MICROCHIP

PIC16C64

40-Pin EPROM-Based 8-Bit CMOS Microcontroller

FEATURES

High-performance RISC-like CPU

- Only 35 single word instructions to learn
- All single cycle instructions (200ns) except for program branches which are two-cycle
- Operating speed: DC - 20 MHz clock input
DC - 200ns instruction cycle
- 14-bit wide instructions and 8-bit wide data path
- 2048 x 14 on-chip EPROM program memory
- 128 x 8 general purpose registers (SRAM)
- Interrupt capability
- 33 special function hardware registers
- Eight-level deep hardware stack
- Direct, indirect and relative addressing modes

Peripheral Features

- 33 I/O pins with individual direction control
- High current sink/source for direct LED drive
- One pin that can be configured as capture input, PWM output, or compare output
 - Capture is 16-bit, max resolution 200ns
 - Compare is 16-bit, max resolution 200ns
 - PWM resolution is 1- to 10-bit. 8-bit resolution gives 80 KHz maximum frequency and 10-bit resolution gives 20 KHz maximum frequency
- TMR1: 16-bit timer/counter (time-base for capture/compare)
- TMR2: 8-bit timer/counter with 8-bit period register (time-base for PWM), prescaler and postscaler
- TMR0: 8-bit timer/counter with 8-bit programmable prescaler
- Parallel Slave Port (PSP): 8-bit wide, with external RD, WR and CS controls (microprocessor bus interface)
- Synchronous serial port (SSP) with two modes of operation:
 - 3-wire SPI
 - I²C™/ACCESS.bus™ compatible

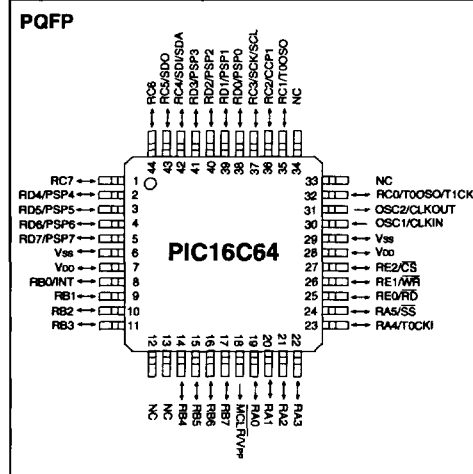
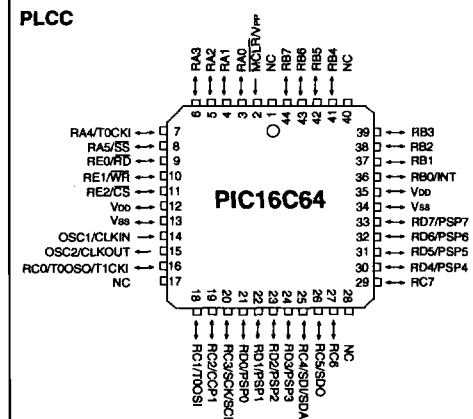
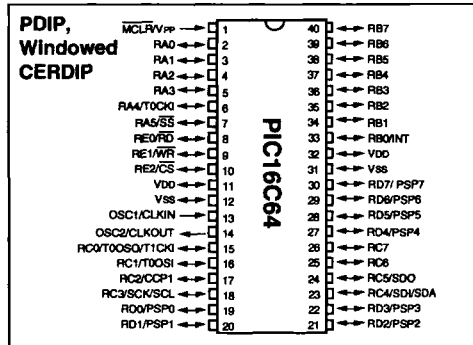
Special Microcontroller Features

- Power-On Reset (POR)
- Power-up Timer (PWRT)
- Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- Security EPROM fuses for code-protection
- Power saving SLEEP mode
- EPROM fuse selectable oscillator options: (RC oscillator, Standard crystal/resonator, High-speed crystal/resonator, Low frequency crystal)
- Serial in-system programming (via two pins)

CMOS Technology

- Low-power, high-speed CMOS EPROM technology
- Fully static design
- Wide-operating voltage range (2.5V to 6.0V)
- Commercial, Industrial, and Automotive Temp. Range
- Low-power consumption
 - < 2mA @ 5V, 4 MHz
 - 15µA typical @ 3V, 32 KHz
 - < 1µA typical standby current

PACKAGE TYPES



2

1.0 GENERAL DESCRIPTION

The PIC16C64 is the first 4-pin member of the versatile PIC16CXX family of low-cost, high-performance, CMOS, fully static, EPROM-based 8-bit microcontrollers.

All PIC16CXX microcontrollers employ an advanced RISC-like architecture. The PIC16CXX has enhanced core features, 8-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with the separate 8-bit wide data. The two stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance. PIC16CXX microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in its class.

The PIC16C64 has 128 bytes of RAM and 33 I/O pins. In addition, the PIC16C64 adds several peripheral features useful in many high performance applications including; three timer/counters, capture, compare, PWM features and serial ports. The synchronous serial port can be configured as either a 3-wire SPI or I²C. An 8-bit Parallel slave port is also provided.

The PIC16C64 has special features which reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low-cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for High-Speed crystals. The SLEEP (power-down) mode offers power saving. The user can wake up the chip from SLEEP through several external and internal interrupts and reset.

A highly reliable watchdog timer with its own on-chip RC oscillator provides protection against software malfunction.

A UV-erasable cerdip-packaged version is ideal for code development while the cost-effective One Time Programmable (OTP) version is suitable for production in any volume.

Table 1-1 shows the features of the PIC16C64 as well as the other members of the PIC16CXX enhanced core family.

A simplified block diagram of the PIC16C64 is shown in Figure 3-1.

The PIC16C64 fits perfectly in applications ranging from high speed automotive and appliance motor control to low-power remote sensors, keyboards and telecom processors. The EPROM technology makes customization of application programs (transmitter codes, motor speeds, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages for through hole or surface mounting make this microcontroller series perfect for all applications with space limitations. Low-cost, low-power, high performance, ease of use and I/O flexibility make the PIC16C64 very versatile even in areas where no microcontroller use has been considered before (e.g. timer functions, replacement of "glue" logic in larger systems, co-processor applications).

1.1 Family and Upward Compatibility

Those users familiar with the PIC16C5X family of microcontrollers will realize that this is an enhanced version of the PIC16C5X architecture. Please refer to Appendix A for a detailed list of modifications. Code written for PIC16C5X can be easily ported to PIC16CXX family of devices (see Appendix B).

1.2 Development Support

The PIC16CXX family is supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a low-cost development programmer and a production quality programmer. A "C" compiler and fuzzy logic support tools are in development.

TABLE 1-1: PIC16CXX FAMILY OF DEVICES

		PIC16C74†	PIC16C64	PIC16C71†	PIC16C84†
Maximum Frequency of Operation		20 MHz	20 MHz	16 MHz	10 MHz
Program Memory (14-bit wide)	EPROM	4K	2K	1K	-
	EEPROM	-	-	-	1K
Data Memory (bytes)		192	128	36	36
Data EEPROM (bytes)		-	-	-	64
Timer 0 (8-bit + 8-bit prescaler)		Yes	Yes	Yes	Yes
Timer 1 (16-bit)		Yes	Yes	-	-
Timer 2 (8-bit)		Yes	Yes	-	-
Capture/Compare/PWM Module(s)		2	1	-	-
Synchronous Serial Port (SPI/I ² C)		Yes	Yes	-	-
Serial Communications Interface (USART)		Yes	-	-	-
Parallel Slave Port		Yes	Yes	-	-
Analog to Digital Converter (8-bit)		8 ch.	-	4 ch.	-
Power On Reset		Yes	Yes	Yes	Yes
Watchdog Timer		Yes	Yes	Yes	Yes
External Interrupts		Yes	Yes	Yes	Yes
Interrupt Sources		12	6	4	4
Program Memory Code Protect		Yes	Yes	Yes	Yes
I/O		33	33	13	13
I/O High Current Capability	Source	25mA	25mA	20mA	20mA
	Sink	25mA	25mA	25mA	25mA
Package Types		40-pin DIP, 44-pin PLCC, 44-pin PQFP	40-pin DIP, 44-pin PLCC, 44-pin PQFP	18-pin DIP 18-pin SOIC	18-pin DIP 18-pin SOIC

† For information on these devices please refer to their respective data sheets.



2.0 PIC16C64 DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements the proper device option can be selected using the information and tables in this section. When placing orders, please use the "PIC16C64 Product Identification System" on the back page of this data sheet to specify the correct part number.

2.1 UV Erasable Devices

The UV erasable version, offered in cerdip package is optimal for prototype development and pilot programs.

The UV erasable version can be erased and reprogrammed to any of the oscillator modes etc. Microchip's PICSTART™ and PRO MATE™ programmers supports programming of the PIC16C64.

2.2 One-Time-Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers expecting frequent code changes and updates.

The OTP devices, packaged in plastic packages permit the user to program them once. In addition to the program memory, the configuration fuses must be programmed.

2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who chose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and fuse options already programmed by the factory. Certain code and prototype verification procedures do apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

2.4 Serialized Quick-Turnaround-Production (SQTP) Devices

Microchip offers the unique programming service where a few user defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password or ID number.

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXX uses a Harvard architecture, in which, program and data are accessed from separate memories. This improves bandwidth over traditional Von-Neuman architecture where program and data are fetched from the same memory. Separating program and data memory further allows instructions to be sized differently than 8-bit wide data word. Instruction op-codes are 14-bit wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions (see Figure 3-1). Consequently, all instructions (35) execute in a single cycle (200ns @ 20 MHz) except for program branches.

The PIC16C64 addresses 2K x 14 program memory space, all on-chip. Program execution in microcontroller mode is internal only.

The PIC16CXX can directly or indirectly address its register files or data memory. All special function registers including the program counter are mapped in the data memory. The PIC16CXX has a fairly orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16CXX simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC16CXX device contains an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bit wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow out bit in subtraction. See the SUBLW and SUBWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with a description of the device pins in Table 3-1.

PIC16C64

TABLE 3-1: PIC16C64 PINOUT DESCRIPTION

Pin						
Name	DIP No.	PLCC No.	PQFP No.	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	13	14	30	I	CMOS	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	14	15	31	O	—	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/VPP	1	2	18	I/P	ST	Master clear (reset) input/programming voltage input. This pin is an active low reset to the device.
RA0	2	3	19	I/O	TTL	PORTA is a bidirectional I/O port. Can also be selected to be the clock input to the TMR0 timer/counter. Output is open collector type. Can also be the slave select for the synchronous serial port.
RA1	3	4	20	I/O	TTL	
RA2	4	5	21	I/O	TTL	
RA3	5	6	22	I/O	TTL	
RA4/T0CKI	6	7	23	I/O	ST	
RA5/SS	7	8	24	I/O	TTL	
RB0/INT	33	36	8	I/O	TTL/ST†	PORTB is a bidirectional I/O port. Port B can be software programmed for internal weak pull-up on all inputs. RB0/INT can also be selected as an external interrupt pin. Interrupt on change pin. Interrupt on change pin. Interrupt on change pin. Serial programming clock. Interrupt on change pin. Serial programming data.
RB1	34	37	9	I/O	TTL	
RB2	35	38	10	I/O	TTL	
RB3	36	39	11	I/O	TTL	
RB4	37	41	14	I/O	TTL	
RB5	38	42	15	I/O	TTL	
RB6	39	43	16	I/O	TTL/ST‡	
RB7	40	44	17	I/O	TTL/ST‡	
RC0/T0OSO/T1CKI	15	16	32	I/O	ST	PORTC is a bidirectional I/O port. RC0/T1CKI can also be selected as a Timer1 clock/oscillator input. RC1/T1CKO can also be selected as a Timer1 oscillator output. RC2/CCP1 can also be selected as a capture1 input/compare1 output/PWM1 output. RC3/SCK/SCL can also be selected as the synchronous serial clock for both SPI and I ² C modes. RC4/SDI/SDA can also be selected as the SPI Data In (SPI mode) or data I/O (I ² C mode). RC5/SDO can also be selected as the SPI Data Out (SPI mode).
RC1/T0OSI	16	18	35	I/O	ST	
RC2/CCP1	17	19	36	I/O	ST	
RC3/SCK/SCL	18	20	37	I/O	ST	
RC4/SDI/SDA	23	25	42	I/O	ST	
RC5/SDO	24	26	43	I/O	ST	
RC6	25	27	44	I/O	ST	
RC7	26	29	1	I/O	ST	

Legend: I = input, O = output, I/O = input/output, P = power;
 — = Not used, TTL = TTL input, ST = Schmitt trigger input

(Cont.)

† This buffer is a Schmitt trigger input when configured as the external interrupt.

‡ This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 3-1: PIC16C64 PINOUT DESCRIPTION (CONT.)

Pin						
Name	DIP No.	PLCC No.	PQFP No.	I/O/P Type	Buffer Type	Description
RD0/PSP0	19	21	38	I/O	ST/TTL§	PORTD is a bidirectional I/O port or parallel slave port for interfacing to a microprocessor bus.
RD1/PSP1	20	22	39	I/O	ST/TTL§	
RD2/PSP2	21	23	40	I/O	ST/TTL§	
RD3/PSP3	22	24	41	I/O	ST/TTL§	
RD4/PSP4	27	30	2	I/O	ST/TTL§	
RD5/PSP5	28	31	3	I/O	ST/TTL§	
RD6/PSP6	29	32	4	I/O	ST/TTL§	
RD7/PSP7	30	33	5	I/O	ST/TTL§	
RE0/RD	8	9	25	I/O	ST/TTL§	Bidirectional I/O pin or read control for parallel slave port.
RE1/WR	9	10	26	I/O	ST/TTL§	Bidirectional I/O pin or write control for parallel slave port.
RE2/CS	10	11	27	I/O	ST/TTL§	Bidirectional I/O pin or select control for parallel slave port.
Vss	12,31	13,34	6,29	P	—	Ground reference for logic and I/O pins.
Vdd	11,32	12,35	7,28	P	—	Positive supply for logic and I/O pins.
NC	—	1,17 28,40	12,13 33,34		—	These pins are not internally connected. These pins should be left unconnected.

Legend: I = input, O = output, I/O = input/output, P = power;
 — = Not used, TTL = TTL input, ST = Schmitt trigger input

§ This buffer is a Schmitt trigger input when configured as general purpose I/O and a TTL input when used in the parallel slave port mode (for interfacing to a microprocessor bus).

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3.1 Clocking Scheme/Instruction Cycle

The clock input (from pin OSC1) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3 and Q4. Internally, the PC is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 3-2.

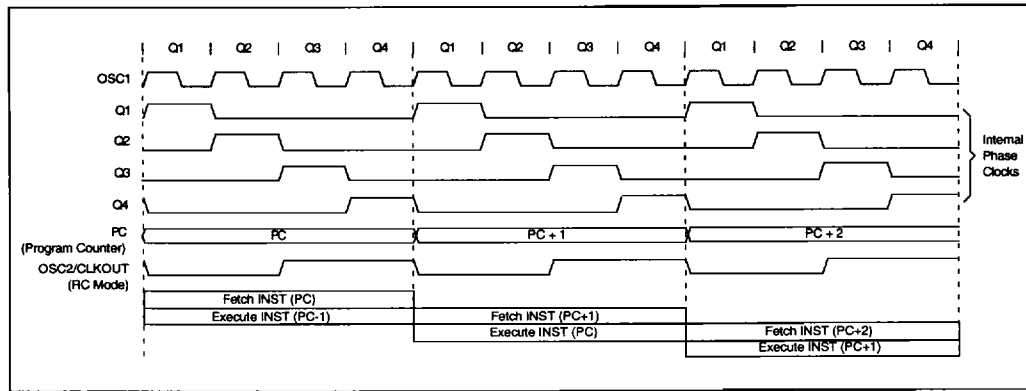
3.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g. GOTO) then two cycles are required to complete the instruction (see Example 3-1).

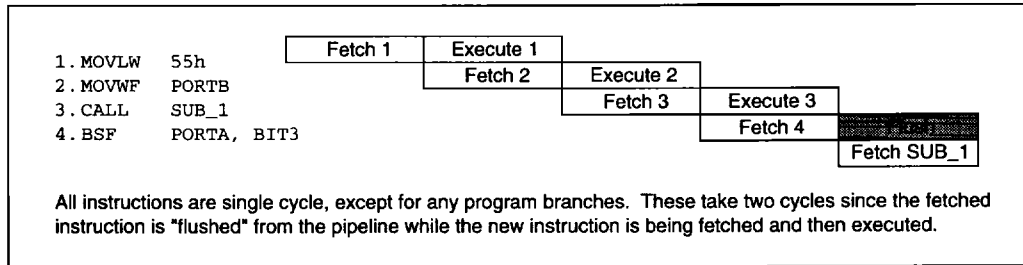
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register (IR)" in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-2: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW

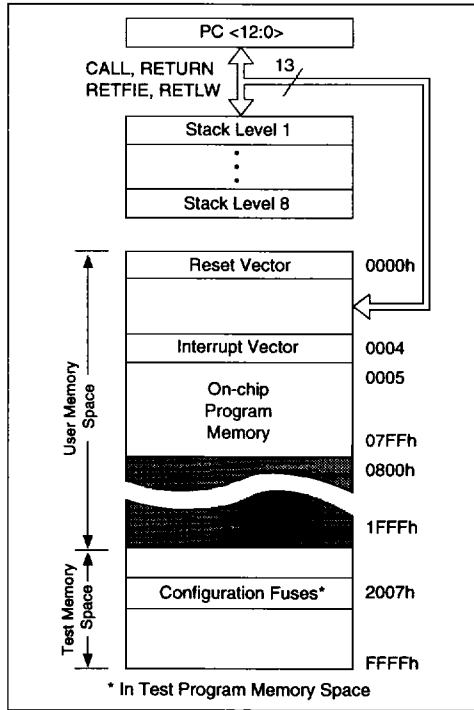


4.0 MEMORY ORGANIZATION

4.1 Program Memory Organization

The PIC16C64 has a 13-bit program counter capable of addressing an 8K x 14 program memory space. Only the first 2K x 14 (0000h - 07FFh) are physically implemented. Accessing a location above 7FFh will cause a wrap-around within the first 2K x 14 space. The reset vector is at 0000h and the interrupt vector is at 0004h (see Figure 4-1).

FIGURE 4-1: PROGRAM MEMORY MAP AND STACK



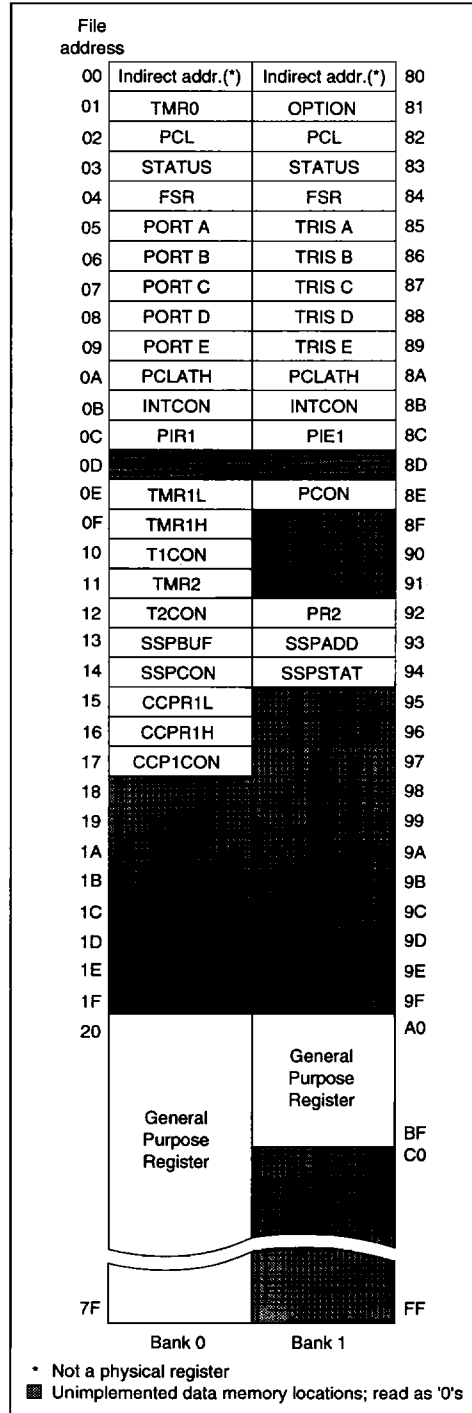
4.2 Data Memory Organization

The data memory (see Figure 4-2) is composed of the general purpose register file and the special registers. The data memory extends up to 7Fh. The first 32 locations are used to map special function registers. Locations 20h - 7Fh (Bank 0) and A0h-BFh (Bank 1) are general purpose registers implemented as static RAM. There are two register file page select bits in the STATUS register allowing selection from up to four Banks. Some special function registers are mapped in Bank 1.

4.2.1 GENERAL PURPOSE REGISTER FILE

The register file, in PIC16C64 is organized as 128 x 8. It is accessed either directly or indirectly through the file select register FSR.

FIGURE 4-2: REGISTER FILE MAP



PIC16C64

4.2.2 SPECIAL FUNCTION REGISTERS:

The special function registers are registers used by the CPU and Peripheral functions for controlling the desired operation of the device (see Table 4-1). These registers are static RAM.

The special registers can be classified into two sets. The special registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

TABLE 4-1: SPECIAL REGISTERS FOR THE PIC16C64

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bank 0									
00†	INDF (Indirect Address)	Addressing this location uses contents of FSR to address data memory (not a physical register)							
01	TMR0	Timer0							
02†	PCL	Program Counter's (PC's) Least Significant Byte							
03†	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	C
04†	FSR	Indirect data memory address pointer							
05	PORTA	PortA Data Latch where written to PortA pins when read							
06	PORTB	PortB Data Latch where written to PortB pins when read							
07	PORTC	PortC Data Latch where written to PortC pins when read							
08	PORTD	PortD Data Latch where written to PortD pins when read							
09	PORTE	PortE Data Latch where written to PortE pins when read							
0A†	PCLATH	Buffered Register for the upper 5 bits of the Program Counter (PC)							
0B†	INTCON	GIE	PEIE	RTIE	INTE	RBIE	RTIF	INTF	RBIF
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
0D	Reserved								
0E	TMR1L	Timer1 Least Significant Byte							
0F	TMR1H	Timer1 Most Significant Byte							
10	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1INSYNC	TMR1CS	TMR1ON
11	TMR2	Timer2							
12	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
13	SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register							
14	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0
15	CCPR1L	Capture/Compare/Duty Cycle Register (LSB)							
16	CCPR1H	Capture/Compare/Duty Cycle Register (MSB)							
17	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0
Bank 1									
80†	INDF (Indirect Address)	Addressing this location uses contents of FSR to address data memory (not a physical register)							
81	OPTION	RBPU	INTEDG	RTS	RTE	PSA	PS2	PS1	PS0
82†	PCL	Program Counter's (PC's) Least Significant Byte							
83†	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	C
84†	FSR	Indirect data memory address pointer							
85	TRISA	PortA Data Direction Register							
86	TRISB	PortB Data Direction Register							
87	TRISC	PortC Data Direction Register							
88	TRISD	PortD Data Direction Register							
89	TRISE	IBF	OBF	IBOV	PSPMODE	—	TRISE2	TRISE1	TRISE0
8A†	PCLATH	Shadow Register for the upper 5 bits of the Program Counter (PC)							
8B†	INTCON	GIE	PEIE	RTIE	INTE	RBIE	RTIF	INTF	RBIF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
8D	Reserved								
8E	PCON	—	—	—	—	—	—	POR	—
8F	Reserved								
90	Reserved								
91	Reserved								
92	PR2	Timer2 Period Register							
93	SSPADD	Synchronous Serial Port (I ² C mode) Address Register							
94	SSPSTAT	—	—	D/A	P	S	R/W	UA	BF
95	Reserved								
96	Reserved								
97	Reserved								

Legend — = Unimplemented locations, Read as '0'
 † These registers can be addressed from either bank.

4.2.2.1 STATUS Register

The STATUS register contains the arithmetic status of the ALU, the RESET status, and the page preselect bits for data memory.

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the logic.

Furthermore, TO and PD bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

Forexample, CLRF STATUS will clear the upper three bits and set the Z bit. This leaves the status register as 000UU1UU (where U = unchanged).

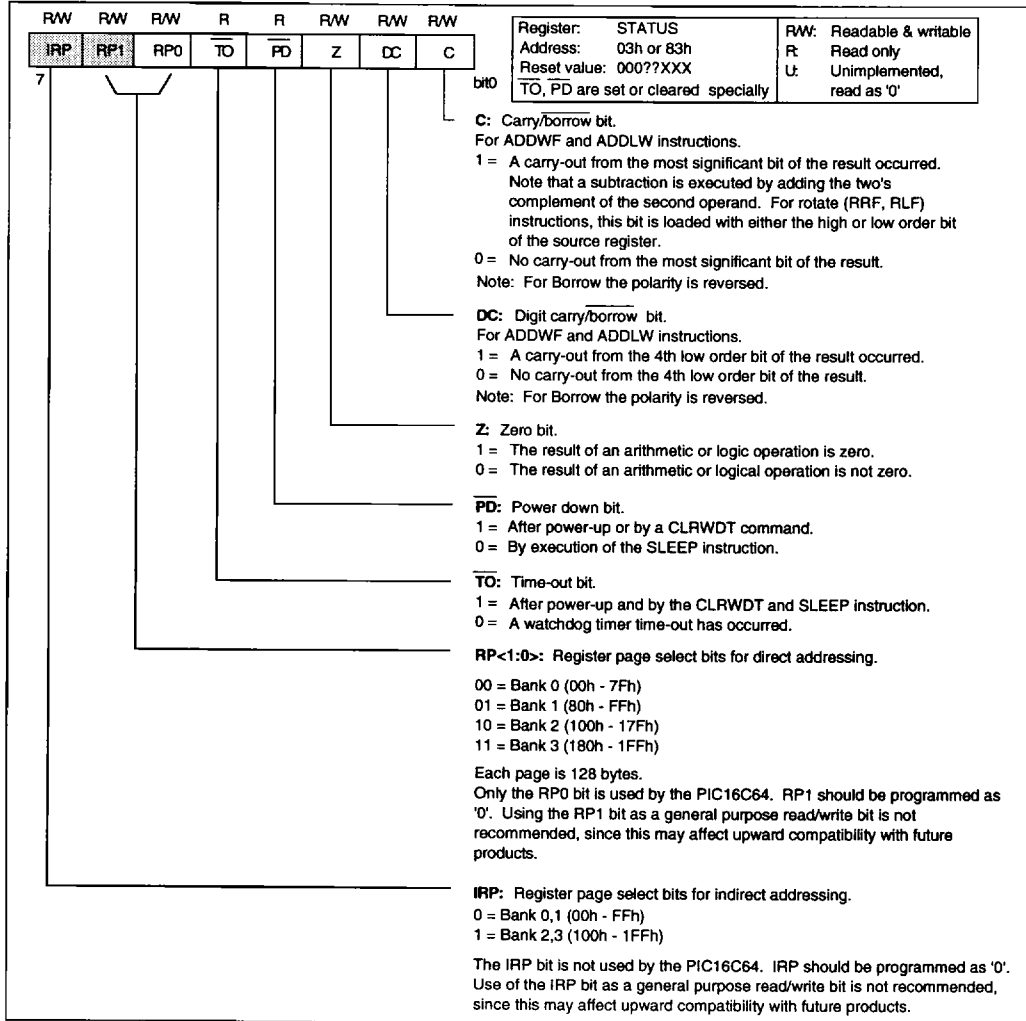
It is recommended, therefore, that only BCF, BSF and MOVWF instructions are used to alter the status registers because these instructions do not affect any status bit. For other instructions, affecting any status bits, see the "Instruction Set Summary".

Note 1: The IRP and RP1 bits (STATUS<7:6>) are not used by the PIC16C64 and should be programmed as '0'. Use of these bits as general purpose R/W bits is NOT recommended, since this may affect upward compatibility with future products.

Note 2: The C and DC bits operate as a borrow out bit in subtraction. See the SUBLW and SUBWF instructions for examples.

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FIGURE 4-3: STATUS REGISTER

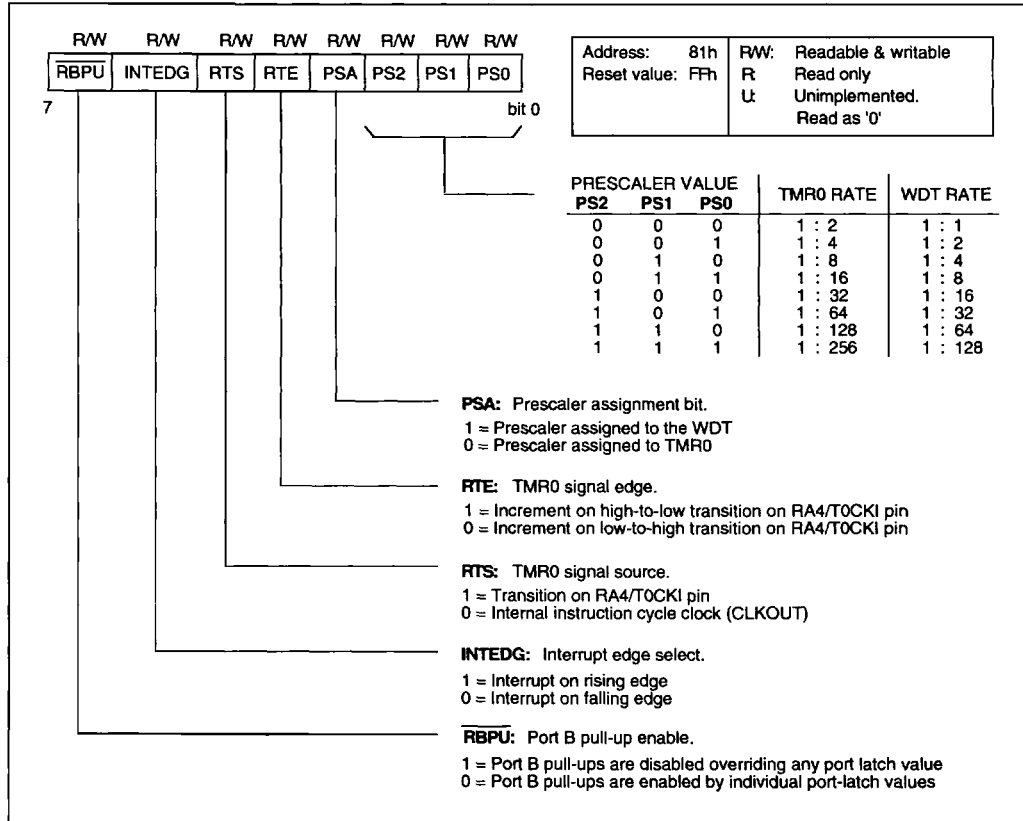


PIC16C64

4.2.2.2 OPTION Register

The OPTION register (address 81h) is a readable and writable register which contains various control bits to configure the prescaler, the external INT interrupt, TMR0, and the weak pull-ups on PORTB.

FIGURE 4-4: OPTION REGISTER



4.2.2.3 INTCON Register

The PIC16C64 has eight sources of interrupt:

- External interrupt from RB0/INT pin
- Timer0 overflow
- Interrupt on change on RB<7:4> pins
- Timer1 overflow
- Timer2 matches period register
- A capture, a compare, or a PWM output is reset
- The synchronous serial port
- The parallel slave port read/write

The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global enable bits. The peripheral interrupt flags reside in the PIR1 register (Addr 0Ch).

A global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding mask bit in INTCON register (Figure 4-5). GIE is cleared on reset.

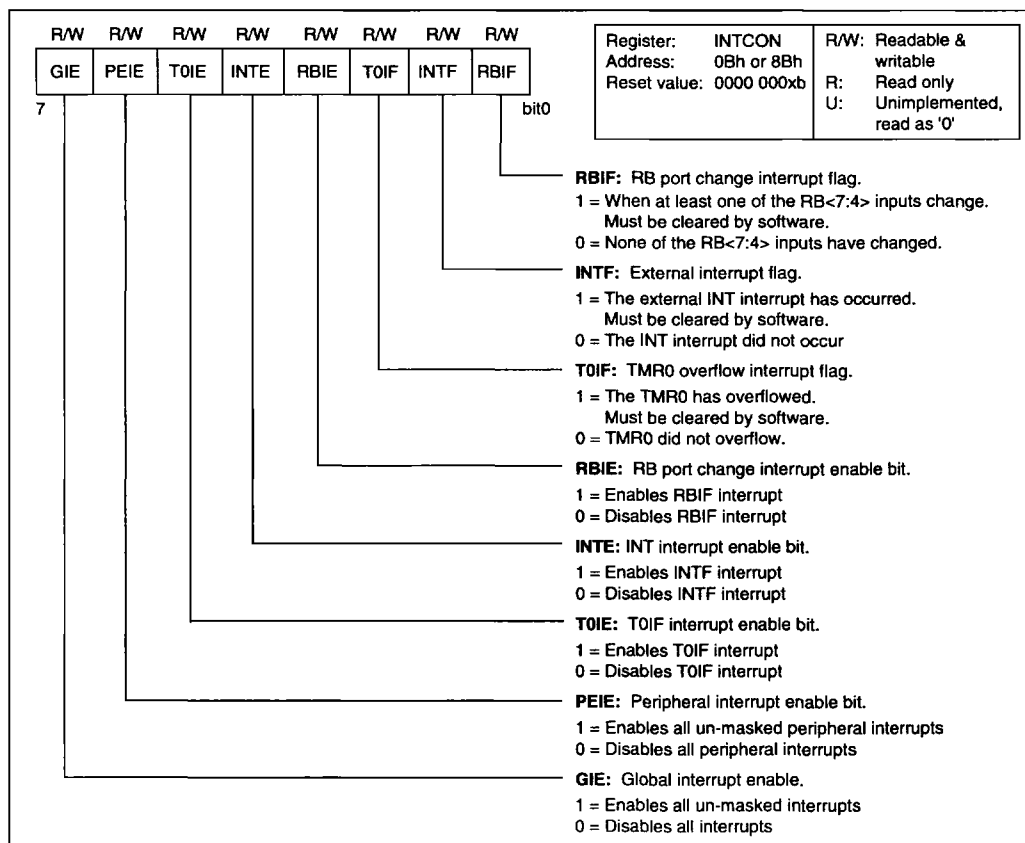
When an interrupt is responded to, the GIE is cleared to disable any further interrupt, the return address is pushed into the stack and the PC is loaded with 0004h. For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be 3-4 instruction cycles. The exact latency depends when the interrupt event occurs (see Figure 12-15). The latency is the same for 1 or 2 cycle instructions. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid infinite interrupt requests. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

The "return from interrupt" instruction, RETFIE, exits interrupt routine as well as sets the GIE bit to re-enable interrupts.



Note: The TOIF, INTF, or RBIF will be set by the specified condition even if the corresponding Interrupt Enable Bit is cleared (interrupt disabled) or the GIE bit is cleared (all interrupts disabled).

FIGURE 4-5: INTCON REGISTER

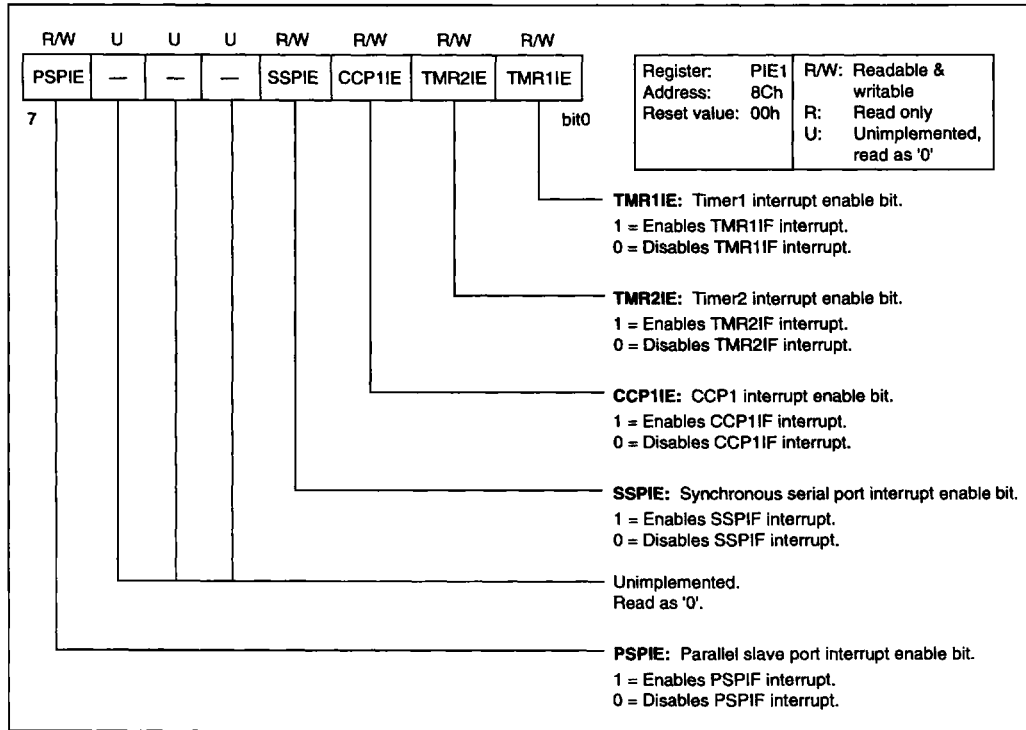


PIC16C64

4.2.2.4 PIE1 Register

This register contains the individual enable bits for the Peripheral Interrupts.

FIGURE 4-6: PIE1 REGISTER

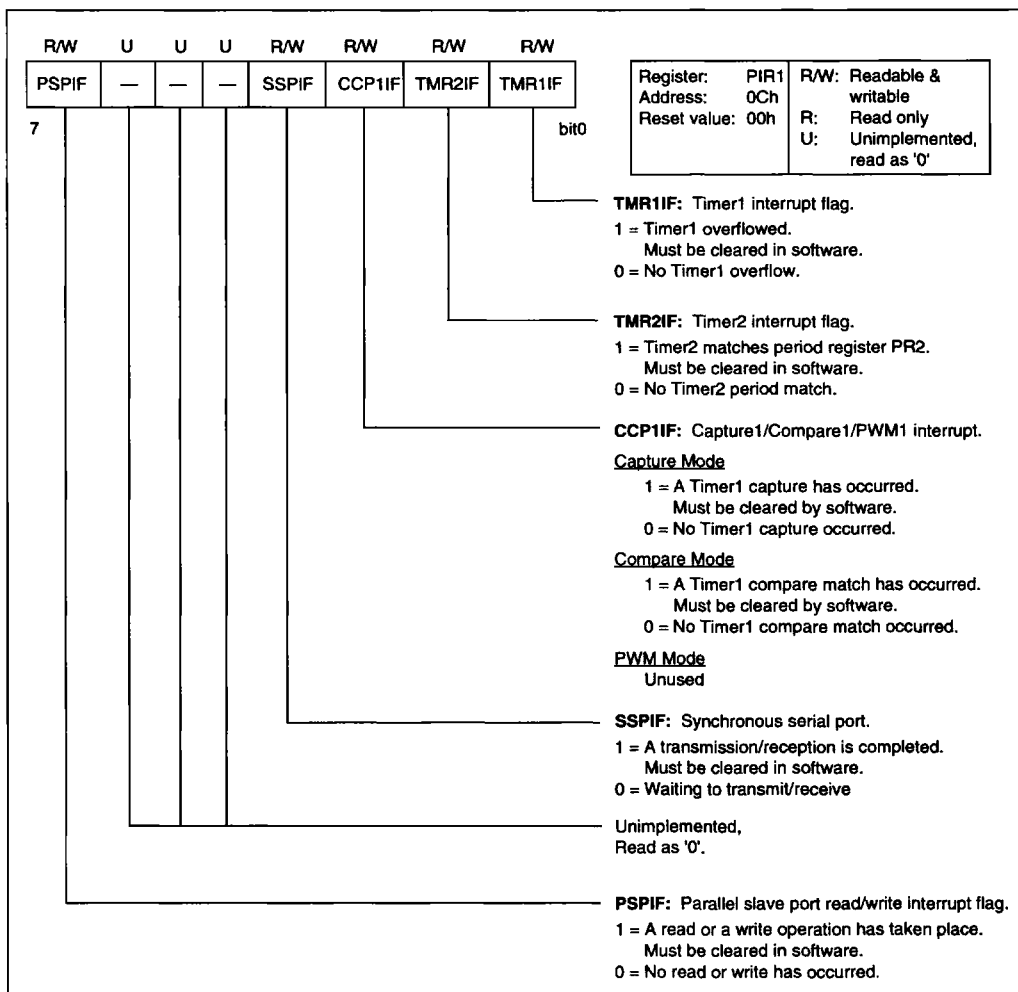


4.2.2.5 PIR1 Register

This register contains the individual flag bit for the Peripheral Interrupts.

Note: These bits will be set by the specified condition, even if the corresponding Interrupt Enable bit is cleared (interrupt disabled) or the GIE bit is cleared (all interrupts disabled). Before enabling an interrupt, the user may wish to clear the interrupt flag, to ensure that the program does not immediately branch to the Peripheral Interrupt service routine.

FIGURE 4-7: PIR1 REGISTER

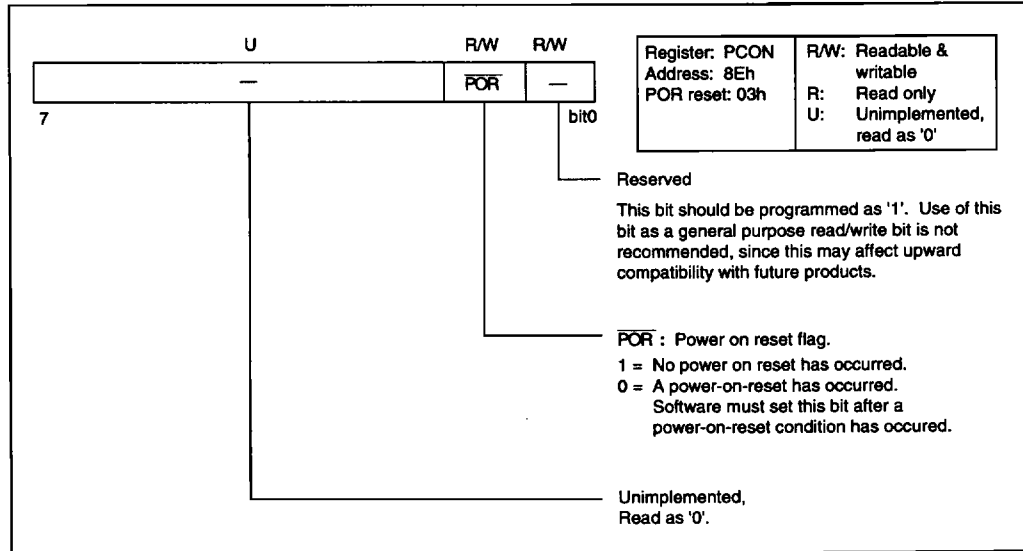


PIC16C64

4.2.2.6 PCON Register

The PCON register contains flag bits to allow differentiation between a Power-On Reset to an external MCLR reset, WDT reset.

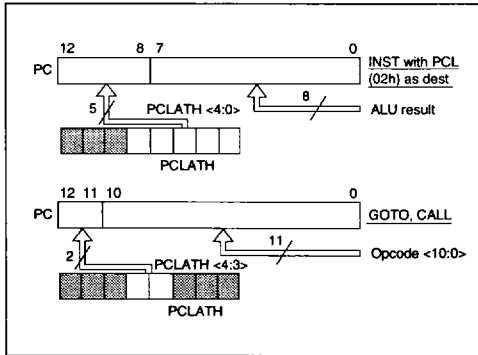
FIGURE 4-8: PCON REGISTER



4.3 PCL and PCLATH

The program counter (PC) is 13-bit wide. The low byte, PCL is a readable and writable register (02h or 82h). The high byte of the PC, PCH is not directly readable or writable. The high byte of the PC can be written through the PCLATH register (0Ah or 8Ah). When the PC is loaded with a new value during a CALL, GOTO or a write to PCL, the high bits of PC are loaded from PCLATH, as shown in Figure 4-9.

FIGURE 4-9: LOADING OF PC IN DIFFERENT SITUATIONS



4.3.1 COMPUTED GOTO

When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to "Table Read Using the PIC16CXX" (AN556).

4.3.2 Stack

The PIC16CXX has an 8-deep x 13-bit wide hardware stack (see Figure 4-1). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is pushed in the stack when a CALL instruction is executed or an interrupt is acknowledged. The stack is popped in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a "PUSH" or a "POP" operation.

The stack operates as a circular buffer. This means that after the stack has been "PUSHed" eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on). This means that the user can implement "software resets" for the system.

Note: There are no STATUS bits to indicate stack overflows or stack underflow conditions.

PIC16C64

4.4 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause an indirect addressing.

Indirect addressing is possible by using file address 00h. Any instruction using the INDF register, actually accesses data pointed to by the file select register (FSR). Reading INDF itself indirectly will produce 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-10. However, IRP is not used in the PIC16C64.

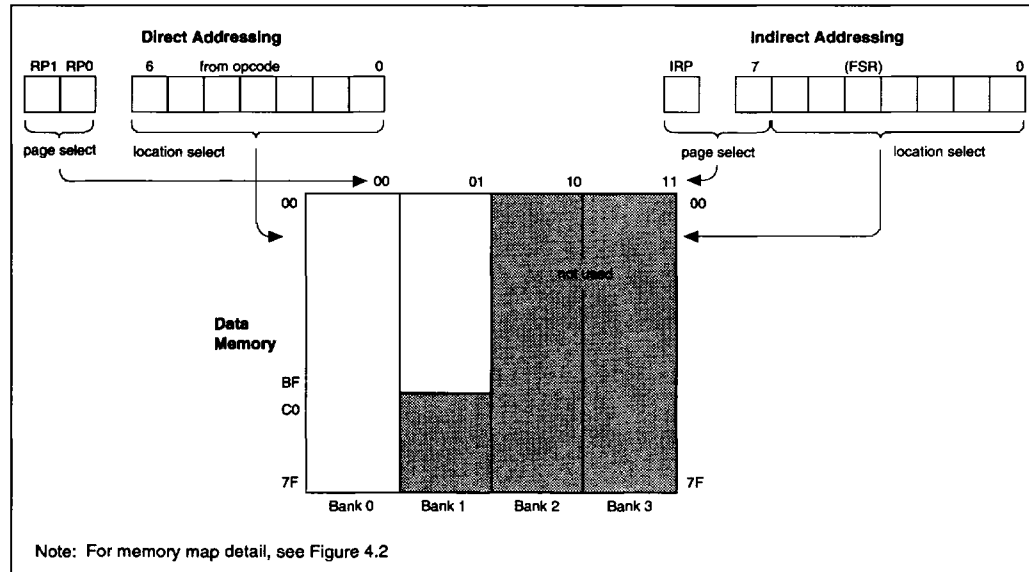
A simple program to clear RAM location 20h-2Fh using indirect addressing is shown in Example 4-1.

EXAMPLE 4-1: INDIRECT ADDRESSING

```

movlw    0x20    ;initialize pointer
movwf    FSR     ;to RAM
NEXT     clrfs   INDF ;clear indent by
         incrf   FSR  ;inc pointer
         btfs   FSR.4 ;all done?
         goto   NEXT ;no clear next
CONTINUE:                ;yes continue
    
```

FIGURE 4-10: DIRECT/INDIRECT ADDRESSING



5.0 I/O PORTS

The PIC16C64 has five ports, PORTA through PORTE. These ports pins may be multiplexed with an alternate function for the peripheral features on the device.

5.1 PORTA and TRISA Registers

PORTA is a 6-bit wide latch. RA4 is a Schmitt trigger input and an open collector output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRISA registers) which can configure these pins as output or input.

A '1' in the TRISA register configures the corresponding port pin as input.

Port RA4 is multiplexed with TMR0 clock input.

Reading PORTA register reads the status of the pins, whereas writing to it will write to the port latch.

EXAMPLE 5-1: INITIALIZING PORTA

```
BSF STATUS, RP0;Select Bank1
MOVLW 0xCF ;Value used to initialize
;data direction
MOVWF TRISA ;Set RA<3:0> as inputs
; RA<5:4> as outputs
;TRISA<7:6> are always
;read as '0'.
```

FIGURE 5-1: BLOCK DIAGRAM OF PORT PINS RA<3:0> and RA<5>

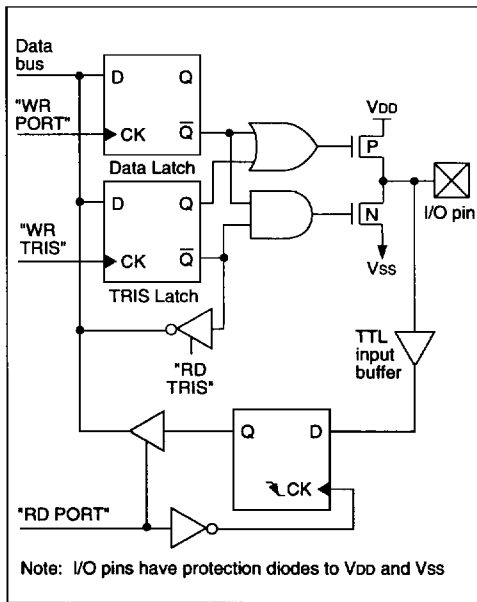


FIGURE 5-2: BLOCK DIAGRAM OF RA4 PIN

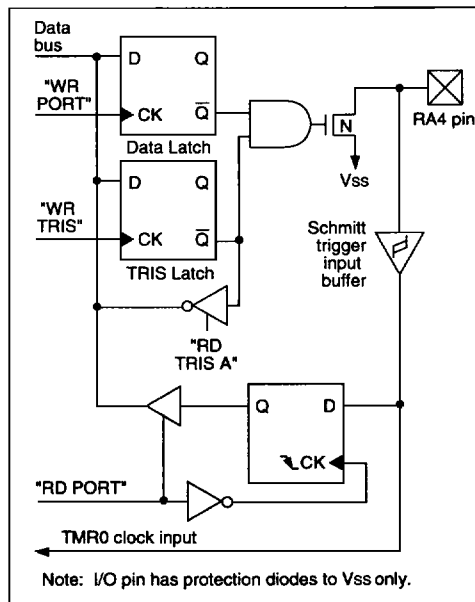


TABLE 5-1: PORTA FUNCTIONS

Name	Bit	Buffer Type	Function
RA0	bit0	TTL	Input/output
RA1	bit1	TTL	Input/output
RA2	bit2	TTL	Input/output
RA3	bit3	TTL	Input/output
RA4/T0CKI	bit4	ST	Input/output or external clock input for TMR0. Output is open collector type
RA5/SS	bit5	TTL	Input/output or slave select input for synchronous serial port

Legend: TTL = TTL input, ST = Schmitt trigger input

TABLE 5-2: SUMMARY OF PORTA REGISTERS

Register Name	Function	Address	Power-on Reset Value
PORTA	PORTA pins when read PORTA latch when written	05h	--XX XXXX
TRISA	PORTA data direction register 0 = output, 1 = input	85h	--11 1111

Notes: 1: x = unknown, - = unimplemented, reads as a '0'.

2: For reset values of registers in other reset situations refer to Table 12-6.

5.2 PORTB and TRISB Registers

PORTB is an 8-bit wide bidirectional port (file register address 06h). The corresponding data direction register is TRISB (address 86h). A '1' in TRISB configures the corresponding port pin as an input. Reading PORTB register reads the status of the pins whereas writing to it will write to the port latch.

Each of the PORTB pins has a weak internal pull-up (~100 μ A typical). A single control bit can turn on all the pull-ups. This is done by clearing the RBPU (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on power-on reset.

Four of PORTB's pins, RB<7:4>, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e. any RB7-RB4 pin configured as an output is excluded from the interrupt on change comparison). On every instruction cycle, the input pins (of RB7-RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7-RB4 are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>).

This interrupt can wake the device up from SLEEP. The user, in the interrupt service routine, can clear the interrupt in one of two ways:

- a) Disable the interrupt by clearing RBIE (INTCON<3>) bit.
- b) Read PORTB. This will end mismatch condition. Then, clear RBIF bit.

A mismatch condition will continue to set the RBIF bit. Reading PORTB will end the mismatch condition, and allow the RBIF bit to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552 in the *Embedded Control Handbook*).

2

Note: If a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may not be set.

FIGURE 5-3: BLOCK DIAGRAM OF PORT PINS RB<7:4>

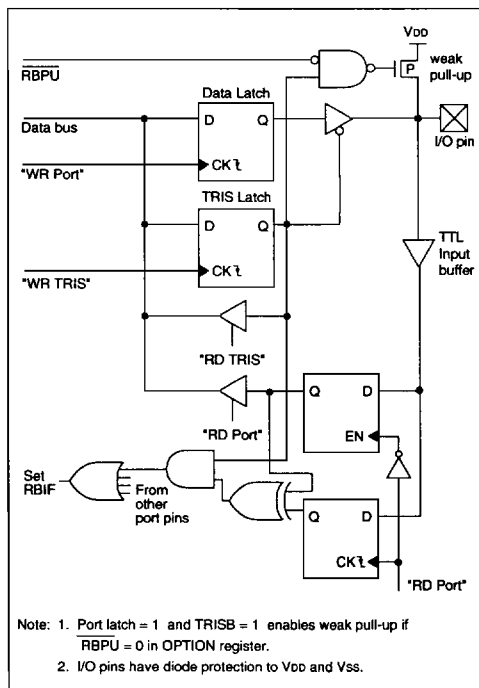


FIGURE 5-4: BLOCK DIAGRAM OF PORT PINS RB<3:0>

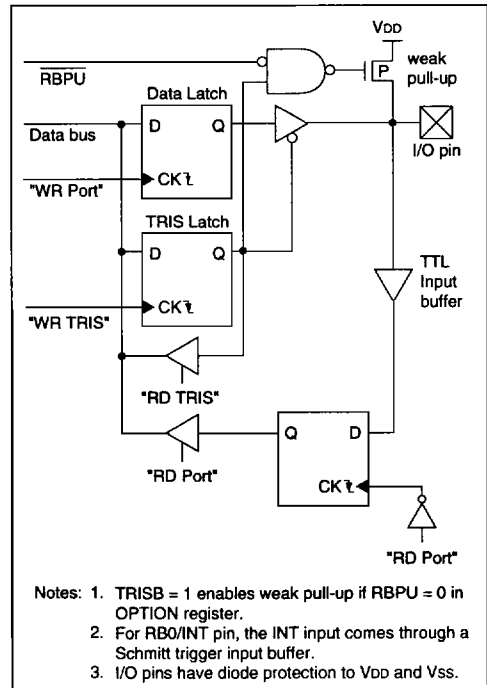


TABLE 5-3: PORTB FUNCTIONS

Name	Bit	Buffer Type	Function
RB0/INT	bit0	TTL/ST†	Input/output pin or external interrupt input. Internal software programmable weak pull-up
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up
RB3	bit3	TTL	Input/output pin. Internal software programmable weak pull-up
RB4	bit4	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up
RB5	bit5	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up
RB6	bit6	TTL/ST‡	Input/output pin (with interrupt on change). Internal software programmable weak pull-up
RB7	bit7	TTL/ST‡	Input/output pin (with interrupt on change). Internal software programmable weak pull-up

Legend: TTL = TTL input, ST = Schmitt Trigger

† This buffer is a Schmitt trigger input when configured as the external interrupt.

‡ This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 5-4: SUMMARY OF PORTB REGISTERS

Register Name	Function	Address	Power-on Reset Value
PORTB	PORTB pins when read PORTB latch when written	06h	XXXX XXXX
TRISB	PORTB data direction register 0 = output, 1 = input	86h	1111 1111
OPTION	Weak pull-up on/off control (RBPU bit)	81h	1111 1111

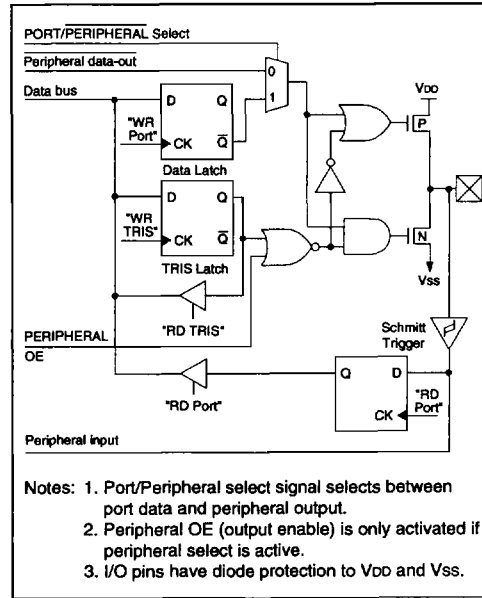
5.3 PORTC and TRISC Registers

I/O PORTC is an 8-bit bidirectional port. Each pin is individually configurable as input and output through the TRISC register. PORTC is multiplexed with several peripheral functions (see Table 5-5). PORTC pins have Schmitt trigger input buffers.

EXAMPLE 5-2: INITIALIZING PORTC

```
BSF STATUS, RP0;Select Bank1
MOVLW 0xCF ;Value used to initialize
;data direction
MOVWF TRISC ;Set RC<3:0> as inputs
; RC<5:4> as outputs
; RC<7:6> as inputs
```

FIGURE 5-5: PORTC BLOCK DIAGRAM



- Notes: 1. Port/Peripheral select signal selects between port data and peripheral output.
- 2. Peripheral OE (output enable) is only activated if peripheral select is active.
- 3. I/O pins have diode protection to V_{DD} and V_{SS}.



TABLE 5-5: PORTC FUNCTIONS

Name	Bit	Buffer Type	Function
RC0/T1CKI	bit0	ST	Input/output port pin or Timer1 clock input/Timer1 oscillator input
RC1/T1CKO	bit1	ST	Input/output port pin or Timer1 oscillator output
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3/SCK/SCL can also be selected as the synchronous serial clock for both SPI and I ² C modes.
RC4/SDI/SDA	bit4	ST	RC4/SDI/SDA can also be selected as the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or Synchronous serial port data output
RC6	bit6	ST	Input/output port pin
RC7	bit7	ST	Input/output port pin

Legend: ST = Schmitt Trigger Input

TABLE 5-6: SUMMARY OF PORTC REGISTERS

Register Name	Function	Address	Power-on Reset Value
PORTC	PORTC pins when read PORTC latch when written	07h	XXXX XXXX
TRISC	PORTC data direction register 0 = output, 1 = input	87h	1111 1111

- Notes: 1: x = unknown, - = unimplemented, reads as a '0'.
- 2: For reset values of registers in other reset situations refer to Table.

5.4 PORTD and TRISD Registers

I/O PORTD is an 8-bit port with Schmitt trigger input buffers. Each pin is individually configurable as input or output.

PORTD can be configured as an 8-bit wide microprocessor port (or parallel slave port) by setting control bit PSPMODE (TRISE<4>). In this mode, the input buffers are TTL.

FIGURE 5-6: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)

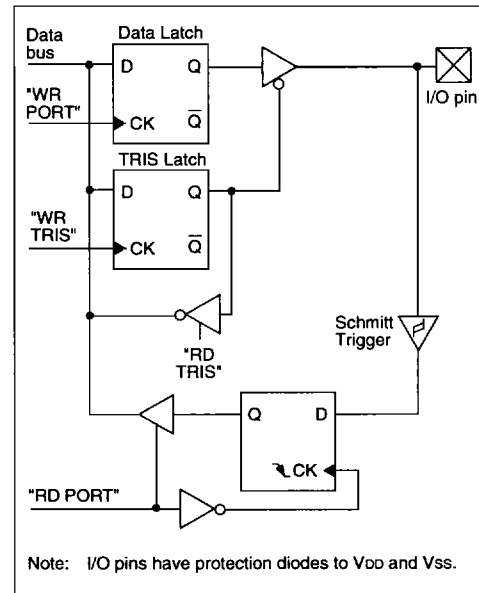


TABLE 5-7: PORTD FUNCTIONS

Name	Bit	Buffer Type	Function
RD0/PSP0	bit0	ST/TTL	Input/output port pin or parallel slave port bit 0
RD1/PSP1	bit1	ST/TTL	Input/output port pin or parallel slave port bit 1
RD2/PSP2	bit2	ST/TTL	Input/output port pin or parallel slave port bit 2
RD3/PSP3	bit3	ST/TTL	Input/output port pin or parallel slave port bit 3
RD4/PSP4	bit4	ST/TTL	Input/output port pin or parallel slave port bit 4
RD5/PSP5	bit5	ST/TTL	Input/output port pin or parallel slave port bit 5
RD6/PSP6	bit6	ST/TTL	Input/output port pin or parallel slave port bit 6
RD7/PSP7	bit7	ST/TTL	Input/output port pin or parallel slave port bit 7

Legend: ST = Schmitt Trigger Input, TTL = TTL input

TABLE 5-8: SUMMARY OF PORTD REGISTERS

Register Name	Function	Address	Power-on Reset Value
PORTD	PORTD pins when read PORTD latch when written	08h	XXXX XXXX
TRISD	PORTD data direction register 0 = output, 1 = input	88h	1111 1111

Notes: 1: x = unknown, - = unimplemented, reads as a '0'.

2: For reset values of registers in other reset situations refer to Table.

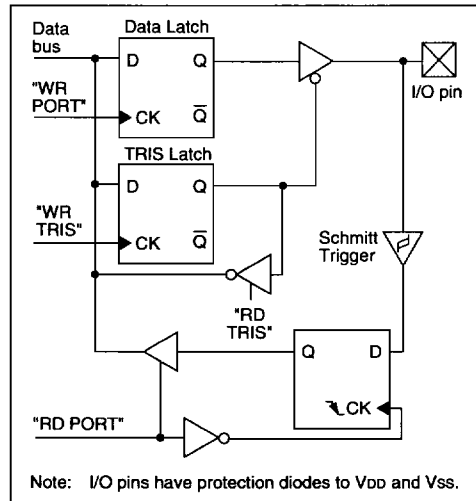
5.5 PORTE and TRISE Register

I/O PORTE has three pins RE0, RE1 and RE2 which are individually configurable as inputs or outputs. These have Schmitt trigger input buffers.

I/O PORTE becomes control inputs for the microprocessor port when the PSPMODE bit (TRISE<4>) is set. In this mode, the user must make sure that the TRISE<2:0> bits are set (pins are configured as digital inputs). In this mode the input buffers are TTL.

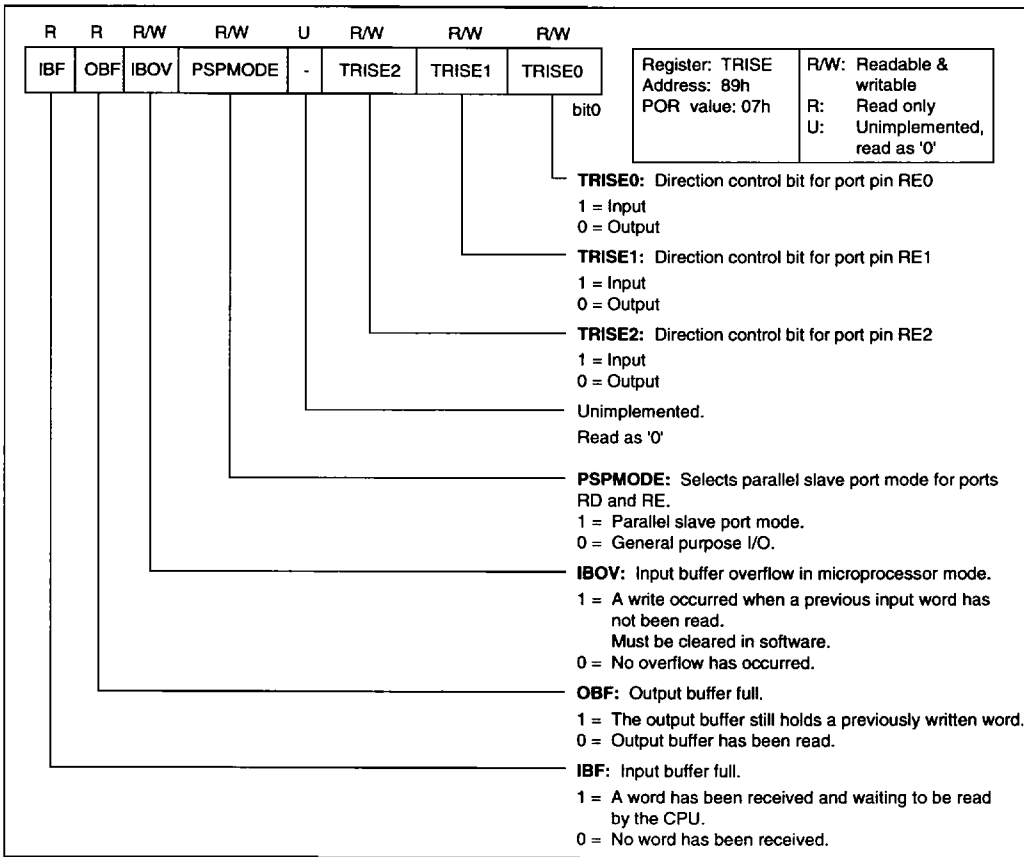
Figure 5-7 shows the TRISE register, which also controls the synchronous slave port operation.

FIGURE 5-7: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)



2

FIGURE 5-8: TRISE REGISTER



PIC16C64

TABLE 5-9: PORTE FUNCTIONS

Name	Bit	Buffer Type	Function
RE0/ \overline{RD}	bit0	ST/TTL	Input/output port pin or Read control input in parallel slave port mode \overline{RD} 1 = Not a read operation 0 = Read operation. The system reads the 16C64 PortD register (if chip selected)
RE1/ \overline{WR}	bit1	ST/TTL	Input/output port pin or Write control input in parallel slave port mode \overline{WR} 1 = Not a write operation 0 = Write operation. The system writes to the 16C64 PortD register (if chip selected)
RE2/ \overline{CS}	bit2	ST/TTL	Input/output port pin or Chip select control input in parallel slave port mode \overline{CS} 1 = Device is not selected 0 = Device is selected

Legend: ST = Schmitt Trigger Input, TTL = TTL input

TABLE 5-10: SUMMARY OF PORTE REGISTERS

Register Name	Function	Address	Power-on Reset Value
PORTE	PORTE pins when read PORTE latch when written	09h	---- -XXX
TRISE	PORTE data direction control bits and PORTD mode control	89h	0000 -111

5.6 I/O Programming Considerations

5.6.1 BIDIRECTIONAL I/O PORTS

Some instructions operate internally as read followed by write operations. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation, and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit 5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit 5 and PORTB is written to the output latches. If another bit of PORTB is used as a bidirectional I/O pin (for example, bit 0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit 0 is switched into output mode later on, the content of the data latch may now be unknown.

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

Reading the PORT register, reads the values of the PORT pins. Writing to the PORT register writes the value to the PORT latch. When using read modify write instructions (ex. BCF, BSF, etc.) on a PORT, the value of the PORT pins is read, the desired operation is done to this value, and this value is then written to the PORT latch.

Example 5-3 shows the effect of two sequential read modify write instructions (ex. BCF, BSF, etc.) on an I/O PORT.

EXAMPLE 5-3: READ MODIFY WRITE INSTRUCTIONS ON AN I/O PORT

```

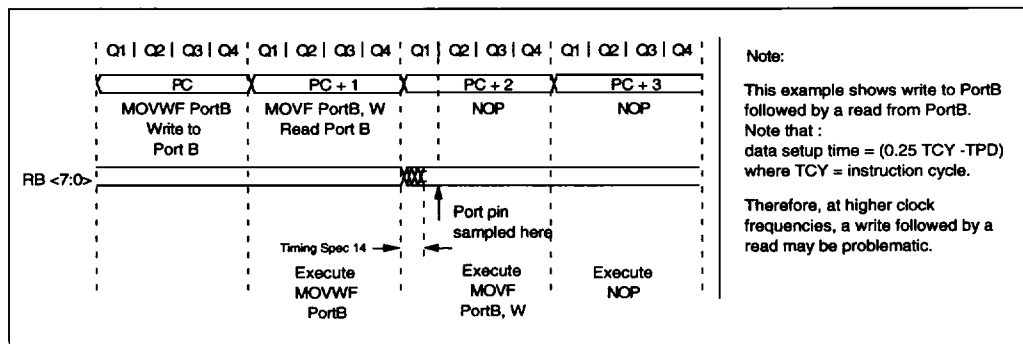
; Initial PORT settings:  PORTB<7:4> Inputs
;                        PORTB<3:0> Outputs
; PORTB<7:6> have external pull-up and are not
; connected to other circuitry.
;
;                        PORT latch  PORT pins
;                        -----
; BCF  PORTB, 7  ; 01pp pppp  11pp pppp
; BCF  PORTB, 6  ; 10pp pppp  11pp pppp
; BSF  STATUS, RPO ;
; BCF  TRISB, 7  ; 10pp pppp  11pp pppp
; BCF  TRISB, 6  ; 10pp pppp  10pp pppp
;
; Note that the user may have expected the pin
; values to be 00pp pppp. The 2nd BCF caused RB7
; to be latched as the pin value (High).
    
```

2

5.6.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (see Figure 5-9). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or an other instruction not accessing this I/O port.

FIGURE 5-9: SUCCESSIVE I/O OPERATION



5.7 Parallel Slave Port

PORTD operates as an 8-bit wide parallel slave port, or microprocessor port when control bit PSPMODE (TRISE<4>) is set. In slave mode it is asynchronously readable and writable by the external world through RD control input (RE0/RD) and WR control input (RE1/WR).

It can directly interface to an 8-bit microprocessor data bus. The microprocessor can read or write the PORTD latch as an 8-bit latch. Setting PSPMODE also enables the port pin RE0 to be the RD input, RE1 to be the WR input and RE2 to be the CS (chip select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (set).

There are actually two 8-bit latches, one for data-out (from the PIC16CXX) and one for data input. The user writes 8-bit data to PORTD data latch and reads data from the port pin latch (note that they have the same address). In this mode the TRISD register is ignored, since the microprocessor is controlling the direction of data flow.

Status flag IBF, Input Buffer Full (TRISE<7>), is set if a received word is waiting to be read by the CPU. The IBF is cleared when PORTD is read by the CPU. IBF is a read only status bit. Status flag OBF, Output Buffer Full (TRISE<6>), is set if a word written to PORTD latch is waiting to be read by the external bus. The OBF flag is cleared when PORTD is read by the external device. Status flag IBOV, Input Buffer Overflow (TRISE<5>), is set if a second word is written to the microprocessor port when the previous word has not been read by the CPU. It is a read/write bit and must be cleared by the CPU.

When not in PSPMODE, IBF and OBF bits are held as cleared. However, if the IBOV flag was previously set, it must be cleared in the software.

An interrupt is generated and latched into control bit PSPIF (PIR1<7>) when a read or a write operation is completed. The PSPIF interrupt flag must be cleared by the CPU and the interrupt can be disabled by clearing the interrupt enable bit PSPIE (PIE1<7>).

FIGURE 5-10: PORTD AND PORTE AS A PARALLEL SLAVE PORT

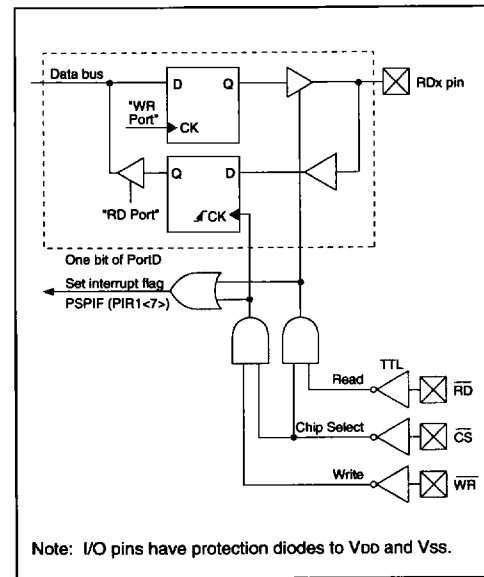


TABLE 5-11: SUMMARY OF PARALLEL SLAVE PORT REGISTERS

Register Name	Function	Address	Power-on Reset Value
PORTD	Parallel slave port Read/Write Data	08h	XXXX XXXX
TRISD	PORTD data direction register	88h	1111 1111
PORTE	Parallel slave port Read/Write/Chip Select signals	09h	---- -xxx
TRISE	Control bits for PORTD peripheral	89h	0000 -111
PIR1	Interrupt register (PSPIF bit)	0Ch	0000 0000
PIE1	Interrupt Enable register (PSPIE bit)	8ch	0000 0000

6.0 OVERVIEW OF TIMER MODULES

The PIC16C64 has three timer modules. Each module can generate an interrupt to indicate that an event has occurred (i.e. timer overflow). Each of these modules is explained in full detail in the following sections. The timer modules are:

- Timer0 (TMR0) module (see Section 7)
- Timer1 (TMR1) module (see Section 8)
- Timer2 (TMR2) module (see Section 9)

For enhanced time-based functionality, the following module can be used with either of the TMR1 or TMR2 modules. This module is the:

- Capture/Compare/PWM (CCP1) module (see Section 10)

6.1 Timer0 (TMR0) Overview

The TMR0 module is identical to the RTCC module of other PIC16CXX enhanced core products (and very similar to the PIC16C5X products). The TMR0 module is a simple 8-bit overflow counter. The clock source can be either the internal system clock (OSC/4) or an external clock. When the clock source is an external clock, the TMR0 module can be selected to increment on either the rising or falling edge.

The TMR0 module also has a programmable prescaler option. This prescaler can be assigned to either the RTCC module or the Watchdog Timer. The PSA bit (OPTION<3>) assigns the prescaler, and the PS2 -PS0 (OPTION<2:0>) determines the prescaler value. The RTCC can increment at the following rates: 1:1 (when prescaler assigned to Watchdog Timer), 1:2, 1:4, 1:8, 1:16, 1:32, 1:64, 1:128, 1:256.

Synchronization of the external clock occurs after the prescaler. When the prescaler is used, the external clock frequency may be higher than the device's frequency. The maximum frequency is 50 MHz, given the high and low time requirements of the clock.

When the clock source is an external clock, the TMR0 module can be selected to increment on either the rising or falling edge.

6.2 Timer1 (TMR1) Overview

Timer1 (TMR1) is a 16-bit timer/counter. The clock source can be either the internal system clock (OSC/4), an external clock, or an external crystal. TMR1 can operate as either a timer or a counter. When operating as a counter (external clock source), the counter can either operate synchronized to the device or asynchronously to the device. Asynchronous operation allows TMR1 to operate during sleep, which is useful for applications that require a real time clock as well as the power savings of sleep mode.

TMR1 also has a prescaler option which allows the TMR1 to increment at the following rates: 1:1, 1:2, 1:4, 1:8. TMR1 can be used in conjunction with the Capture / Compare / PWM (CCP1) module. When used with the CCP1 module, TMR1 is the timebase for 16-bit capture or the 16-bit compare. When using the TMR1 module with the CCP1 module, TMR1 must be synchronized to the device (timer or synchronized counter mode).

6.3 Timer2 (TMR2) Overview

Timer2 (TMR2) is an 8-bit timer. TMR2 has both a programmable prescaler and postscaler, as well as an 8-bit period register (PR2). TMR2 can be used with the CCP1 module as well as the baud rate generator for the Synchronous Serial Port (SSP). The prescaler option which allows the TMR2 to increment at the following rates: 1:1, 1:4, 1:16.

The postscaler allows TMR2 to match the period register (PR2) a programmable number of times before generating an interrupt. The postscaler can be programmed from 1:1 to 1:16 (inclusive).

6.4 CCP1 Overview

The CCP1 module can operate in one of these three modes: 16-bit capture, 16-bit compare, or 10-bit Pulse Width Modulation (PWM)

Capture mode, captures the 16-bit value of TMR1 into the CCP1H:CCP1L register pair. The capture event can be programmed for either the falling edge, rising edge, fourth rising edge, or the sixteenth rising edge of the CCP1 pin.

Compare mode, compares the TMR1H:TMR1L register pair to the CCP1H:CCP1L register pair. When a match occurs an interrupt can be generated, and the output pin CCP1 can be forced to given state (High or Low) or TMR1 can be reset. This depends on the control bits CCP1M3 - CCP1M0.

PWM mode, compares TMR2 to a 10-bit duty cycle register as well as to an 8-bit period register (PR2). When the TMR2 = PR2, TMR2 is reset to 00h, an interrupt can be generated, and the CCP1 pin (if an output) will be forced high. When the TMR2 = Duty Cycle register, the CCP1 pin will be forced low.

7.0 TIMER0 (TMR0) MODULE

The TMR0 module timer/counter has the following features:

- 8-bit timer/counter
- Readable and writable (file address 01h)
- 8-bit software programmable prescaler
- Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 7-1 is a simplified block diagram of the TMR0 module.

Timer mode is selected by clearing the RTS bit (OPTION<5>). In timer mode, the TMR0 module will increment every instruction cycle (without prescaler). If TMR0 is written, increment is inhibited for the following

two cycles (see Figures 7-2 and 7-3). The user can work around this by writing an adjusted value to the TMR0 module.

Counter mode is selected by setting the RTS bit (OPTION<5>). In this mode TMR0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by control bit RTE (OPTION<4>). Clearing the RTE bit selects the rising edge. Restrictions on the external clock input is discussed in detail in Section 7.2.

The prescaler is shared between the TMR0 module and the Watchdog Timer. The prescaler assignment is controlled in software by control bit, PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to TMR0. The prescaler is not readable or writable. When the prescaler is assigned to the TMR0 module, prescale values of 1:2, 1:4, ..., 1:256 are selectable. Section 7.3 details the operation of the prescaler.

FIGURE 7-1: TIMER0 (TMR0) BLOCK DIAGRAM

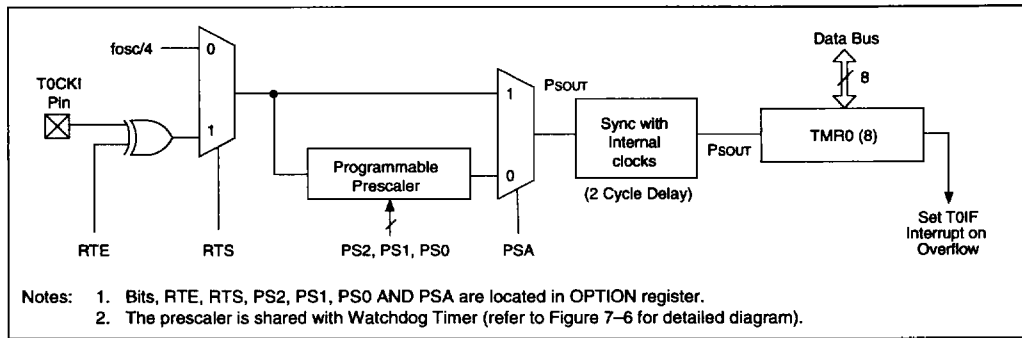


FIGURE 7-2: TIMER0 (TMR0) TIMING: INTERNAL CLOCK/NO PRESCALE

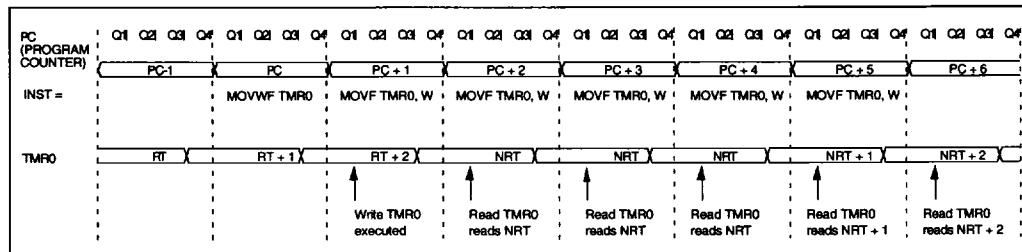
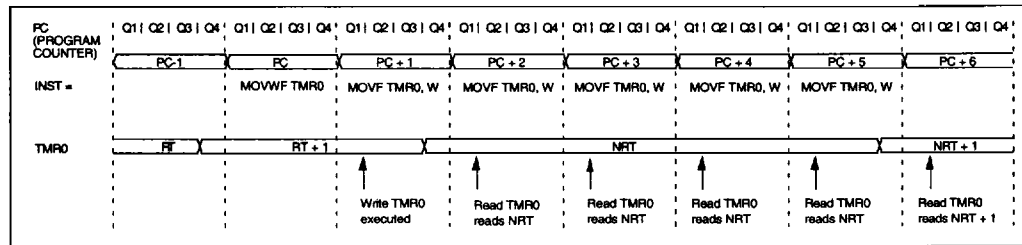


FIGURE 7-3: TIMER0 (TMR0) TIMING: INTERNAL CLOCK/PRESCALE 1:2



7.1 TMR0 (TMR0) Interrupt

TMR0 interrupt is generated when the TMR0 module timer/counter overflows from FFh to 00h. This overflow sets the TOIF bit. The interrupt can be masked by clearing the TOIE bit (INTCON<5>). The TOIF bit (INTCON<2>) must be cleared in software by the TMR0 module interrupt service routine before re-enabling this interrupt. The TMR0 module interrupt can not wake the processor from SLEEP since the timer is shut off during SLEEP. See Figure 7-4 for TMR0 interrupt timing.

7.2 Using TMR0 with External Clock

When external clock input is used for TMR0, it is synchronized with the internal phase clocks. Therefore, the external clock input must meet certain requirements.

Also there is some delay from the occurrence of the external clock edge to the actual incrementing of TMR0. Referring to Figure 7-5, the synchronization is done after the prescaler. The output of the prescaler is sampled twice in every instruction cycle to detect rising or falling edges. Therefore, it is necessary for Psout to be high for at least 2 tosc and low for at least 2 tosc where:

tosc = oscillator time period.

When no prescaler is used, Psout (Prescaler output, see Figure 7-1) is the same as TMR0 clock input and therefore the requirements are:

$$TRTH = TMR0 \text{ high time} \geq 2tosc + \Delta T$$

(See parameter #40)

$$TRTL = TMR0 \text{ low time} \geq 2tosc + \Delta T$$

(See parameter #41)

When prescaler is used, the TMR0 module input is divided by the asynchronous ripple counter-type prescaler and so the prescaler output is symmetrical.

Then:

$$Psout \text{ high time} = Psout \text{ low time} = \frac{N \cdot TRT}{2}$$

where

$$TRT = TMR0 \text{ input period}$$

$$N = \text{prescale value (2, 4, \dots, 256)}$$

The requirement is, therefore:

$$\frac{N \cdot TRT}{2} \geq 2tosc + \Delta T, \text{ or } TRT \geq \frac{4tosc + 2\Delta T}{N}$$

where

$$\Delta T = \text{small RC delay}$$

(see Timing Specifications).

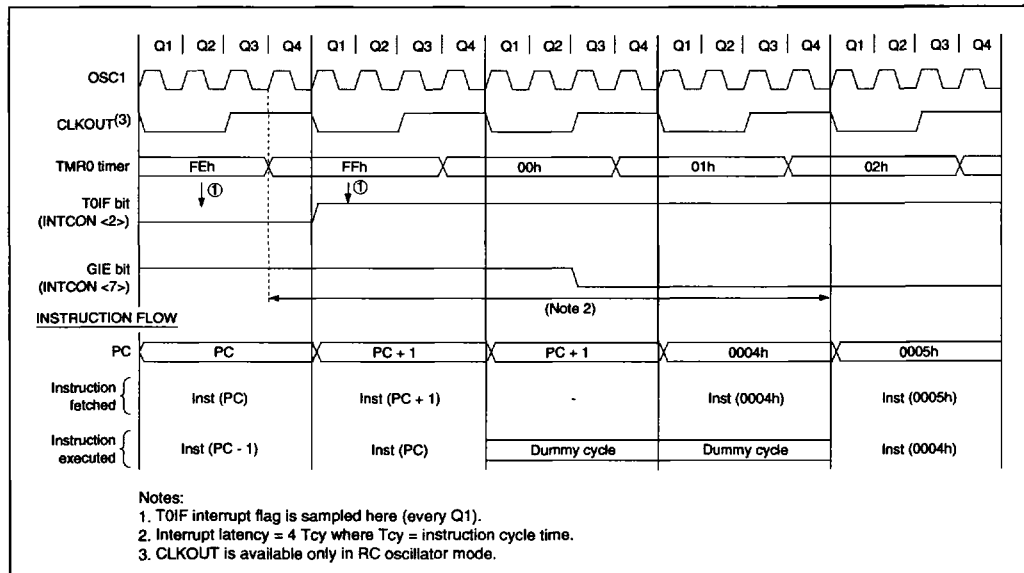
The user will notice that no requirement on TMR0 high time or low time is specified. However, if the high time or low time on TMR0 is too small then the pulse may not be detected, hence a minimum high or low time of 10 ns is required. In summary, the TMR0 module input requirements are:

$$TRT = TMR0 \text{ period} \geq (4tosc + 2\Delta T)/N$$

$$TRTH = TMR0 \text{ high time} \geq \Delta T$$

$$TRTL = TMR0 \text{ low time} \geq \Delta T$$

FIGURE 7-4: TMR0 (TMR0) INTERRUPT TIMING



Delay from external clock edge: Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the TMR0 module is actually incremented. Referring to Figure 7-5, the reader can see that this delay is between 3 t_{osc} and 7 t_{osc} . Thus, for example, measuring the interval between two edges (e.g. period) will be accurate within $\pm 4 t_{osc}$ ($\pm 200ns$ @ 20 MHz).

7.3 Prescaler

An 8-bit counter is available as a prescaler for the TMR0 module, or as a post-scaler for the Watchdog Timer, respectively (see Figure 7-6). For simplicity, this counter is being referred to as "prescaler" throughout this data

sheet. Note that there is only one prescaler available which is mutually exclusively shared between the TMR0 module and the Watchdog Timer. Thus, a prescaler assignment for the TMR0 module means that there is no prescaler for the Watchdog Timer, and vice-versa.

The PSA and PS2-PS0 bits (OPTION<3:0>) determine the prescaler assignment and pre-scale ratio.

When assigned to the TMR0 module, all instructions writing to the TMR0 module (e.g. CLRF 1, MOVWF 1, BSF 1,x....etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

FIGURE 7-5: TIMER0 TIMING WITH EXTERNAL CLOCK

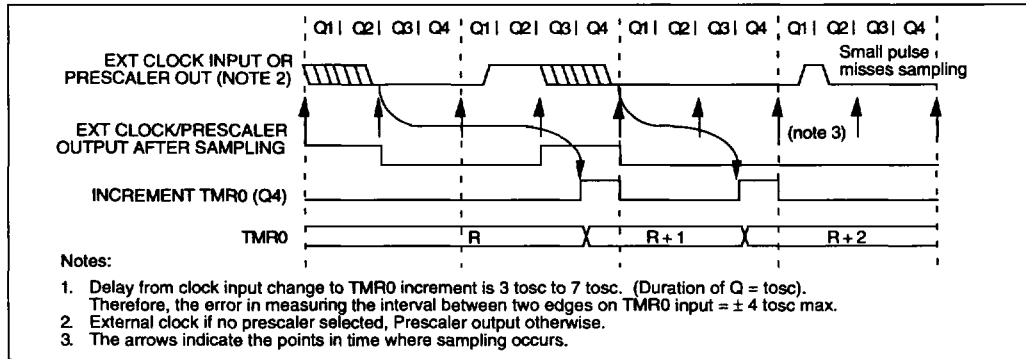
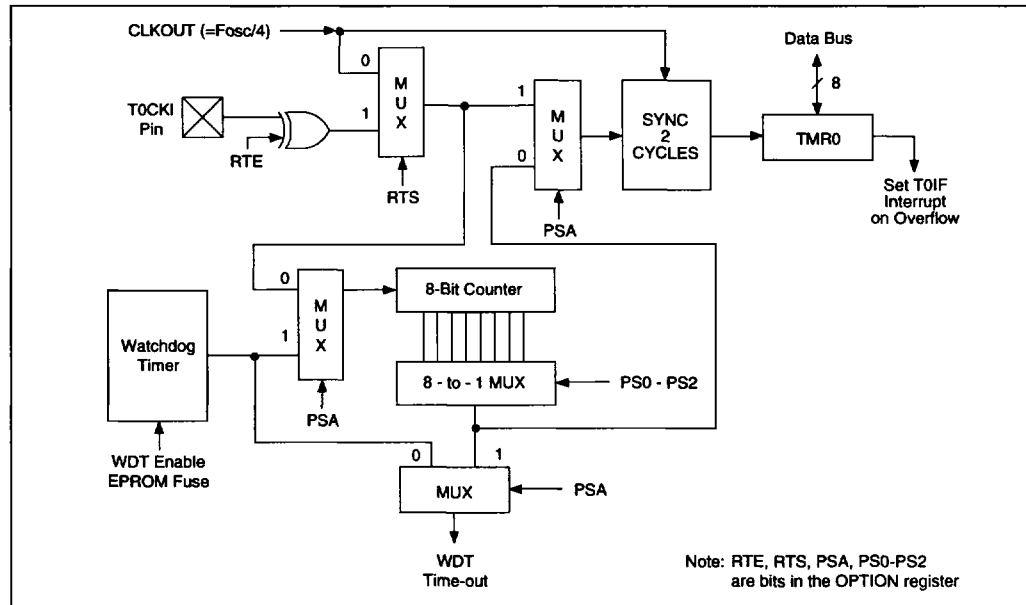


FIGURE 7-6: BLOCK DIAGRAM OF THE TMR0/WDT PRESCALER



7.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control, i.e., it can be changed "on the fly" during program execution. To avoid an unintended device RESET, the following instruction sequence (shown in Example 7-1) must be executed when changing the prescaler assignment from TMR0 to WDT. Depending on the selected prescaler value (lines 2 and 3) determines if lines 9 and 10 are required:

EXAMPLE 7-1: CHANGING PRESCALER (TMR0→WDT)

```

1. BCF STATUS, RP0 ;Bank 0
2. CLRF TMR0 ;Clear TMR0
3. BSF STATUS, RP0 ;Bank 1
4. CLRWDT ;Clears WDT and
; prescale
5. MOVLW B'xxxx1xxx' ;Select new prescale
6. MOVWF OPTION ; value
7. BCF STATUS, RP0 ;Bank 0
    
```

Steps 2 and 3 are only required if an external TMR0 source is used. Steps 9 and 10 are necessary only if the desired prescale value is '000' or '001'.

To change prescaler from the WDT to the TMR0 module use the sequence shown in Example 7-2. This precaution must be taken even if the WDT is disabled.

EXAMPLE 7-2: CHANGING PRESCALER (WDT→TMR0)

```

1. CLRWDT ;Clear WDT and
;prescaler
2. BSF STATUS, RP0
3. MOVLW B'xxxx0xxx' ;Select TMR0, new
;prescale value and
;clock source
4. MOVWF OPTION ;
5. BCF STATUS, RP0
    
```



TABLE 7-1: SUMMARY OF TMR0 REGISTERS

Register Name	Function	Address	Power-on Reset Value
TMR0	Timer/counter register	01h	XXXX XXXX
OPTION	Configuration and prescaler assignment bits for TMR0. See Figure 4-4	81h	1111 1111
INTCON	TMR0 overflow interrupt flag and mask bits See Figure 4-5	0Bh	0000 000X

TABLE 7-2: REGISTERS ASSOCIATED WITH TMR0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
01	TMR0	TIMER0							
0B/8B	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF
81	OPTION	RBPU	INTEDG	RTS	RTE	PSA	PS2	PS1	PS0
85	TRISA	—	—	TRISA 5	TRISA 4	TRISA 3	TRISA 2	TRISA 1	TRISA 0

Legend — = Unimplemented locations, Read as '0'
 Shaded boxes are not used by TMR0 module.

8.0 TIMER1 (TMR1) MODULE

Timer1 is a 16-bit timer/counter consisting of two 8-bit registers (TMR1H and TMR1L) which are readable and writable. TMR1 increments from 0000h to FFFFh and rolls over to 0000h. An interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit TMR1IF (PIR1<0>). This interrupt can be enabled or disabled using the timer1 interrupt enable bit TMR1IE (PIE1<0>).

TMR1 can operate in one of two modes:

- As a timer
- As a counter

This is determined by the clock select bit, TMR1CS (T1CON<1>).

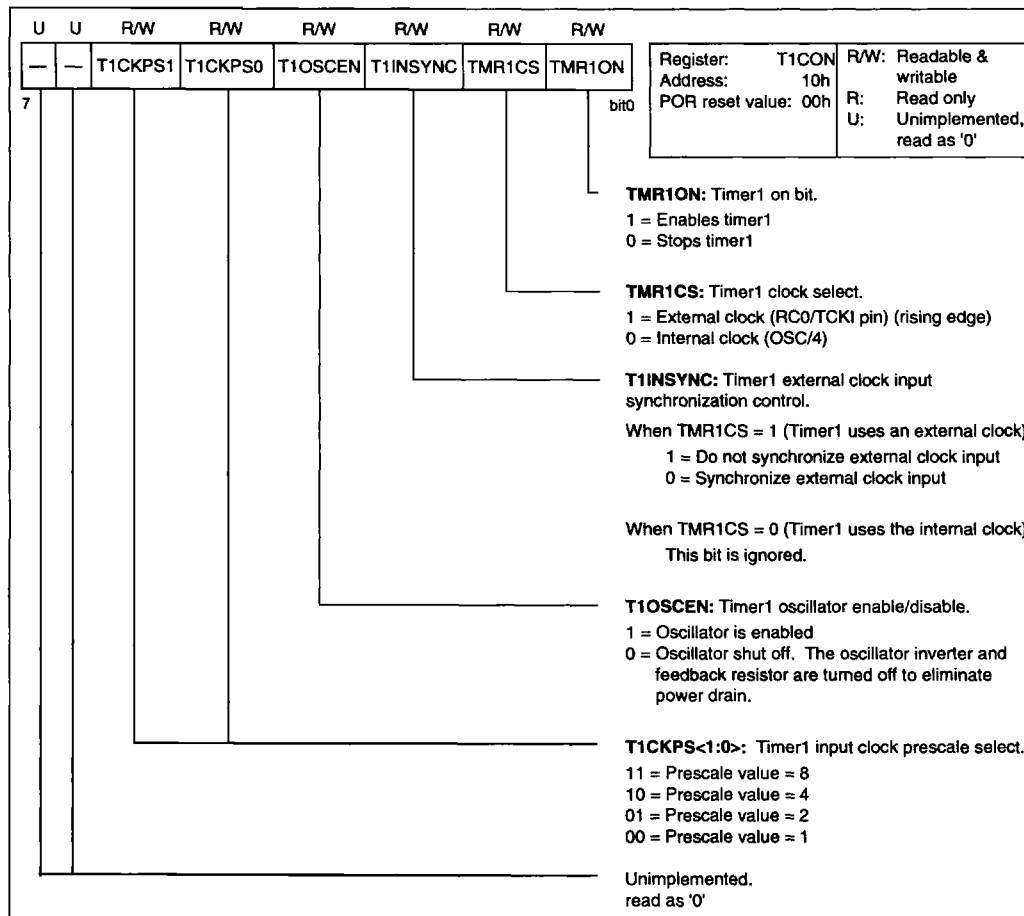
In timer mode, TMR1 increments every instruction cycle. In counter mode, it increments on every rising edge of external clock input on pin RC0/T1CKI.

Timer1 can be turned on or off using the control bit TMR1ON (T1CON<0>). See description of T1CON control register for all control bits related to Timer1.

Timer1 also has an internal "reset input". This reset can be generated by CCP1 (Capture/compare/PWM) module. See Section 10 for details. Figure 8-1 shows the Timer1 control register.

When the Timer1 oscillator is enabled (T1OSCEN is set), the RC1/T1CKO pin becomes an output. That is, the TRISC<1> value is ignored. The RC0/T1CKI pin should normally be configured as an input (for external clock). However, this pin can be configured as an output, if self-clocking (through the output pin) is desired.

FIGURE 8-1: T1CON: TIMER1 CONTROL REGISTER



8.1 TMR1 Operation in Timer Mode

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is OSC/4. The synchronize control bit T1INSYNC (T1CON<2>) has no effect since the internal clock is always in sync.

8.2 TMR1 Operation in Synchronized Counter Mode

Counter mode is selected by setting the TMR1CS bit. In this mode the timer increments on every rising edge of clock input on pin RC0/T1OSCO/T1CKI.

If T1INSYNC is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple counter.

In this configuration, during SLEEP mode, TMR1 will not increment even if external clock is present, since the synchronization circuit is shut off. The prescaler however will continue to increment.

8.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

In synchronized counter mode, the prescaler output is sampled twice every instruction cycle. Therefore, the following restrictions apply to external clock input:

when prescaler is 1:1:

$$T_{TCKIH} = T1CKI \text{ high time} \geq 2 \text{ tosc} + \Delta T$$

$$T_{TCKIL} = T1CKI \text{ low time} \geq 2 \text{ tosc} + \Delta T$$

where ΔT = small RC delay (see timing specifications)

when prescaler is higher:

The input clock is divided by two or more, so the prescaler output is symmetrical. The requirements are then:

$$\begin{aligned} \text{Prescaler out high time} &= \text{Prescaler out low time} \\ &= \frac{N \cdot T_{T1CKIP}}{2} \geq 2 \text{ tosc} + \Delta T \end{aligned}$$

$$\text{or } T_{T1CKIP} \geq 4 \frac{\text{tos}c + \Delta T}{N}$$

where T_{T1CKIP} = T1CKI input clock period
 N = prescale value (2, 4, 8)
 ΔT = small RC delay (see timing specifications)

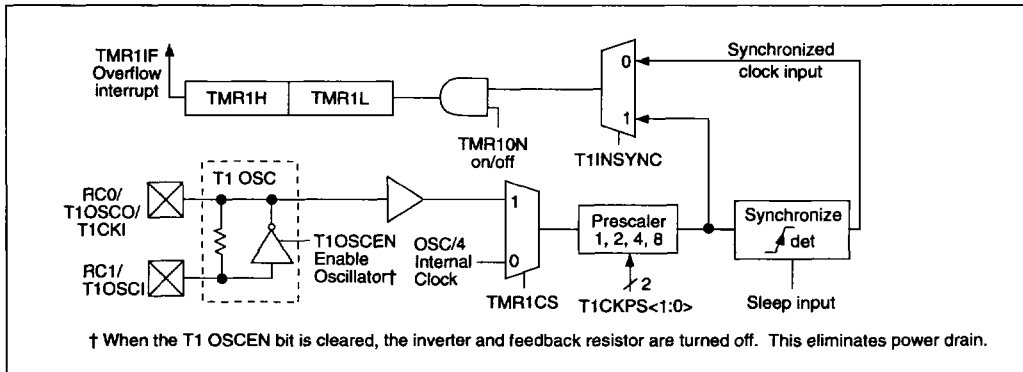
Note that no requirement on minimum high time or low time is mentioned. However, if the pulse is too small it may not be recognized. Hence a minimum high and low time is specified.

$$T_{T1CKIH} \geq \Delta T \text{ (see timing specification \#45)}$$

$$T_{T1CKIL} > \Delta T \text{ (see timing specification \# 46)}$$



FIGURE 8-2: TMR1 BLOCK DIAGRAM



8.3 TMR1 Operation in Asynchronous Counter Mode

If the control bit T1INSYNC is set, the external clock input is not synchronized. The timer continues to increment asynchronous to the internal phase clocks. The timer will continue to run during SLEEP and generate an interrupt on overflow which will wake up the processor. However, special precautions in software are needed to read/write the timer (see Section 8.3.2).

In asynchronous counter mode, Timer1 can not be used as timebase for capture or compare operations.

8.3.1 EXTERNAL CLOCK INPUT TIMING WITH UNSYNCHRONIZED CLOCK

If T1INSYNC is set, the timer will increment completely asynchronously. The input clock must meet a certain minimum high time and low time requirements, as specified in timing specifications #45 and #46.

8.3.2 READING AND WRITING TIMER1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L while the timer is running off external asynchronous clock will guarantee a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself poses certain problems since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers while the register is incrementing. This may produce an unpredictable value in the timer register.

Writing to the timer is no problem, if the clock is slower than the instruction cycle time. Reading the 16-bit value requires some care. Example 8-1 is an example routine to read the 16-bit timer value. This is useful if the timer cannot be stopped.

EXAMPLE 8-1: READING A 16-BIT FREE-RUNNING TIMER

```

; All Interrupts are disabled
MOVF   TMR1H, Wreg   ; Read high byte
MOVWF  TMPH          ;
MOVF   TMR1L, Wreg   ; Read low byte
MOVWF  TMPL          ;
MOVF   TMR1H, Wreg   ; Read high byte
SUBWF  TMPH, Wreg    ; Sub 1st read
;                               ; with 2nd read
BTFSC  STATUS, Z     ; is result = 0
GOTO   CONTINUE      ; Good 16-bit read
;
; TMR1L may have rolled over between the read
; of the high and low bytes. Reading the high
; and low bytes now will read a good value.
;
MOVF   TMR1H, Wreg   ; Read high byte
MOVWF  TMPH          ;
MOVF   TMR1L, Wreg   ; Read low byte
MOVWF  TMPL          ;
; Re-enable Interrupt (if required)
CONTINUE :           ; Continue with your
;                               ; code
    
```

8.4 Timer1 Oscillator

A crystal oscillator circuit is built in between T1CKI pin (input) and T1CKO (amplifier output). It is enabled by setting control bit T1OSCEN (T1CON<3>). The oscillator is a low-power oscillator rated up to 200KHz. It will continue to run during SLEEP. It is primarily intended for a 32KHz crystal. Table 8-1 shows the capacitor selection for the Timer1 oscillator.

The Timer1 oscillator is identical to the LP oscillator. The user must allow software time-out to ensure proper oscillator start-up.

TABLE 8-1: CAPACITOR SELECTION FOR THE TIMER1 OSCILLATOR

Osc Type	Freq	C1	C2
LP	32 KHz§	15 pF	15 pF
	100 KHz	15 pF	15 pF
	200 KHz	0 - 15 pF	0 - 15 pF

Higher capacitance increases the stability of oscillator but also increases the start-up time. These values are for design guidance only.
 §For $V_{DD} > 4.5V$, $C1 = C2 \sim 30pF$ is recommended.

8.5 Resetting Timer1 using CCP1 Trigger Output

If CCP1 module is configured in compare mode to generate a "special event" trigger (CCP1M<3:0>= 1011), this signal will reset timer1.

Timer1 must be configured for timer or synchronized counter mode operation to take advantage of this feature. If the Timer1 is running in asynchronous counter mode, this reset operation may not work.

In the event that a write to Timer1 coincides with a reset trigger from CCP1, the write will take precedence.

In this mode of operation, the CCPR1H:CCPR1L registers pair effectively becomes the period register for the timer1.

8.6 Resetting of Timer Registers

TMR1H and TMR1L registers are not reset on POR or any other reset except by the CCP1 special reset trigger.

T1CON register is reset to 00h on Power-On Reset. In any other reset, the register is unaffected.

8.7 Prescaler

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.



TABLE 8-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B/8B	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
0E	TMR1L	Timer1 Least Significant Byte							
0F	TMR1H	Timer1 Most Significant Byte							
10	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1INSYNC	TMR1CS	TMR1ON

Legend — = Unimplemented locations, Read as '0'
 Note: Shaded boxes are not used by Timer1 module.

PIC16C64

9.0 TIMER2 (TMR2) MODULE

Timer2 is an 8-bit timer with a prescaler and a postscaler. It is especially suitable as PWM time-base (for PWM mode of CCP module). TMR2 is a readable and writable register.

The input clock (osc/4) has a prescale option of 1, 4 or 16 (selected by control bits TCKPS1, TCKPS0, register T2CON).

Timer2 has an 8-bit period register PR2. Timer2 increments from 00h until it matches PR2 and then resets to 00h. PR2 is a readable and writable register.

The overflow (or match) output of TMR2 goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling) to generate timer2 interrupt (latched in TMR2IF bit, PIR<1>).

Timer2 can be shut off using TMR2ON (T2CON<2>) control bit to minimize power consumption.

Figure 9-2 shows the Timer2 control register.

9.1 Prescaler and Postscaler

The prescaler and postscaler counters are cleared when any of the following occurs: a write to the TMR2 register, a write to the T2CON register, or any device reset (Power-On Reset, MCLR reset, or Watchdog Timer reset).

9.2 Output of TMR2

The output of TMR2 (before the postscaler) is fed to the synchronous serial port module which optionally uses it to generate shift clock.

FIGURE 9-1: TIMER2 BLOCK DIAGRAM

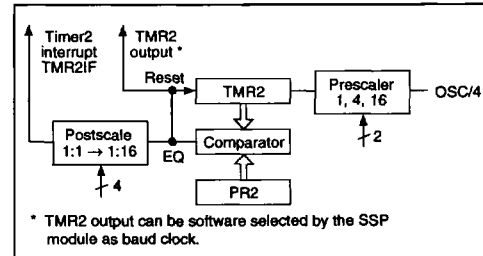


FIGURE 9-2: T2CON: TIMER2 CONTROL REGISTER

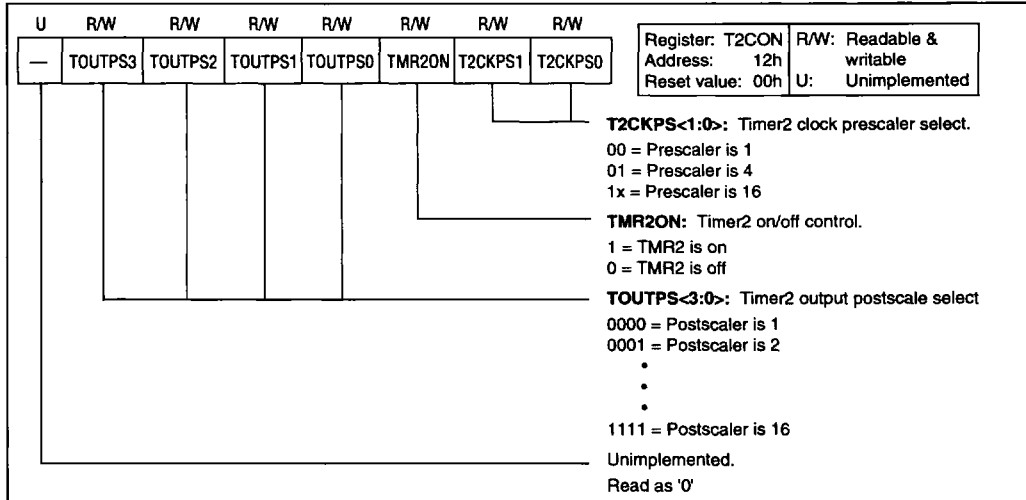


TABLE 9-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
11	TMR2	Timer2							
12	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
92	PR2	Timer2 period Register							

Legend — = Unimplemented locations, Read as '0'
Note: Shaded boxes are not used by Timer2 module.

10.0 CAPTURE/COMPARE/PWM MODULE

The PIC16C64 has a Capture/Compare/PWM (CCP) module consisting of a 16-bit register which can operate as a 16-bit capture register, as a 16-bit compare register or as a PWM output.

CCP1 module:

Capture/compare/PWM register1 (CCPR1) is made up of two 8-bit sections: low byte, CCPR1L and high byte, CCPR1H. Both are readable and writable.

10.1 Capture Mode

In Capture mode, CCPR1 captures the 16-bit value of TMR1 when an event occurs on pin RC2/CCP1. An event is defined as:

1. A falling edge
2. A rising edge
3. Every 4 rising edges
4. Every 16 rising edges

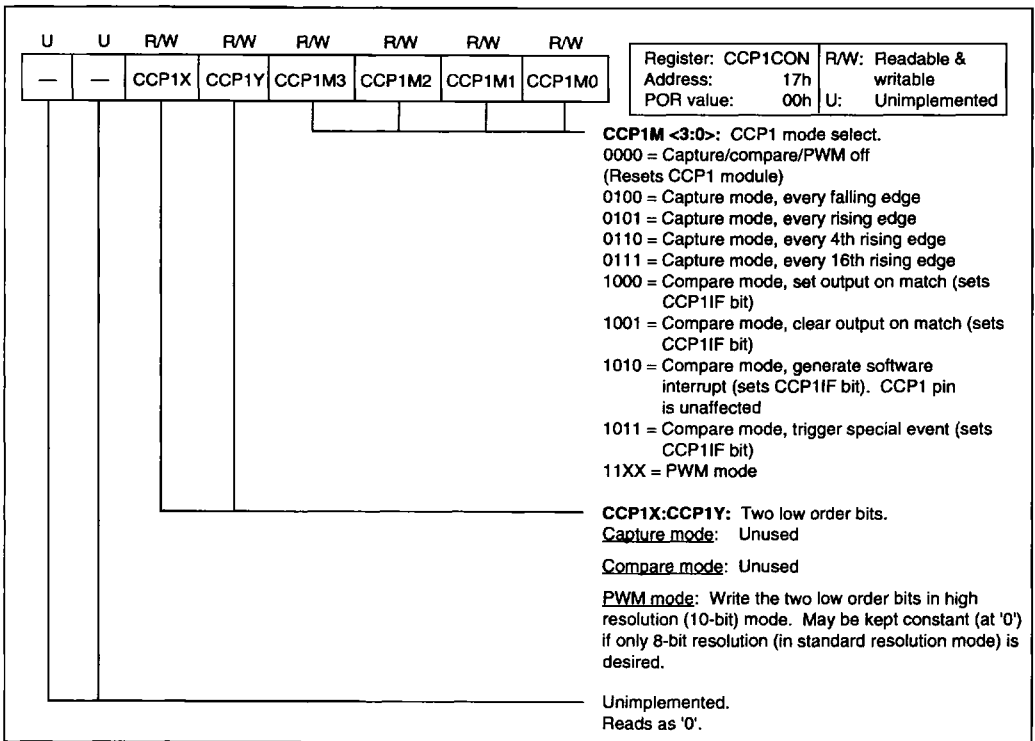
One of these is selected by the control bits CCP1M <3:0> in register CCP1CON. When a capture is made the interrupt request flag, CCP1IR bit (PIR<2>) is set. It must be reset in software. If another capture occurs before the value in register CCPR1 is read, the old captured value will be lost. In capture mode, the RC2/CCP1 pin should be configured as an input through its corresponding TRIS bit.



Note: If the RC2/CCP1 is configured as an output, a write to the port can cause a capture condition.

When the capture mode is changed, a false capture interrupt may be generated. The user should clear the CCP1IF bit following any such change in operating mode.

FIGURE 10-1: CCP1CON REGISTER



10.1.1 PRESCALER DETAILS

There are four prescaler setting, specified by the CCP1M3-CCP1M0 bits. Whenever the CCP module is turned off, or the CCP module is not in capture mode, the prescaler counter is cleared. This means that any reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, and therefore the first capture may be from a non-zero prescaler. Example 10-1 shows the recommended way to switch between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

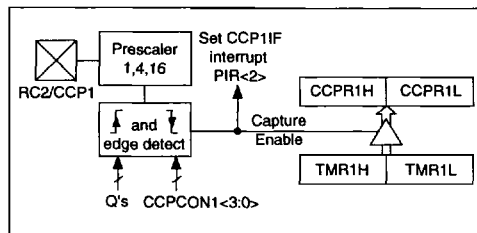
EXAMPLE 10-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
CLRF   CCP1CON   ; Turn CCP module off
MOVLW  NEW_CAPT_PS ; Load the W reg with
                        ; the new prescaler
                        ; mode value
MOVWF  CCP1CON   ; Load CCP1CON with
                        ; this value
```

10.1.2 TIMER1 MODE SELECTION

Timer1 must be running in timer mode or synchronized counter mode for the CCP1 modules to use the capture feature. In asynchronous counter mode the capture operation may not work.

FIGURE 10-2: CAPTURE MODE OPERATION



10.2 Compare Mode

In compare mode, the 16-bit CCPR1 register value is constantly compared against the timer1. When a match occurs, the RC2/CCP1 pin is:

- Driven High
- Driven Low
- Remains Unchanged

The action on the pin is based on the control bits CCP1M <3:0> in register CCP1CON. At the same time, a compare interrupt is also generated (bit CCP1IF, register CCP1CON). The user must set the RC2/CCP1 pin as an output through the TRISC<2> bit.

Note: Clearing the CCP1CON register will force the RC2/CCP1 compare output latch to the default low level. This is not the data latch.

10.2.1 TIMER1 MODE SELECTION

Timer1 must be running in timer mode or synchronized counter mode if the CCP1 module is using the compare feature. In asynchronous counter mode the compare operation may not work.

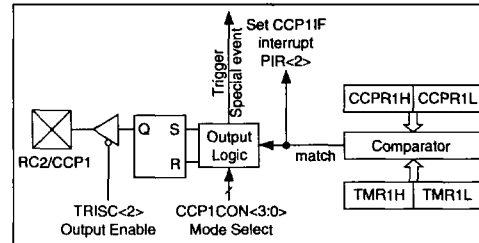
10.2.2 SOFTWARE INTERRUPT MODE

Another compare mode is software interrupt mode in which the CCP1 pin is not affected. Only CCP1IF interrupt is generated.

10.2.3 SPECIAL TRIGGER

The special trigger output of CCP1 is an internal Hardware Trigger which can be used to reset the timer1. This allows the CCPR1 register to effectively be a 16-bit programmable period register for timer1.

FIGURE 10-3: COMPARE MODE OPERATION



10.3 PWM Mode

In Pulse Width Modulation (PWM) mode, the RC2/CCP1 produces up to 10-bit resolution PWM output. This pin must be configured as an output through the TRISC<2> bit. In PWM mode, the user writes the 8-bit duty-cycle value to the low byte of the CCPR1 register, namely CCPR1L. The high-byte, CCPR1H is used as the slave buffer to the low byte. The 8-bit data is transferred from the master to the slave when the PWM1 output is set (i.e. at the beginning of the duty cycle). This double buffering is essential for glitchless PWM output. In PWM mode CCPR1H is readable but not writable. The period of the PWM is determined by timer2 period register (PR2).

PWM period is = $[(PR2) + 1] \cdot 4 \text{ tosc} \cdot (\text{TMR2 prescale value})$

PWM duty cycle = $(DC1) \cdot \text{tosc} \cdot (\text{TMR2 prescale value})$

where DC1 = 10 bit value from CCPR1L and CCP1CON<5:4> concatenated.

The PWM output resolution is therefore programmable up to a maximum of 10-bit.

Note: Clearing the CCP1CON register will force the RC2/CCP1 PWM output latch to the default low level. This is not the I/O data latch.

FIGURE 10-4: SIMPLIFIED PWM BLOCK DIAGRAM

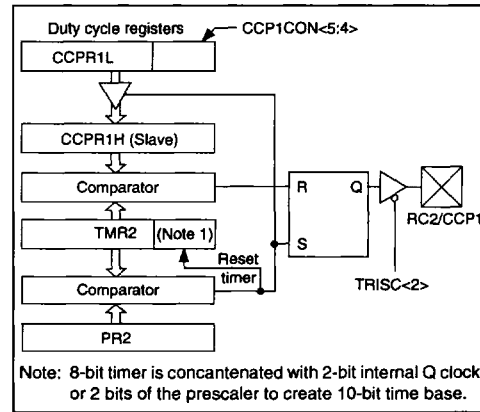


TABLE 10-1: PWM FREQUENCY VS RESOLUTION AT 20 MHZ

Max Resolution (High Resolution Mode)	Frequency		
	TMR2 Prescale = 1	TMR2 Prescale = 4	TMR2 Prescale = 16
10 bit	19.53 KHz	4.88 KHz	1.22 KHz
9 bit	39.06 KHz	9.77 KHz	2.44 KHz
8 bit	78.13 KHz	19.53 KHz	4.88 KHz

TABLE 10-2: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 20 MHZ

PWM Frequency	1.22 KHz	4.88 KHz	19.53 KHz	78.13 KHz	157.5 KHz	210.53 KHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0xFF	0x7F	0x5F
Resolution (High-resolution mode†)	10-bit	10-bit	10-bit	8-bit	7-bit	6.5-bit
Resolution (Standard-resolution mode†)	8-bit	8-bit	8-bit	6-bit	5-bit	4.5-bit

† Standard resolution mode has the CCP1X:CCP1Y bit constant (or '0'), and only compares the TMR2 against the PR2. The Q-cycles are not used.

PIC16C64

TABLE 10-3: REGISTERS ASSOCIATED WITH TIMER1 AND CAPTURE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B/8B	INTCON	GIE	PEIE	TOIE	INTC	RBIE	TOIF	INTF	RBIF
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
0E	TMR1L	Timer1 Least Significant Byte							
0F	TMR1H	Timer1 Most Significant Byte							
10	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1INSYNC	TMR1CS	TMR1ON
15	CCPR1L	Timer1 Capture Register (LSB)							
16	CCPR1H	Timer1 Capture Register (MSB)							
17	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0

Legend — = Unimplemented locations, Read as '0' Note: Shaded boxes are not used in this mode.

TABLE 10-4: REGISTERS ASSOCIATED WITH TIMER1 AND COMPARE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B/8B	INTCON	GIE	PEIE	TOIE	INTC	RBIE	TOIF	INTF	RBIF
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
0E	TMR1L	Timer1 Least Significant Byte							
0F	TMR1H	Timer1 Most Significant Byte							
10	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1INSYNC	TMR1CS	TMR1ON
15	CCPR1L	Timer1 Compare Register (LSB)							
16	CCPR1H	Timer1 Compare Register (MSB)							
17	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0

Legend — = Unimplemented locations, Read as '0' Note: Shaded boxes are not used in this mode.

TABLE 10-5: REGISTERS ASSOCIATED WITH TIMER2 AND PWM

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B/8B	INTCON	GIE	PEIE	TOIE	INTC	RBIE	TOIF	INTF	RBIF
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
11	TMR2	Timer2							
92	PR2	Timer2 period Register							
12	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
15	CCPR1L	Timer2 Duty Cycle Register							
16	CCPR1H	Timer2 Duty Cycle Register (Slave)							
17	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0

Legend — = Unimplemented locations, Read as '0' Note: Shaded boxes are not used in this mode.

11.0 SYNCHRONOUS SERIAL PORT (SSP)

The Synchronous Serial Port (SSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be Serial EEPROMs, shift registers, display drivers, A/D converters, etc. The SSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C)

FIGURE 11-1: SSPSTAT: SYNC SERIAL PORT STATUS REGISTER

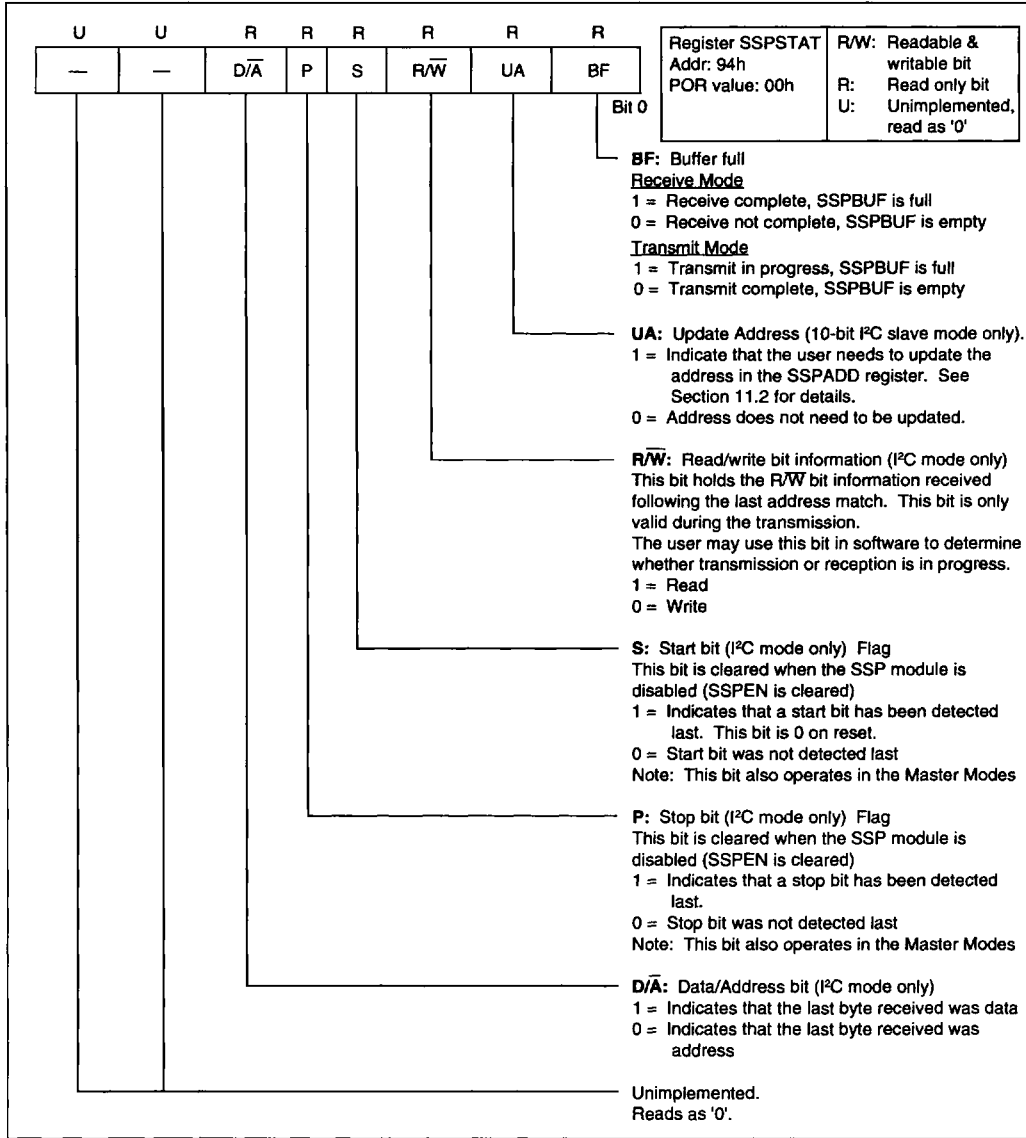
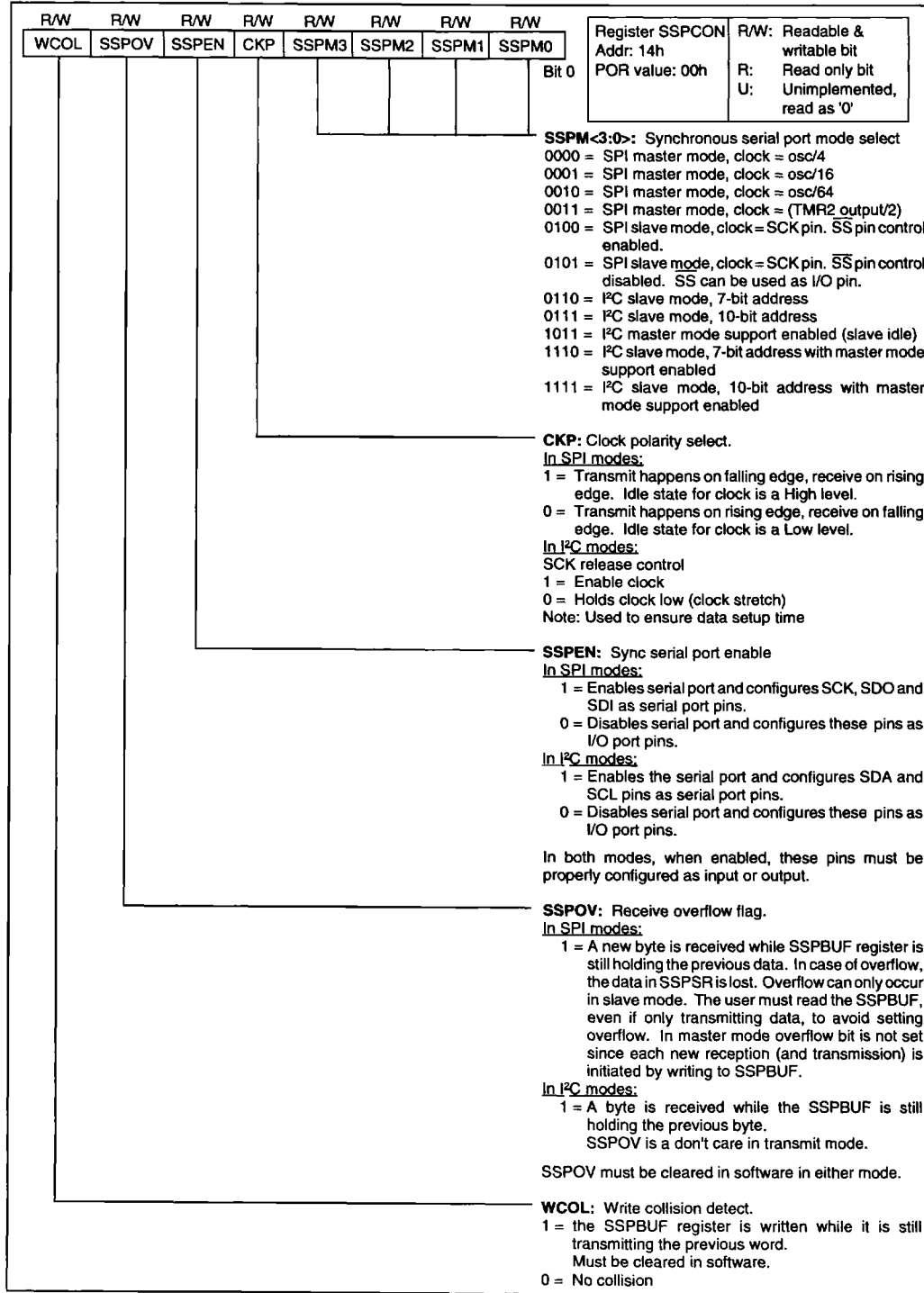


FIGURE 11-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER



11.1 SPI Mode

The SPI mode allows 8-bits of data to be synchronously transmitted and received simultaneously. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO)
- Serial Data In (SDI)
- Serial Clock (SCK)

Additionally a fourth pin may be used when in a slave mode of operation:

- Slave Select (\overline{SS})

When initializing the SPI, several options need to be specified. This is done by appropriately programming the control bit in the SSPCON register (SSPCON<5:0>). These control bits allow the following to be specified:

- Master Mode (SCK is the clock output)
- Slave Mode (SCK is the clock input)
- Clock Polarity (Output/Input data on the Rising/Falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select Mode (Slave mode only)

The SSP consists of a transmit/receive Shift Register (SSPSR) and a Buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, while the SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the 8-bits of data have been received, that information is moved to the SSPBUF register, the Buffer Full (BF) bit (SSPSTAT<0>) and the SSPIF bit are set. This double buffering of the received data (SSPBUF), allows the next byte to start reception before reading the data that was received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect (WCOL) bit (SSPCON<7>) will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF completed successfully. When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. The Buffer Full (BF) bit (SSPSTAT<0>) indicates when the SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally the SSP Interrupt is used to determine when the transmission/reception has completed. The SSPBUF can then be read (if data is meaningful) and/or the SSPSR (SSPSR) can be written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 11-1 shows the loading of the SSPBUF (SSPSR) for data transmission. The instructions with the comment fields beginning with ;*** are only required if the received data is meaningful.

EXAMPLE 11-1: LOADING THE SSPBUF (SSPSR) REGISTER

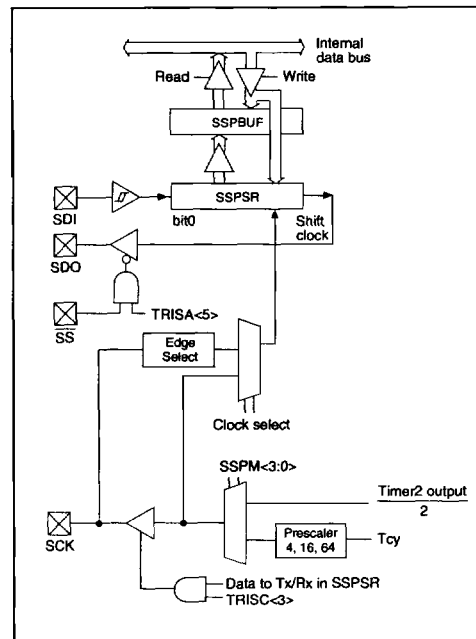
```

LOOP BSF STATUS, RP0 ;Specify Bank 1
      BTFSS SSPSTAT, BF ;Has data been
      ;received
      ;(transmit complete)?
      GOTO LOOP ;No
      BCF STATUS, RP0 ;Specify Bank 0
      MOVF SSPBUF, W ;W reg = contents
      ;of SSPBUF
      MOVWF RXDATA ;*** Save in user RAM
      MOVF TXDATA, W ;W reg = contents of
      ;TXDATA
      MOVWF SSPBUF ;New data to xmit.
    
```

The block diagram of the SSP module, when in SPI mode (Figure 11-3), shows that the SSPSR is not directly readable or writable, and can only be accessed from addressing the SSPBUF register. Additionally, the SSP status register (SSPSTAT) indicates the various status conditions.



FIGURE 11-3: SSP BLOCK DIAGRAM (SPI MODE)

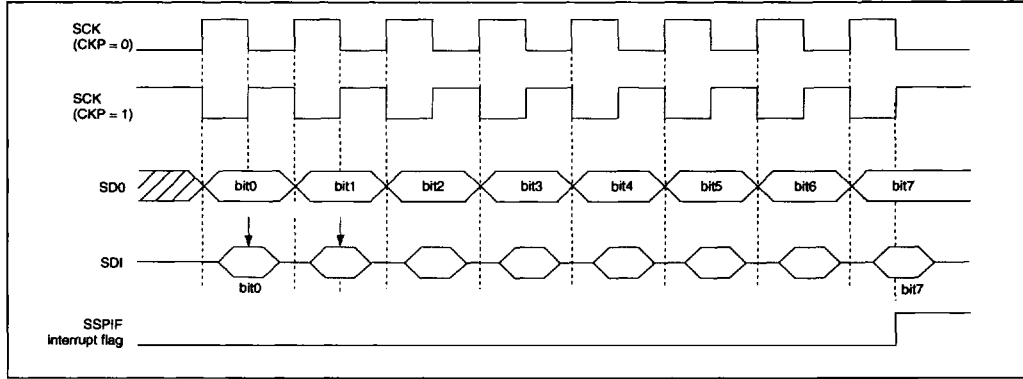


The \overline{SS} pin allows a synchronous slave mode. The SPI must be in slave mode (SSPCON<3:0> = 04h) and the TRISA<5> bit must be set for the synchronous slave mode to be enabled. When the \overline{SS} pin is low, transmission and reception are enabled and the SDO pin is driven. When the \overline{SS} pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. External pull-up / pull-

down resistors may be desirable, depending on the application.

To emulate 2-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.

FIGURE 11-5: SPI MODE TIMING (MASTER MODE OR SLAVE MODE W/O \overline{SS} CONTROL)



2

FIGURE 11-6: SPI MODE TIMING (SLAVE MODE WITH \overline{SS} CONTROL)

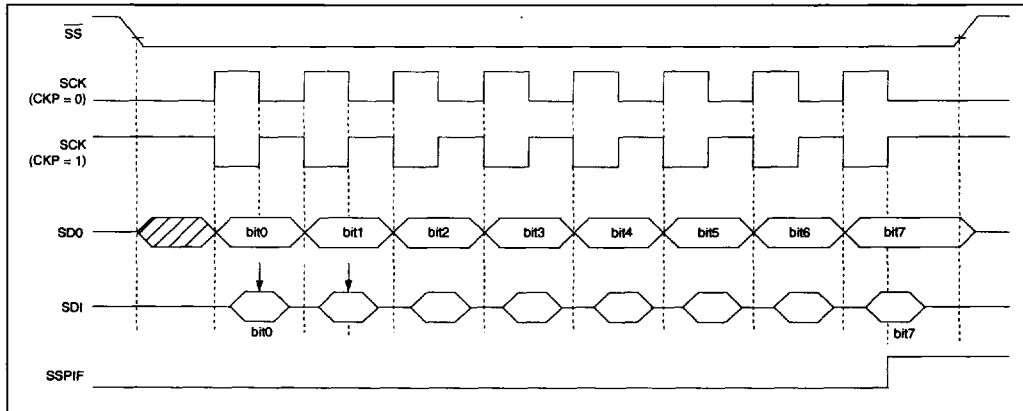


TABLE 11-1: REGISTERS ASSOCIATED WITH SPI OPERATION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B/8B	INTCON	GIE	PEIE	TOIE	INTE	RB2IE	TOIF	INTF	RB1F
0C	PIR1	PSPIF	—	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	—	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
13	SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register							
14	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0
94	SSPSTAT	—	—	D/A	P	S	R/W	UA	BF

Legend — = Unimplemented locations, Read as '0' Note: Shaded boxes are not used by SSP module in SPI mode.

11.2 I²C Overview

This section gives an overview of the Inter-IC (I²C) bus, with Section 11.3 discussing the operation of the SSP module in I²C mode. The Inter-IC (I²C) bus is a two-wire serial interface developed by Philips/Signetics™. The original specification, or standard mode, was for data transfers of up to 100-Kbps. An enhanced specification, or fast mode, supports data transmission up to 400 Kbps. Both standard mode and fast mode devices will inter-operate if attached to the same bus.

The I²C interface employs a comprehensive protocol to ensure reliable transmission and reception of data. When transmitting data, one device is the "master" (generates the clock), while the other device(s) acts as the "slave". All Portions of the slave protocol are implemented in the SSP module's hardware, while portions of the master protocol will need to be addressed in the PIC16CXX software. Table 11-2 defines some of the I²C-bus terminology. For additional information on the I²C interface specification, please refer to the Philips/Signetics™ document "The I²C-bus and how to use it". The order number for this document is 98-8080-575.

In the I²C interface protocol each device has an address. When a master wishes to initiate a data transfer, it first transmits the address of the device that it wishes to "talk" to. All devices "listen" to see if this is their address. Within this address, a bit specifies if the master wishes to read / write from / to the slave device. The master and slave are always in opposite modes (transmitter/receiver) of operation during a data transfer. That is they can be thought of operating in either of these two relations:

- Master-transmitter and Slave-receiver
- Slave-transmitter and Master-receiver

In both cases the master generates the clock signal.

The output stages of the clock (SCL) and data (SDA) lines must have an open-drain or open-collector in order to perform the wired-AND function of the bus. External pull-up resistors are used to ensure a high level, when no device is pulling the line down.. The number of devices that may be attached to the I²C bus is limited only by the maximum bus loading specification of 400 pF.

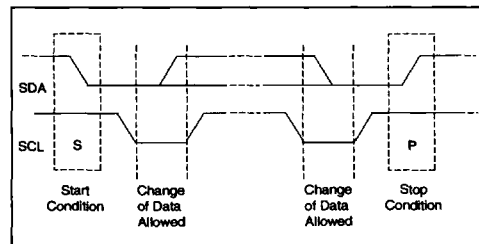
TABLE 11-2: I²C-BUS TERMINOLOGY

Term	Description
Transmitter	The device that sends the data to the bus
Receiver	The device that receives the data from the bus
Master	The device which initiates the transfer, generates the clock, and terminates the transfer
Slave	The device addressed by a master
Multi-master	More than one master device in a system. These masters can attempt to control the bus at the same time without corrupting the message
Arbitration	Procedure that ensures that only one of the master devices will control the bus. This ensures that the transfer data does not get corrupted.
Synchronization	Procedure where the clock signals of two or more devices are synchronized.

11.2.1 INITIATING AND TERMINATING DATA TRANSFER

During times of no data transfer (idle time), both the clock line (SCL) and the data line (SDA) are pulled high through the external pull-up resistors. The START and STOP conditions determine the start and stop of data transmission. The START condition is defined as a high to low transition of the SDA when the SCL is high. The STOP condition is defined as a low to high transition of the SDA when the SCL is high. Figure 11-7 shows the START and STOP conditions. The master generates these conditions for starting and terminating data transfer. Due to the definition of the START and STOP conditions, when data is being transmitted the SDA line can only change state when the SCL line is low.

FIGURE 11-7: START AND STOP CONDITIONS



11.2.2 ADDRESSING I²C DEVICES

There are two address formats. The simplest is the 7-bit address format with a R/W bit (see Figure 11-8). The more complex is the 10-bit address with a R/W bit (see Figure 11-9). For 10-bit address format, two bytes must be transmitted with the first five bits specifying this to be a 10-bit address.

FIGURE 11-8: 7-BIT ADDRESS FORMAT

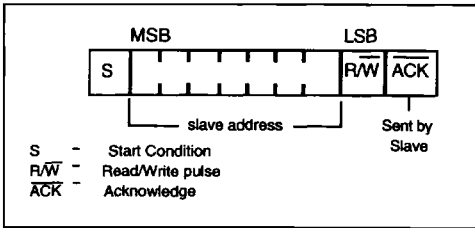
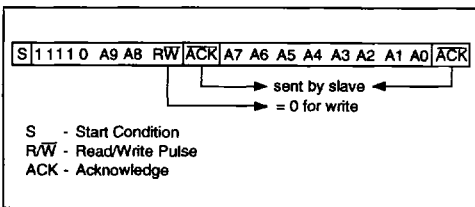


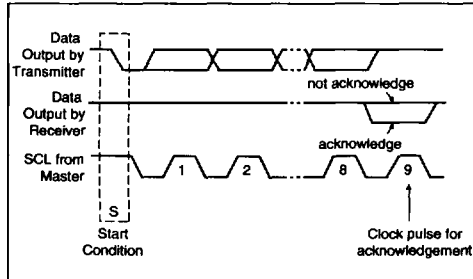
FIGURE 11-9: I²C 10-BIT ADDRESS FORMAT



11.2.3 TRANSFER ACKNOWLEDGE

All data must be transmitted per byte, with no limit to the number of bytes transmitted per data transfer. After each byte, the slave-receiver generates an acknowledge bit (ACK). This is shown in Figure 11-10. When a slave-receiver doesn't acknowledge the slave address or received data, the master must abort the transfer. The slave must leave SDA high so that the master can generate the STOP condition (see Figure 11-7).

FIGURE 11-10: SLAVE-RECEIVER ACKNOWLEDGE

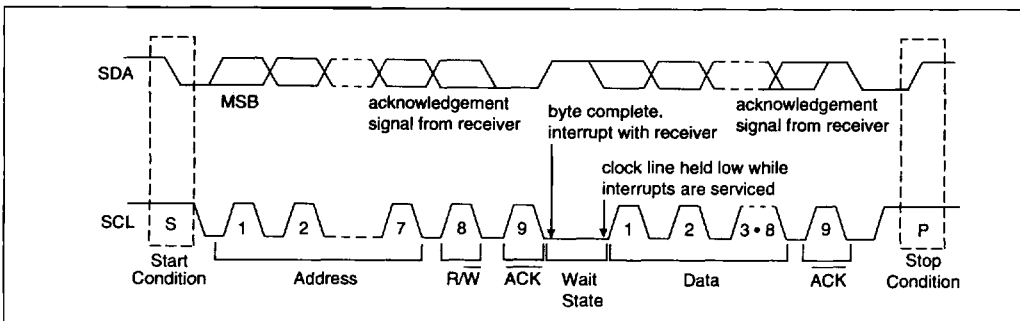


2

If the master is receiving the data (master-receiver), it generates an acknowledge signal for each received byte of data, except for the last byte. To signal the end of data to the slave-transmitter, the master does not generate an acknowledge (not acknowledge). The slave then releases the SDA line so the master can generate the STOP condition. The master can also generate the STOP condition during the acknowledge pulse for valid termination of data transfer.

If the slave needs to delay the transmission of the next byte, holding the SCL line low will force the master into a wait state. Data transfer continues when the slave releases the SCL line. This allows the slave to move the received data or fetch the data it needs to transfer before allowing the clock to start. This wait state technique can also be implemented at the bit level. Figure 11-11 shows a data transfer waveform.

FIGURE 11-11: A DATA TRANSFER



PIC16C64

Figures 11-12 and 11-13 show Master-transmitter and Master-receiver data transfer sequences.

When a master does not wish to relinquish the bus (by generating a STOP condition), a repeated START condition (Sr) must be generated. This condition is identical to the start condition (SDA goes high-to-low while SCL

is high), but occurs after a data transfer acknowledge pulse (not the bus-free state). This allows a master to send "commands" to the slave and then receive the requested information or to address a different slave device. This sequence is shown in Figure 11-14.

FIGURE 11-12: MASTER-TRANSMITTER SEQUENCE

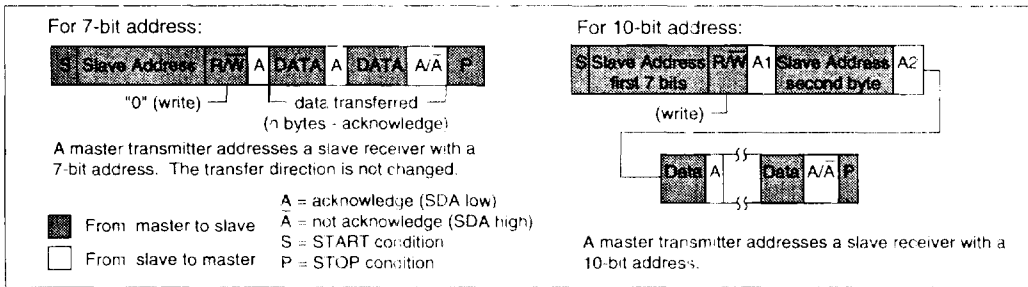


FIGURE 11-13: MASTER-RECEIVER SEQUENCE

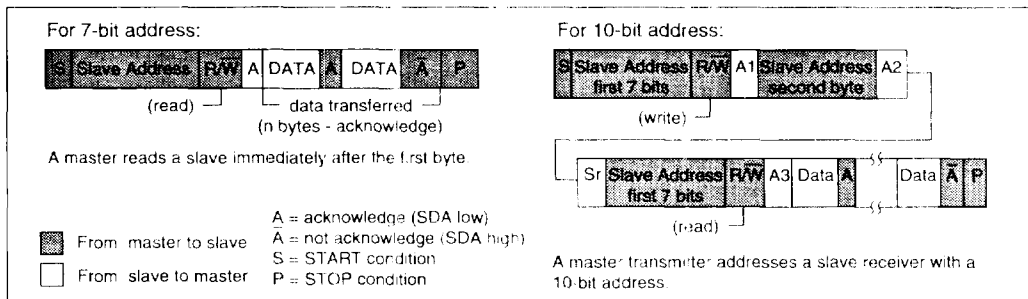
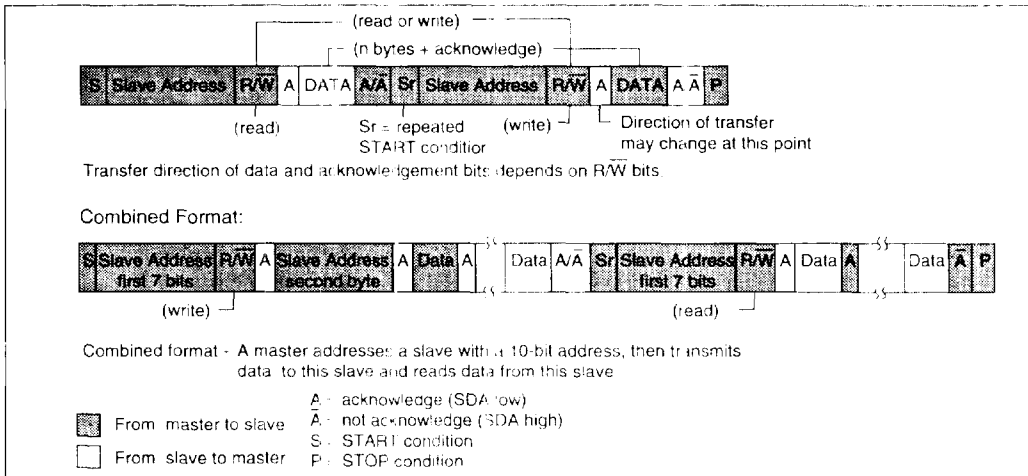


FIGURE 11-14: COMBINED FORMAT



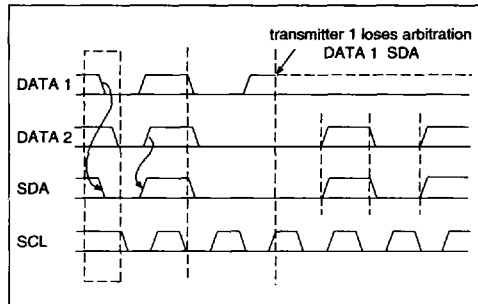
11.2.4 Multi-master

The I²C protocol allows a system to have more than one master. This is called multi-master. When two or more masters try to transfer data at the same time, arbitration and synchronization occur.

11.2.4.1 ARBITRATION

Arbitration takes place on the SDA line, while the SCL line is high. The master which transmits a high when the other master transmits a low loses arbitration (see Figure 11-15), and turns off its data output stage. A master which lost arbitration can generate clock pulses until the end of the data byte where it lost arbitration. When the master devices are addressing the same device, arbitration continues into the data.

FIGURE 11-15: MULTI-MASTER ARBITRATION (2 MASTERS)



Masters that also incorporate the slave function, and have lost arbitration must immediately switch over to slave-receiver mode. This is because the winning master-transmitter may be addressing it.

Arbitration is not allowed between:

- A repeated START condition
- A STOP condition and a data bit
- A repeated START condition and a STOP condition

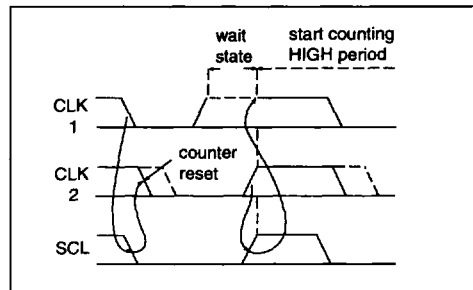
Care needs to be taken to ensure that these conditions do not occur.

11.2.4.2 CLOCK SYNCHRONIZATION

Clock synchronization occurs after the devices have started arbitration. This is performed using a wired-AND connection to the SCL line. A high to low transition on the SCL line causes the concerned devices to start counting off their low period. Once a device clock has gone low, it will hold the SCL line low until its SCL high state is reached. The low to high transition of this clock may not change the state of the SCL line, if another device clock is still within its low period. The SCL line is held low by the device with the longest low period. Devices with shorter low periods enter a high wait-state, until the SCL line comes high. When the SCL line comes high, all devices start counting off their high periods. The first device to complete its high period will pull the SCL line low. The SCL line high time is determined by the device with the shortest high period. This is shown in Figure 11-16.



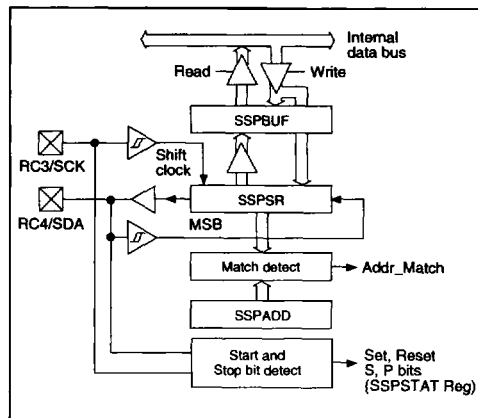
FIGURE 11-16: CLOCK SYNCHRONIZATION



11.3 SSP I²C Operation

The SSP module in I²C mode fully implements all slave functions, and provides support in hardware to facilitate software implementations of the master functions. The SSP module implements the standard and fast mode specifications as well as 7-bit and 10-bit addressing. Two pins are used for data transfer. These are the RC3/SCK/SCL pin, which is the clock (SCL), and the RC4/SDI/SDA pin, which is the data (SDA). The user must configure these pins as inputs or outputs through the TRISC<4:3> bits. A block diagram of the SSP module in I²C mode is shown in Figure 11-17. The SSP module functions are enabled by setting the SSP Enable (SSPEN) bit (SSPCON<5>).

FIGURE 11-17: SSP BLOCK DIAGRAM (I²C MODE)



The SSP module has five registers for I²C operation. These are the:

- SSP Control Register (SSPCON)
- SSP Status Register (SSPSTAT)
- Serial Receive / Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) - Not directly accessible
- Address Register (SSPADD)

The SSPCON register allows control of the I²C operation. Four mode selection bits (SSPCON<3:0>) allows one of the following I²C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address), with master-mode support
- I²C Slave mode (10-bit address), with master-mode support
- I²C Master mode, slave is idle

Selection of any I²C mode and with the SSPEN bit set, forces the SCL and SDA pins to be open collector, provided these pins are set to inputs through the TRISC bits.

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START or STOP bit, specifies if the received byte was data or address, if the next byte is the completion of 10-bit address, and if this will be a read or write data transfer. The SSPSTAT register is read only.

The SSPBUF is the register to which transfer data is written to or read from. The SSPSR register shifts the data in or out of the device. In receive operations, the SSPBUF and SSPSR create a doubled buffered receiver. This allows reception of the next byte before reading the last byte of received data. When the complete byte is received, it is transferred to the SSPBUF and the SSPIF is set. If another complete byte is received before the SSPBUF is read, a receiver overflow has occurred and the SSPOV bit (SSPCON<6> is set.

The SSPADD register holds the slave address. In 10-bit mode, the user needs to write the high byte of the address (1 1 1 1 0 A9 A8 0). Following the high byte address match, the low byte of the address needs to be loaded (A7 - A0).

11.3.1 Slave Mode

In slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The SSP module will override the input state with the output data when required (slave-transmitter).

When an address is matched or the data transfer from an address match is received, the hardware automatically will generate the acknowledge (ACK) pulse, and then load the SSPBUF with the received value in the SSPSR.

There are certain conditions that will cause the SSP module not to give this ACK pulse. These are if either (or both):

- The Buffer Full (BF) bit was set before the transfer was received.
- The Overflow (SSPOV) bit was set before the transfer was received.

In this case, the SSPSR value is not loaded into the SSPBUF, but the SSPIF bit is set. Table 11-3 shows what happens when a data transfer byte is received, given the status of the BF and SSPOV bits. The shaded boxes shows the condition where user software did not properly clear the overflow condition. The BF flag is cleared by reading the SSPBUF register while the SSPOV bit is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I²C specification as well as the requirement of the SSP module is shown in timing specifications #90 and 91.

11.3.1.1 ADDRESSING

Once the SSP module has been enabled, The SSP waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR. All incoming bits are sampled with the rising edge of the clock (SCL) line. The SSPSR<7:1> is compared to the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following things happen:

- SSPSR loaded into SSPBUF
- Buffer Full (BF) bit is set
- ACK pulse is generated
- SSP Interrupt Flag (SSPIF) is set (interrupt is generated if enabled) - on falling edge of ninth SCL pulse

In 10-bit address mode, two address bytes need to be received by the slave (see Figure 11-9). The five Most Significant bits (MSBs) of the first address byte, specify if this is a 10-bit address. The R/W bit (bit 0) must specify a write, so the slave device will receive the second address byte. For a 10-bit address the first byte would equal '1 1 1 1 0 A9 A8 0', where A9 and A8 are the two MSBs of the address. The sequence of events for 10-bit address are as follows, with steps 7-9 for slave-transmitter:

1. Receive first (high) byte of Address (SSPIF, BF and UA are set)
2. Update SSPADD with second (low) byte of Address (clears UA and releases SCL line)
3. Read SSPBUF (clears BF) and clear SSPIF
4. Receive second (low) byte of Address (SSPIF, BF and UA are set)
5. Update SSPADD with first (high) byte of Address (clears UA, if match releases SCL line)
6. Read SSPBUF (clears BF) and clear SSPIF
7. Receive Repeated START condition
8. Receive first (high) byte of Address (SSPIF and BF are set)
9. Read SSPBUF (clears BF) and clear SSPIF



TABLE 11-3: DATA TRANSFER RECEIVED BYTE ACTIONS

Status Bits as Data Transfer is Received		SSPSR → SPBUF	Generate $\overline{\text{ACK}}$ Pulse	Set SSPIF bit (SSP Interrupt if Enabled)
BF	SSPOV			
0	0	Yes	Yes	Yes
1	0	No	No	Yes
1	1	No	No	Yes
0	1	No	No	Yes

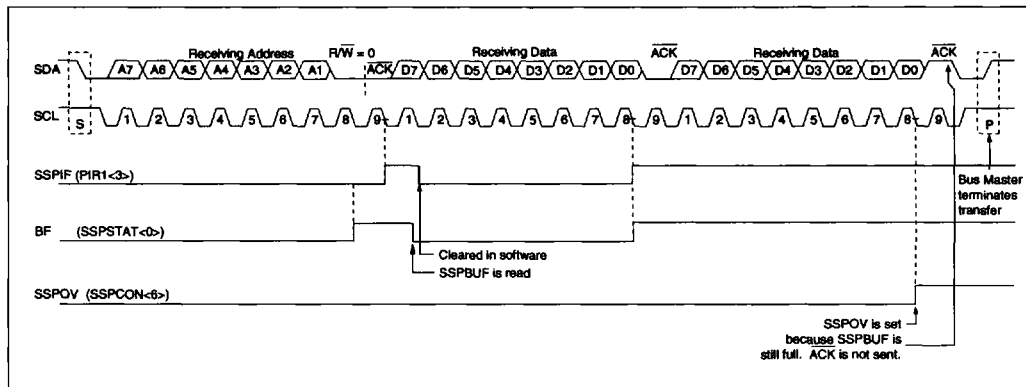
11.3.1.2 RECEPTION

When the $\overline{R/W}$ bit of the address byte is clear and an address match occurs, the $\overline{R/W}$ bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF.

When the address byte overflow condition exists then no acknowledge (\overline{ACK}) pulse is given. An overflow condition is defined as either the BF bit (SSPSTAT<0>) is set or the SSPOV bit (SSPCON<6>) is set.

A SSPIF interrupt is generated for each data transfer byte. The SSPIF bit must be cleared in software, and the SSPSTAT register is used to determine the status of the byte.

FIGURE 11-18: I²C WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)



11.3.1.3 TRANSMISSION

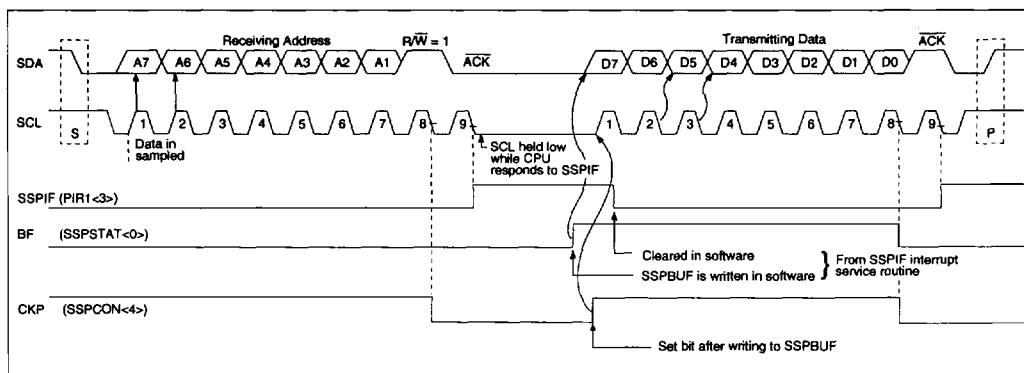
When the $\overline{R/\overline{W}}$ bit of the address byte is set and an address match occurs, the $\overline{R/\overline{W}}$ bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF. The ACK pulse will be sent on the ninth bit, and the SCL pin is held low. The transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then the SCL pin should be enabled by setting the CKP bit (SSPCON<4>). The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (see Figure 11-19).

A SSPIF interrupt is generated for each data transfer byte. The SSPIF bit must be cleared in software, and the SSPSTAT register is used to determine the status of the byte. The SSPIF bit is set on the falling edge of the ninth clock pulse.

As a slave-transmitter, the \overline{ACK} pulse from the master-receiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line was high (not ACK), then the data transfer is complete. The slave then monitors for another occurrence of the START bit. If the SDA line was low (ACK), the transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then the SCL pin should be enabled by setting the CKP bit (SSPCON<4>).



FIGURE 11-19: I²C WAVEFORMS FOR TRANSMISSION (7-BIT ADDRESS)



PIC16C64

11.3.2 Master Mode

Master mode of operation is supported by interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a reset or when the SSP module is disabled. Control of the I²C bus may be taken when the P-bit is set, or the bus is idle and both the S- and P-bits are cleared.

In master mode the SCL and SDA lines are manipulated by changing the corresponding TRISC<4:3> bit(s) to an output (cleared). The output level is always low, irrespective of the value(s) in PORTC<4:3>. So when transmitting data, a "1" data bit must have the TRISC<4> bit set (input) and a "0" data bit must have the TRISC<4> bit cleared (output). The same scenario is true for the SCL line with the TRISC<3> bit.

The following events will cause the SSP Interrupt Flag (SSPIF) to be set (SSP Interrupt if enabled):

- START condition
- STOP condition
- Data transfer byte transmitted/received

Master mode of operation can be done with either the slave mode idle (SSPM3 - SSPM0 = 1011) or with the slave active. When both master and slave modes are enabled, the software needs to differentiate the source(s) of the interrupt.

11.3.3 Multi-master Mode

In multi-master mode, the interrupt generation on the detection of the START and STOP conditions allows the determination of when the bus is free. The STOP (P) and START (S) bits are cleared from a reset or when the SSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is idle and both the S and P bits are cleared. When the bus is busy, enabling the SSP Interrupt will generate the interrupt when the stop condition occurs.

In multi-master operation, the SDA line must be monitored to see if the signal level is the expected output level. This check only needs to be done when a high level is output. If a high level is expected and a low level is present, the device needs to release the SDA and SCL lines (set TRISC<4:3>). There are two stages where this arbitration can be lost, these are:

- Address Transfer
- Data Transfer

When the slave logic is enabled, the slave continues to receive. If arbitration was lost during the address transfer stage, the device may be being addressed. If addressed an ACK pulse will be generated. If arbitration was lost during the data transfer stage, the device will need to re-transfer the data at a later time.

TABLE 11-4: REGISTERS ASSOCIATED WITH I²C OPERATION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0B/8B	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF
0C	PIR1	PSPIF	---	---	---	SSPIF	CCP1IF	TMR2IF	TMR1IF
8C	PIE1	PSPIE	---	---	---	SSPIE	CCP1IE	TMR2IE	TMR1IE
13	SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register							
93	SSPAD	Synchronous Serial Port (I ² C mode) Address Register							
14	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0
94	SSPSTAT	---	---	D/A	P	S	R/W	UA	BF

Legend --- = Unimplemented locations, Read as '0'

Note: Shaded boxes are not used by the SSP module in I²C mode.

FIGURE 11-20: OPERATION OF THE I²C MODULE IN IDLE_MODE, RCV_MODE OR XMIT_MODE

<pre> IDLE_MODE (7-bit): if (Addr_match) { Set interrupt; if (R/W = 1) {Send \overline{ACK} = 0; set XMIT_MODE; } else if ($\overline{R/W}$ = 0) set RCV_MODE; } </pre>
<pre> RCV_MODE: if ((SSPBUF=Full) OR (SSPOV = 1)) {Set SSPOV; Do not acknowledge; } else { transfer SSPSR → SSPBUF; send \overline{ACK} = 0; } Receive 8-bits in SSPSR; Set interrupt; </pre>
<pre> XMIT_MODE: While ((SSPBUF = Empty) AND (CKP=0)) Hold SCL Low; Send byte; Set interrupt; if (\overline{ACK} Received = 1) (End of transmission; Go back to IDLE_MODE;) else if (\overline{ACK} Received = 0) Go back to XMIT_MODE; </pre>
<pre> IDLE_MODE (10-Bit): If (High_byte_addr_match AND (R/W = 0)) { PRIOR_ADDR_MATCH = FALSE; Set interrupt; if ((SSPBUF = Full) OR ((SSPOV = 1)) { Set SSPOV; Do not acknowledge; } else { Set UA = 1; Send \overline{ACK} = 0; While (SSPADD not updated) Hold SCL low; Clear UA = 0; Receive Low_addr_byte; Set interrupt; Set UA = 1; If (Low_byte_addr_match) { PRIOR_ADDR_MATCH = TRUE; Send \overline{ACK} = 0; while (SSPADD not updated) Hold SCL low; Clear UA = 0; Set RCV_MODE; } } } else if (High_byte_addr_match AND (R/W = 1)) { if (PRIOR_ADDR_MATCH) { send \overline{ACK} = 0; set XMIT_MODE; } else PRIOR_ADDR_MATCH = FALSE; } </pre>

2

12.0 SPECIAL FEATURES OF THE CPU

What sets apart a microcontroller from other processors are special circuits to deal with the needs of real time applications. The PIC16CXX family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

1. OSC selection
2. Reset
 - Power-On Reset (POR)
 - Power-Up Timer (PWRT)
 - Oscillator Start-Up Timer (OST)
3. Interrupts
4. Watchdog Timer (WDT)
5. SLEEP
6. Code protection
7. In-circuit serial programming

The PIC16CXX has a Watchdog Timer which can be shut off only through EPROM fuses. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the oscillator start-up timer (OST), intended to keep the chip in reset until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72ms (nominal) on power-up only, designed to keep the part in reset while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

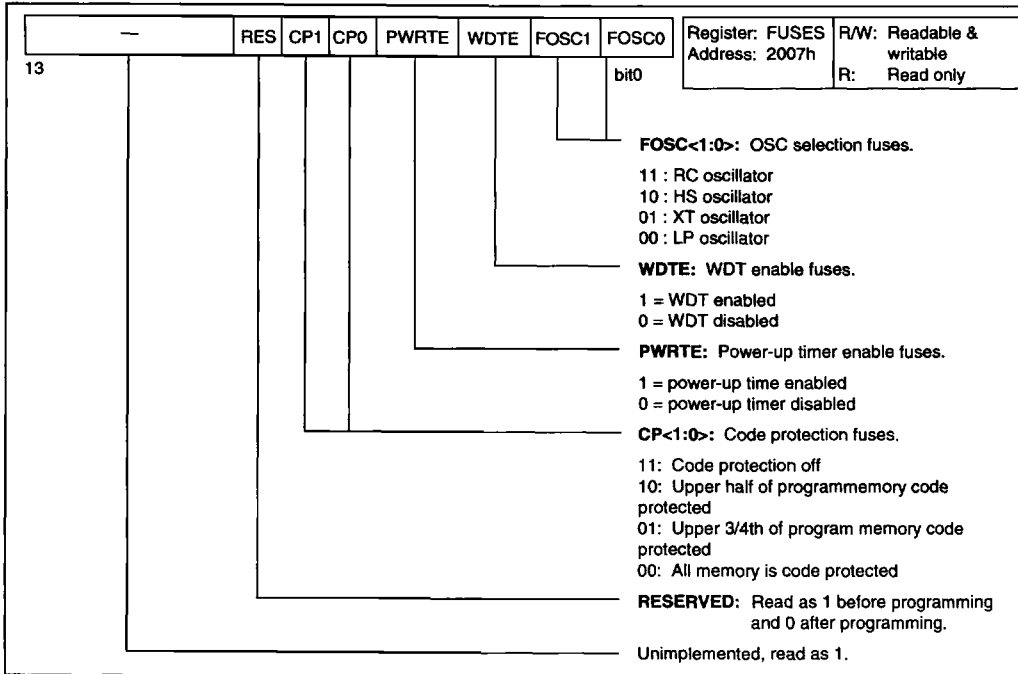
The SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through external reset, Watchdog Timer timeout or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of EPROM configuration bits (fuses) are used to select various options.

12.1 Configuration Fuses

The PIC16CXX has six configuration fuses which are EPROM bits. These fuses can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h - 3FFFh), which can be accessed during programming.

FIGURE 12-1: CONFIGURATION WORD



12.2 Oscillator Configurations

12.2.1 OSCILLATOR TYPES

The PIC16CXX can be operated in four different oscillator options. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal
- HS High Speed Crystal
- RC Resistor/Capacitor

12.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation (Figure 12-2). The PIC16CXX Oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1 pin. This is shown in Figure 12-3.

FIGURE 12-2: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (HS, XT OR LP OSC CONFIGURATION)

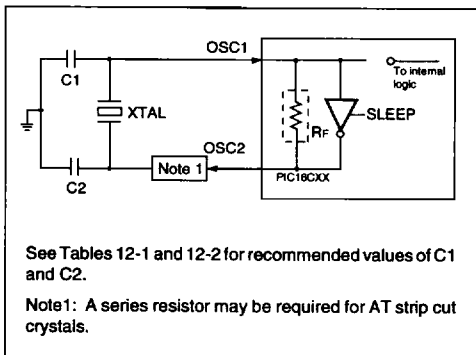


FIGURE 12-3: EXTERNAL CLOCK INPUT OPERATION (HS, XT, or LP OSC CONFIGURATION)

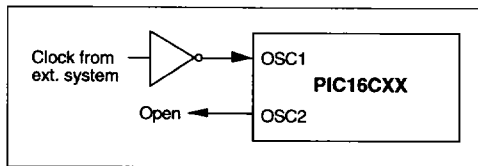


TABLE 12-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS

Oscillator Type	Resonator Frequency	Capacitor Range C1 = C2
XT	455 KHz	150 - 330 pF
	2.0 MHz	20 - 330 pF
	4.0 MHz	20 - 330 pF
HS	8.0 MHz	20 - 200 pF

Higher capacitance increases the stability of oscillator but also increases the start-up time. These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

2

TABLE 12-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Freq	C1	C2
LP	32 KHz§	15 pF	15 pF
	100 KHz	15 pF	15 pF
	200 KHz	0 - 15 pF	0 - 15 pF
XT	100 KHz	15 - 30 pF	200 - 300 pF
	200 KHz	15 - 30 pF	100 - 200 pF
	455 KHz	15 - 30 pF	15 - 100 pF
	1 MHz	15 - 30 pF	15 - 30 pF
	2 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15 pF	15 pF
	20 MHz	15 pF	15 pF

Higher capacitance increases the stability of oscillator but also increases the start-up time. These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

§ For VDD > 4.5V, C1 = C2 = 30pf is recommended.

12.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance, or one with parallel resonance.

Figure 12-4 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 kΩ resistor provides the negative feedback for stability. The 10 kΩ potentiometer biases the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 12-4: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT

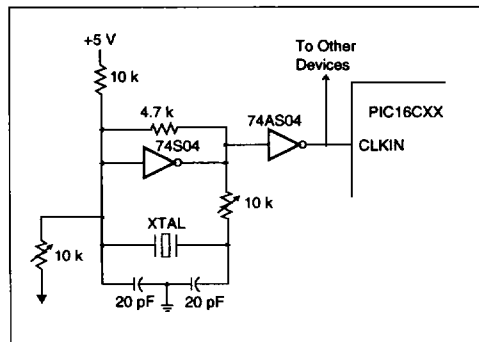
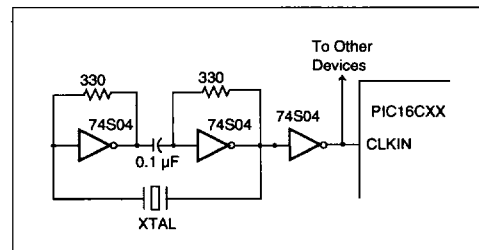


Figure 12-5 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330-Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 12-5 : EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



12.2.4 RC OSCILLATOR

For timing insensitive applications the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (R_{ext}) and capacitor (C_{ext}) values, and the operation temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low C_{ext} values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 12-6 shows how the R/C combination is connected to the PIC16CXX. For R_{ext} values below 2.2 kΩ, the oscillator operation may become unstable, or stop completely. For very high R_{ext} values (e.g. 1 MΩ), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep R_{ext} between 3 kΩ and 100 kΩ.

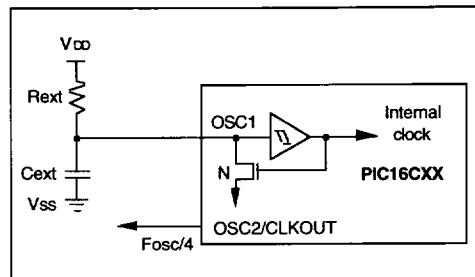
Although the oscillator will operate with no external capacitor ($C_{ext} = 0$ pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See Section 17.0 for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See Section 17.0 for variation of oscillator frequency due to V_{DD} for given R_{ext}/C_{ext} values as well as frequency variation due to operating temperature for given R, C, and V_{DD} values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (see Figure 3-2 for waveform).

FIGURE 12-6: RC OSCILLATOR MODE



12.3 Reset

The PIC16CXX differentiates between various kinds of reset:

- a) Power-On Reset (POR)
- b) $\overline{\text{MCLR}}$ Reset during normal operation
- c) $\overline{\text{MCLR}}$ reset during SLEEP
- d) WDT time-out reset during normal operation
- e) WDT time-out reset during SLEEP

Some registers are not affected in any reset condition; their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a "reset state" on power-on reset (POR), on $\overline{\text{MCLR}}$ or WDT reset during normal operation and on $\overline{\text{MCLR}}$ reset during SLEEP. They are not affected by a WDT reset during SLEEP, since this reset is viewed as the resumption of normal operation. TO and PD bits are set or cleared differently in different reset situations as indicated in Table 12-4. These bits are used in software to determine the nature of reset. See Table 12-6 for a full description of reset states of all registers.

A simplified block diagram of the on-chip reset circuit is shown in Figure 12-7.

12.4 Power-On Reset (POR), Power-Up-Timer (PWRT) and Oscillator Start-up Timer (OST)

12.4.1 Power-On Reset (POR)

A Power-On Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.6V - 1.8V). To take advantage of the POR, just tie $\overline{\text{MCLR}}$ pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create Power-On Reset. A minimum rise time for VDD is required. See Electrical Specifications for details.

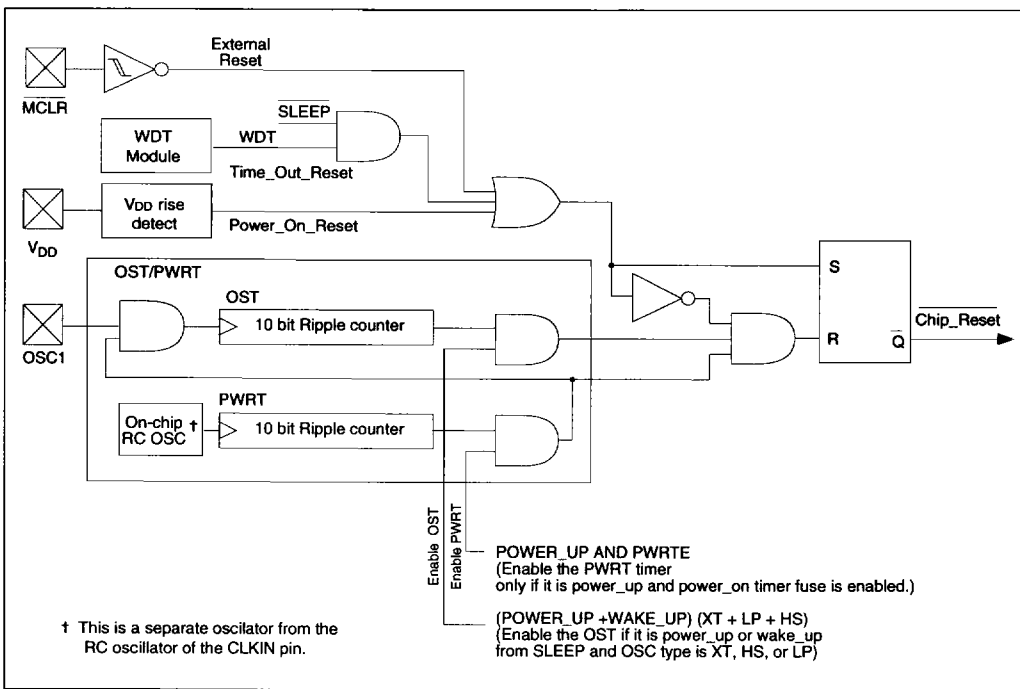
The POR circuit does not produce internal reset when VDD declines.

12.4.2 POWER-UP TIMER (PWRT)

The Power-Up Timer provides a fixed 72ms time-out on power-up only from POR. The power-up timer operates on an internal RC oscillator. The chip is kept in reset as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration fuse, PWRT_{EN} can enable (if set) or disable (if cleared or programmed) the power-up timer.

The Power-Up Time delay will vary from chip to chip and due to VDD and temperature. See the DC Parameters section for details.

FIGURE 12-7: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



12.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This guarantees that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-On Reset or wake-up from SLEEP.

12.4.4 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First PWRT time-out is invoked after POR has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and PWRT fuse status. For example, in RC mode with PWRT fuse cleared (PWRT disabled), there will be no time-out at all. Figures 12-8 to 12-10 depict time-out sequences.

TABLE 12-3: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power up		Wake up from SLEEP
	PWRT = 1	PWRT = 0	
XT, HS, LP	72 ms + 1024 tosc	1024 tosc	1024 tosc
RC	72 ms	—	—

Since the time-outs occur from POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (see Figure 12-9). This is useful for testing purposes or to synchronize more than one PIC16CXX device operating in parallel.

Table 12-5 shows the reset conditions for some special registers, while Table 12-6 shows the reset conditions for all the registers.

12.4.1 POWER CONTROL/STATUS REGISTER (PCON)

The power control/status register, PCON (address 8Eh) has only one bit.

Bit1 is $\overline{\text{POR}}$ (Power-on-reset). It is cleared on power-on-reset and unaffected otherwise. The user must set this bit following power-on-reset. On a subsequent reset if $\overline{\text{POR}}$ is 'cleared, it will indicate that a Power-On Reset must have occurred (V_{DD} may have gone too low).

TABLE 12-4: STATUS BITS AND THEIR SIGNIFICANCE

POR	$\overline{\text{TO}}$	$\overline{\text{PD}}$	
0	1	1	Power-on-reset
0	0	X	Illegal, $\overline{\text{TO}}$ is set on POR
0	X	0	Illegal, $\overline{\text{PD}}$ is set on POR
1	0	1	WDT reset during normal operation
1	0	0	WDT timeout wakeup from SLEEP
1	1	1	$\overline{\text{MCLR}}$ reset during normal operation
1	1	0	$\overline{\text{MCLR}}$ reset during SLEEP or interrupt wake-up from SLEEP

TABLE 12-5: RESET CONDITION FOR SPECIAL REGISTERS

	PCL Addr: 02h	STATUS Addr: 03h	PCON Addr: 8Eh
Power-On Reset	000h	0001 1xxx	---- --0-
$\overline{\text{MCLR}}$ reset during normal operation	000h	0001 1uuu	---- --u-
$\overline{\text{MCLR}}$ reset during SLEEP	000h	0001 0uuu	---- --u-
WDT reset during normal operation	000h	0000 1uuu	---- --u-
WDT during SLEEP	PC + 1	uuu0 0uuu	---- --u-
Interrupt wake-up from SLEEP	PC + 1 (1)	uuu1 0uuu	---- --u-

Legend: u = unchanged
 x = unknown
 - = unimplemented bit, reads as '0'

Notes: 1. When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

TABLE 12-6: RESET CONDITION FOR REGISTERS

Register	Address	• Power-on Reset	• MCLR Reset during: - normal operation - SLEEP • WDT timeout during normal operation	• Wake up from SLEEP through interrupt • Wake up from SLEEP through WDT timeout
W	-	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	00h	-	-	-
TMR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PC	02h	0000h	0000h	PC + 1 (2)
STATUS	03h	0001 1xxx	000? ?uuu (3)	uuu? ?uuu (3)
FSR	04h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	05h	--xx xxxx	--uu uuuu	--uu uuuu
PORTB	06h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	07h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTD	08h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTE	09h	---- -xxx	---- -uuu	---- -uuu
PCLATH	0Ah	---0 0000	---0 0000	---u uuuu
INTCON	0Bh	0000 000x	0000 0000	uuuu uuuu (1)
PIR1	0Ch	0--- 0000	0--- 0000	u--- uuuu (1)
TMR1L	0Eh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1H	0Fh	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	10h	--00 0000	--uu uuuu	--uu uuuu
TMR2	11h	xxxx xxxx	uuuu uuuu	uuuu uuuu
T2CON	12h	-000 0000	-000 0000	-uuu uuuu
SSPBUF	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPCON	14h	0000 0000	0000 0000	uuuu uuuu
CCPR1L	15h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H	16h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	17h	--00 0000	--00 0000	--uu uuuu
INDF	80h	-	-	-
OPTION	81h	1111 1111	1111 1111	uuuu uuuu
PC	82h	0000h	0000h	PC + 1
STATUS	83h	0001 1xxx	000? ?uuu (3)	uuu? ?uuu (3)
FSR	84h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TRISA	85h	--11 1111	--11 1111	--uu uuuu
TRISB	86h	1111 1111	1111 1111	uuuu uuuu
TRISC	87h	1111 1111	1111 1111	uuuu uuuu
TRISD	88h	1111 1111	1111 1111	uuuu uuuu
TRISE	89h	0000 -111	0000 -111	uuuu -uuu
PCLATH	8Ah	---0 0000	---0 0000	---u uuuu
INTCON	8Bh	0000 000x	0000 0000	uuuu uuuu (1)
PIE1	8Ch	0--- 0000	0--- 0000	u--- uuuu
PCON	8Eh	---- --0-	---- --1-	---- --1-
PR2	92h	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPADD	93h	0000 0000	0000 0000	uuuu uuuu
SSPSTAT	94h	--00 0000	--00 0000	--uu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', ? = value depends on condition

- Notes:
1. One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).
 2. When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).
 3. See Table 12-5 for reset value for specific condition.

2

PIC16C64

FIGURE 12-8 : TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): Case 1

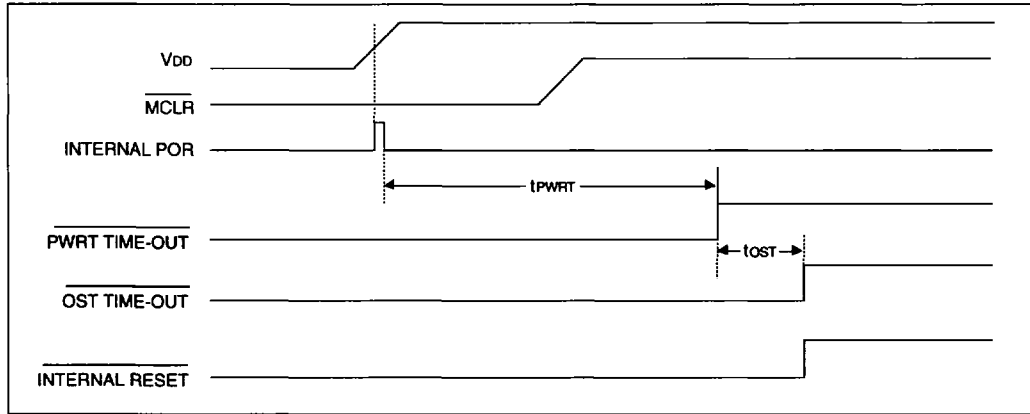


FIGURE 12-9: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): Case 2

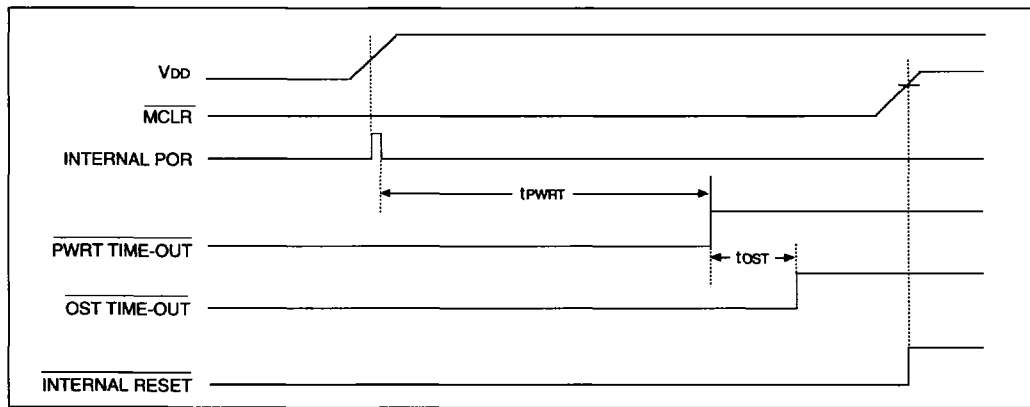


FIGURE 12-10: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO V_{DD})

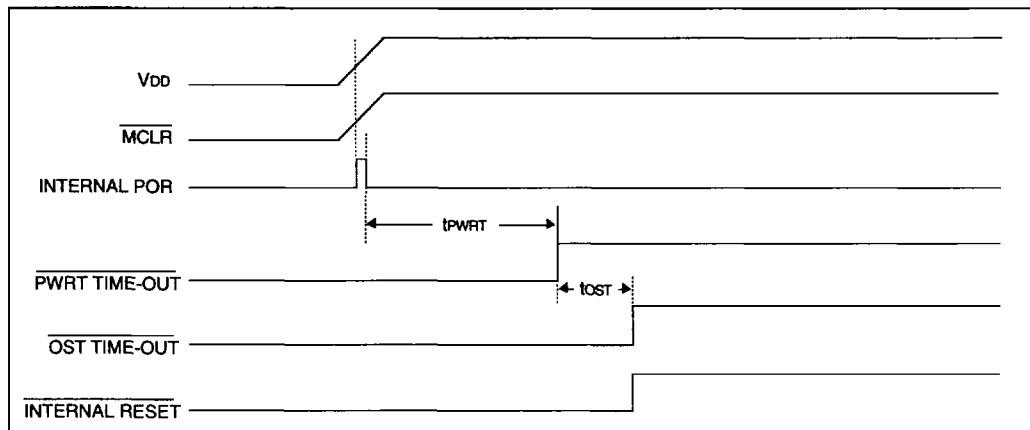
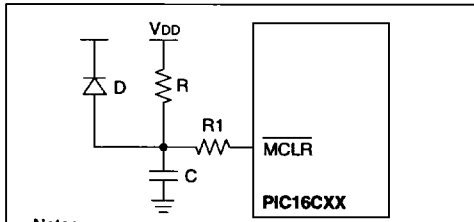


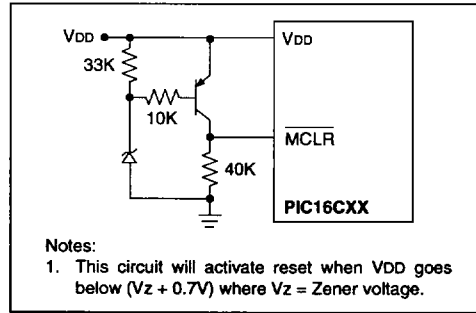
FIGURE 12-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



Notes:

1. External power-on reset circuit is required only if VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
2. $R < 40K\Omega$ is recommended to make sure that voltage drop across R does not exceed 0.2V (max leakage current spec on MCLR pin is 5 μ A). A larger voltage drop will degrade V_{IH} level on MCLR pin.
3. $R1 = 100\Omega$ to $1K\Omega$ will limit any current flowing into MCLR from external capacitor C in the event of MCLR pin breakdown due to ESD or EOS.

FIGURE 12-12: BROWN-OUT PROTECTION CIRCUIT 1

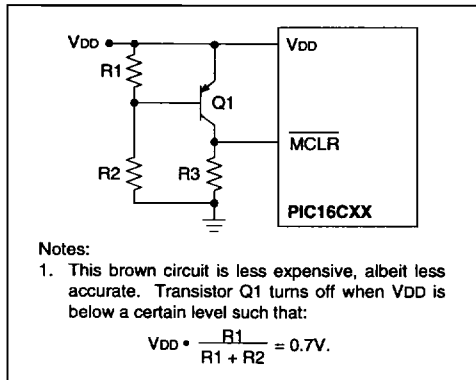


Notes:

1. This circuit will activate reset when VDD goes below $(V_z + 0.7V)$ where $V_z =$ Zener voltage.

2

FIGURE 12-13: BROWN-OUT PROTECTION CIRCUIT 2



Notes:

1. This brown circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \cdot \frac{R1}{R1 + R2} = 0.7V.$$

12.5 Interrupts

The PIC16C64 has eight sources of interrupt:

- External interrupt RB0/INT
- RTCC timer/counter overflow interrupt
- PortB change interrupts (pins RB<7:4>)
- Timer1 overflow interrupt
- Timer2 interrupt
- CCP1 interrupt
- Sync serial port interrupt
- Microprocessor port read/write interrupt

The interrupt control register (INTCON, addr0Bh) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

A global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding enable bits in INTCON register. GIE is cleared on reset.

The RETFIE instruction allows user to return from interrupt and enable interrupt at the same time.

The INT pin interrupt, the RB port change interrupt and the RTCC overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flags are contained in the special register PIR1 (0Ch). The corresponding interrupt enable bits are contained in special registers PIE1 (8Ch).

When an interrupt is responded to, the GIE is cleared to disable any further interrupt, the return address is pushed into the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

Note 1: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

Note 2: If an interrupt occurs while the Global Interrupt Enable (GIE) bit is being cleared, the GIE bit may unintentionally be re-enabled by the user's Interrupt Service Routine (the RETFIE instruction). The events that would cause this to occur are:

1. An instruction clears the GIE bit while an interrupt is acknowledged.
2. The program branches to the interrupt vector and executes the interrupt Service Routine.
3. The interrupt Service Routine completes with the execution of the RETFIE instruction. This causes the GIE bit to be set (enables interrupts), and the program returns to the instruction after the one which was meant to disable interrupts.

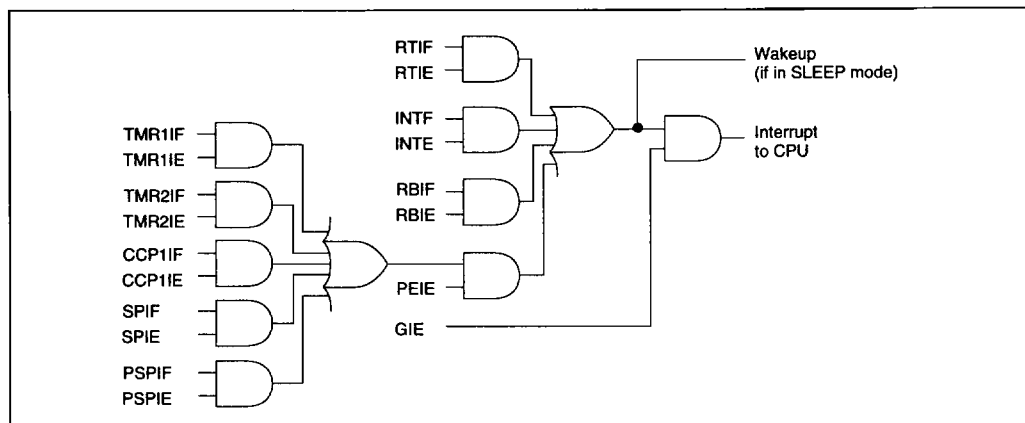
The method to ensure that interrupts are globally disabled is:

1. Ensure that the GIE bit was cleared by the instruction, as shown in the following code:

```

LOOP BCF INTCON, GIE ; Disable Global
      ; Interrupts
      BTFSC INTCON, GIE ; Global Interrupts
      ; Disabled?
      GOTO LOOP ; NO, try again
      ; Yes, continue
      ; with program
      ; flow
    
```

FIGURE 12-14: INTERRUPT LOGIC



12.5.1 INT INTERRUPT

External interrupt on RBO/INT pin is edge triggered: either rising if INTEDG bit (OPTION<6>) is set, or falling, if INTEDG bit is clear. When a valid edge appears on INT pin, the INTF bit (INTCON<1>) is set. This interrupt can be disabled by clearing the INTE control bit (INTCON<4>). INTF bit must be cleared in software in the interrupt service routine before re-enabling this interrupt. The INT interrupt can wake up the processor from SLEEP, if the INTE bit was set prior to going into SLEEP. The status of the GIE bit decides whether or not the processor branches to the interrupt vector following wake-up. See Section 12.8 for details on SLEEP and Figure 12-16 for timing of wake-up from SLEEP through INT interrupt.

12.5.2 TMR0 INTERRUPT

An overflow (FFh → 00h) in the TMR0 will set the TOIF (INTCON<2>) bit. The interrupt can be enabled/disabled by setting/clearing TOIE (INTCON<5>) bit. For operation of the TMR0 module, see Section 7.0.

12.5.3 PORT RB INTERRUPT

An input change on PORTB <7:4> will set the RBIF (INTCON<0>) bit. The interrupt can be enabled/disabled by setting/clearing the RBIE (INTCON<4>) bit. For operation of PORTB, see Section 5.2.

12.6 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt e.g. W register and status register. This will have to be implemented in software.

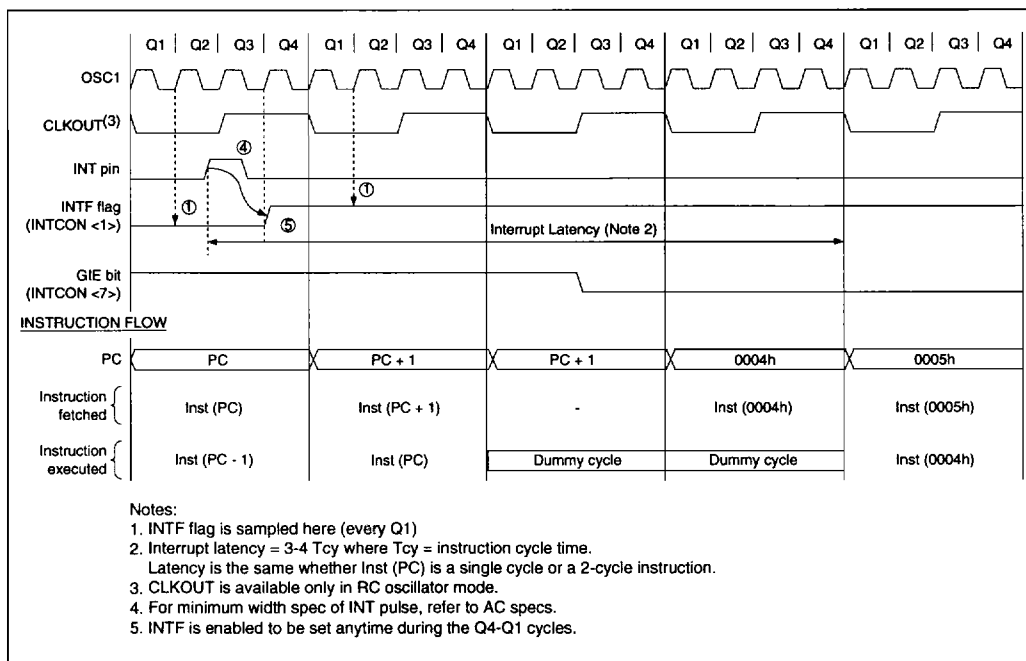
EXAMPLE 12-1: SAVING W REGISTER AND STATUS IN RAM:

```

push:  movwf  temp_w      ; Saving Values
       swapf STATUS,W   ;
       movwf temp_stat   ;
       :               ; Interrupt
       :               ; Service Routine
pop:   swapf  temp_stat,W ; Restoring
       :               ; Values
       movwf STATUS     ;
       swapf temp_w, F   ; Do not want to
       swapf temp_w, W   ; affect the
                          ; z-bit
    
```



FIGURE 12-15: INT PIN INTERRUPT TIMING



12.7 Watchdog Timer (WDT)

The watchdog timer is realized as a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT timeout generates a device RESET. If the device is in SLEEP mode, a WDT timeout causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration fuse WDTE as a '0' (Section 12.1).

12.7.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the prescaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition.

The \overline{TO} bit in the STATUS register will be cleared upon a watchdog timer time-out.

12.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler) it may take several seconds before a WDT time-out occurs.

FIGURE 12-16: WATCHDOG TIMER BLOCK DIAGRAM

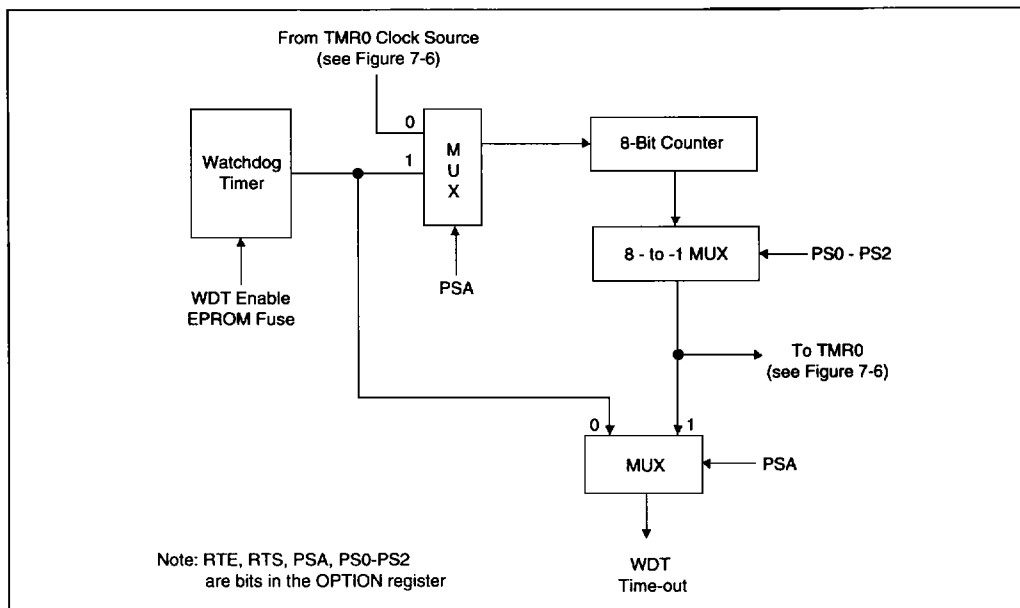


FIGURE 12-17: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
2007	Config. Fuses	—	—	CPI	CP0	PWRT	WDTE	FOSC1	FOSC0
81	OPTION	RBPU	INTEDG	RTS	RTE	PSA	PS2	PS1	PS0

12.8 Power-Down Mode (SLEEP)

The Power-Down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit in the STATUS register is cleared, the TO bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before the SLEEP command was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD, or VSS, with no external circuitry drawing current from the I/O pin. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The RTCC input should also be at VDD or VSS for lowest current consumption. The contribution from on chip pull-ups on PortB should be considered.

The MCLR pin must be at a logic high level (VIHMC).

It should be noted that a RESET generated by a WDT time-out does not drive MCLR pin low.

14.8.1 WAKE-UP FROM SLEEP

The device can wake up from SLEEP through one of the following events:

1. External reset input on MCLR pin
2. Watchdog timer time-out reset (if WDT was enabled)
3. Interrupt from INT pin, RB port change, TMR0 overflow, or some Peripheral Interrupts.

The following peripheral interrupts can wake-up from SLEEP:

1. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
2. SSP Start/Stop bit detect interrupt.

3. CCP capture mode interrupt.
4. Slave port read or write.

Other peripherals can not generate interrupts since during SLEEP, no on-chip Q clocks are present.

The first event will cause a device reset. The two latter events are considered a continuation of program execution. The TO and PD bits in the STATUS register can be used to determine the cause of device reset. PD bit, which is set on power-up is cleared when SLEEP is invoked. TO bit is cleared if WDT time-out occurred (and caused wake-up).

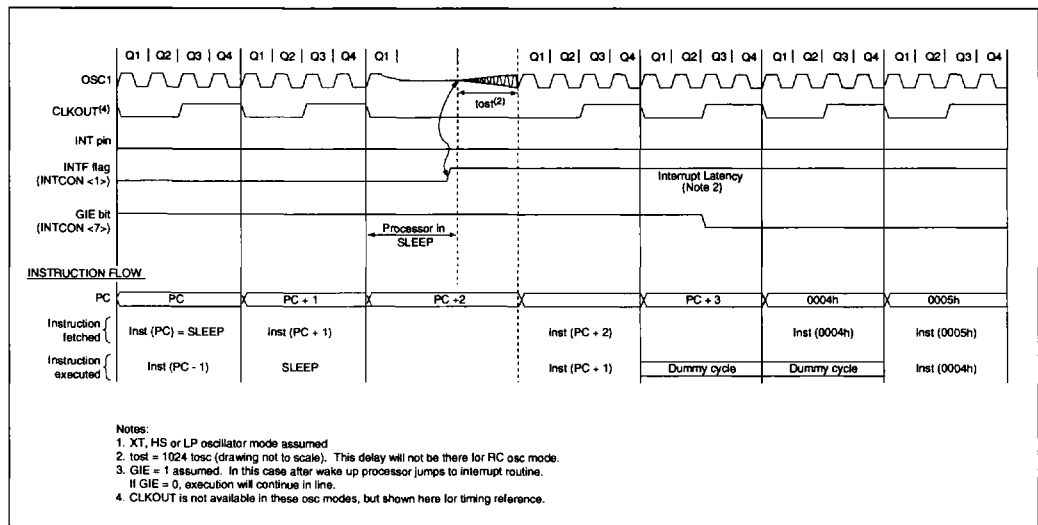
When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and the branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.



Note: If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wake from sleep.

The WDT is cleared when the device wakes-up from sleep, regardless of the source of wake-up.

FIGURE 12-18: WAKE-UP FROM SLEEP THROUGH INTERRUPT



12.9 Code Protection

The code in the program memory can be protected by blowing the code protect fuses (CP<1:0>).

When code protected, the contents of the program memory cannot be read out in a way that the program code can be reconstructed.

In code-protected mode, the configuration word (2007h) will not be scrambled, allowing reading of all fuses.

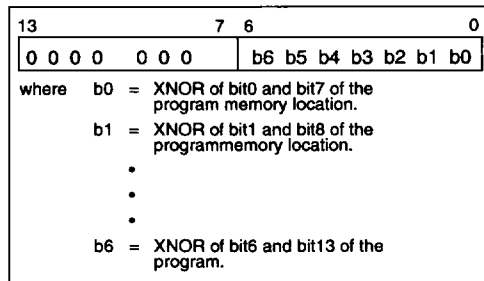
12.9.1 CODE PROTECTION FUSES:

The PIC16/17 microcontroller code protection scheme has been enhanced. These enhancements allow the user to selectively code protect portions of the program memory. The two code protect fuses (CP<1:0>) allow the selection of the following code protection mappings:

- 11 Program memory not code protected
- 01 Upper 3/4 of program memory code protected (200h - 7FF)
- 10 Upper 1/2 of program memory code protected (400h - 7FF)
- 00 Entire program memory code protected

Any word of a protected memory section will read out a scrambled version as shown in Figure 12-17:

FIGURE 12-19: PROTECTED MEMORY READ FORMAT



The configuration word is not code protected, and therefore no scrambling is done. Unprotected segments read normally. Once the program memory location(s) have been code protected, those memory locations can not be further programmed.

12.9.2 VERIFYING A CODE-PROTECTED PART

When code protected, verifying any program memory location will read a scrambled output which looks like "000000xxxxxx" (binary) where X is 1 or 0. To verify a device after code protection, follow this procedure:

1. First, program and verify a good device without code protecting it.
2. Next, blow its code protection fuse and then load its contents in a file.
3. Verify any code-protected PIC16C64 against this file.

12.10 In-Circuit Serial Programming

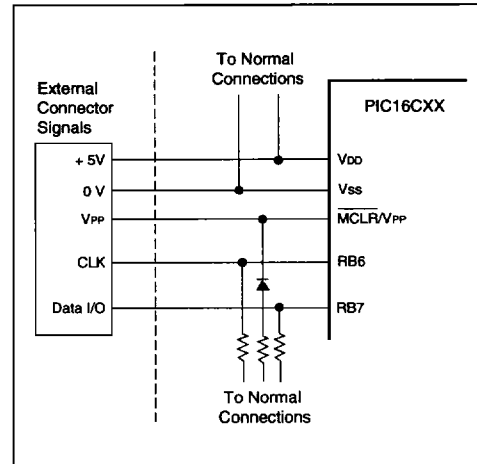
The PIC16CXX microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data and three other lines for power, ground and programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This allows the most recent firmware or a custom firmware to be programmed.

The device is placed into a program/verify mode by holding the RB6 and RB7 pins low while raising the MCLR (Vpp) pin from V_{il} to V_{ih}. RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are schmidt trigger inputs in this mode.

After reset, to place the device into programming/verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14-bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC16C6X/7X Programming Specifications (Literature #DS30153).

A typical in-system serial programming connection is shown in Figure 12-18.

FIGURE 12-20: TYPICAL IN-SYSTEM SERIAL PROGRAMMING CONNECTION



13.0 INSTRUCTION SET SUMMARY

Each PIC16CXX instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16CXX instruction set summary in Table 13-2 lists byte-oriented, bit-oriented, and literal and control operations. Table 13-1 shows the opcode field descriptions.

For byte-oriented instructions, "f" represents a file register designator and "d" represents a destination designator. The file register designator specifies which file register is to be utilized by the instruction.

The destination designator specifies where the result of the operation is to be placed. If "d" is zero, the result is placed in the W register. If "d" is one, the result is placed in the file register specified in the instruction.

For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while "f" represents the number of the file in which the bit is located.

For literal and control operations, "k" represents an 8- or 11-bit constant or literal value.

TABLE 13-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
w	Working register (accumulator)
b	Bit address within an 8 bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLATH	Program Counter High Latch
GIE	Global Interrupt Enable Bit
WDT	Watchdog Timer Counter
TO	Time-out Bit
PD	Power-down Bit
dest	Destination either the W register or the specified register file location
[]	Options
()	Contents
→	Assigned to
< >	Register bit field
∈	In the set of
<i>italics</i>	User defined term

The instruction set is highly orthogonal and is grouped into three basic categories:

- Byte oriented operations
- Bit oriented operations
- Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 µsec. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 µsec.

Table 13-2 lists the instructions recognized by the MPASM assembler.

Figure 13-1 shows the three general formats that the instructions can have.

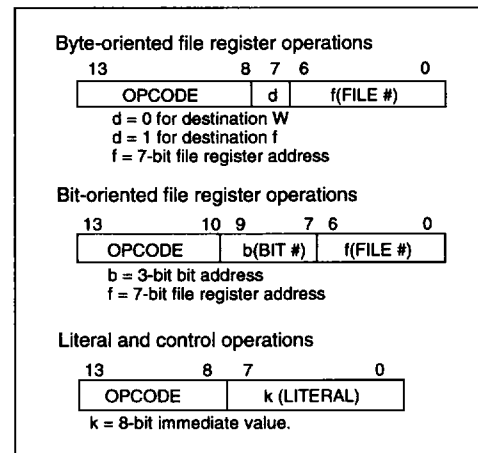
Note: To maintain upward compatibility with future PIC16CXX products, do not use the OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

0xh

where h signifies a hexadecimal digit.

FIGURE 13-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16C64

TABLE 13-2: INSTRUCTION SET

Mnemonic, Operands	Description	Cycles	14-Bit Opcode		Status Affected	Notes
			msb	lsb		
BYTE-ORIENTED FILE REGISTER OPERATIONS						
ADDWF f, d	Add W and f	1	00	0111 dfff ffff	C, DC, Z	1, 2
ANDWF f, d	AND W and f	1	00	0101 dfff ffff	Z	1, 2
CLRF f	Clear f	1	00	0001 1fff ffff	Z	2
CLRWF -	Clear W	1	00	0001 0xxx xxxx	Z	
COMF f, d	Complement f	1	00	1001 dfff ffff	Z	1, 2
DECF f, d	Decrement f	1	00	0011 dfff ffff	Z	1, 2
DECFSZ f, d	Decrement f, Skip if 0	1 (2)	00	1011 dfff ffff		1, 2, 3
INCF f, d	Increment f	1	00	1010 dfff ffff	Z	1, 2
INCFSZ f, d	Increment f, Skip if 0	1 (2)	00	1111 dfff ffff		1, 2, 3
IORWF f, d	Inclusive OR W and f	1	00	0100 dfff ffff	Z	1, 2
MOVF f, d	Move f	1	00	1000 dfff ffff	Z	1, 2
MOVWF f	Move W to f	1	00	0000 1fff ffff		
NOP -	No Operation	1	00	0000 0xx0 0000		
RLF f, d	Rotate left f through carry	1	00	1101 dfff ffff	C	1, 2
RRF f, d	Rotate right f through carry	1	00	1100 dfff ffff	C	1, 2
SUBWF f, d	Subtract W from f	1	00	0010 dfff ffff	C, DC, Z	1, 2
SWAPF f, d	Swap halves f	1	00	1110 dfff ffff		1, 2
XORWF f, d	Exclusive OR W and f	1	00	0110 dfff ffff	Z	1, 2
BIT-ORIENTED FILE REGISTER OPERATIONS						
BCF f, b	Bit Clear f	1	01	00bb bfff ffff		1, 2
BSF f, b	Bit Set f	1	01	01bb bfff ffff		1, 2
BTFSZ f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb bfff ffff		3
BTFSZ f, b	Bit Test f, Skip if Set	1 (2)	01	11bb bfff ffff		3
LITERAL AND CONTROL OPERATIONS						
ADDLW k	Add literal to W	1	11	111x kkkk kkkk	C, DC, Z	
ANDLW k	AND literal to W	1	11	1001 kkkk kkkk	Z	
CALL k	Call subroutine	2	10	0kkk kkkk kkkk		
CLRWDT -	Clear watchdog timer	1	00	0000 0110 0100	\overline{TO} , \overline{PD}	
GOTO k	Go to address	2	10	1kkk kkkk kkkk		
IORLW k	Inclusive OR literal to W	1	11	1000 kkkk kkkk	Z	
MOVLW k	Move literal to W	1	11	00xx kkkk kkkk		
RETIE -	Return from interrupt	2	00	0000 0000 1001		
RETLW k	Return with literal in W	2	11	01xx kkkk kkkk		
RETURN -	Return from subroutine	2	00	0000 0000 1000		
SLEEP -	Go into standby mode	1	00	0000 0110 0011	\overline{TO} , \overline{PD}	
SUBLW k	Subtract W from literal	1	11	110x kkkk kkkk	C, DC, Z	
XORLW k	Excl. OR literal to W	1	11	1010 kkkk kkkk	Z	

- Notes: 1. When an I/O register is modified as a function of itself (e.g. MOVF PORTB, 1) the value used will be that value present on the pins themselves. For example, if the data latch is "1" for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
2. If this instruction is executed on the TMR0 register (and, where applicable, d=1), the prescaler will be cleared if assigned to the TMR0.
3. If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

13.1 Instruction Descriptions

ADDLW Add Literal to W

Syntax: [*label*] ADDLW *k*
 Operands: $0 \leq k \leq 255$
 Operation: $(W) + k \rightarrow W$
 Status Affected: C, DC, Z
 Encoding:

11	111X	kkkk	kkkk
----	------	------	------

 Description: The contents of the W register are added to the 8-bit literal "k" and the result is placed in the W register.
 Words: 1
 Cycles: 1
 Example: ADDLW 0x15
 Before Instruction
 W = 0x10
 After Instruction
 W = 0x25

ANDLW AND Literal and W

Syntax: [*label*] ANDLW *k*
 Operands: $0 \leq k \leq 255$
 Operation: $(W) .AND. (k) \rightarrow W$
 Status Affected: Z
 Encoding:

11	1001	kkkk	kkkk
----	------	------	------

 Description: The contents of W register are AND'ed with the 8-bit literal "k". The result is placed in the W register.
 Words: 1
 Cycles: 1
 Example: ANDLW 0x5F
 Before Instruction
 W = 0xA3
 After Instruction
 W = 0x03



ADDWF ADD W to f

Syntax: [*label*] ADDWF *f,d*
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(W) + (f) \rightarrow (dest)$
 Status Affected: C, DC, Z
 Encoding:

00	0111	dfff	ffff
----	------	------	------

 Description: Add the contents of the W register to register "f". If "d" is 0 the result is stored in the W register. If "d" is 1 the result is stored back in register "f".
 Words: 1
 Cycles: 1
 Example: ADDWF FSR, 0
 Before Instruction
 W = 0x17
 FSR = 0xC2
 After Instruction
 W = 0xD9
 FSR = 0xC2

ANDWF AND W with f

Syntax: [*label*] ANDWF *f,d*
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(W) .AND. (f) \rightarrow dest$
 Status Affected: Z
 Encoding:

00	0101	dfff	ffff
----	------	------	------

 Description: AND the W register with register "f". If "d" is 0 the result is stored in the W register. If "d" is 1 the result is stored back in register "f".
 Words: 1
 Cycles: 1
 Example: ANDWF FSR, 1
 Before Instruction
 W = 0x17
 FSR = 0xC2
 After Instruction
 W = 0x17
 FSR = 0x02

BCF Bit Clear f

Syntax: [*label*] BCF f,b
 Operands: $0 \leq f \leq 127$
 $0 \leq b \leq 7$
 Operation: $0 \rightarrow f$
 Status Affected: None
 Encoding:

01	00bb	bfff	ffff
----	------	------	------

 Description: Bit "b" in register "f" is reset to 0.
 Words: 1
 Cycles: 1
 Example: BCF FLAG_REG, 7
 Before Instruction
 FLAG_REG = 0xC7
 After Instruction
 FLAG_REG = 0x47

BSF Bit Set f

Syntax: [*label*] BSF f,b
 Operands: $0 \leq f \leq 127$
 $0 \leq b \leq 7$
 Operation: $1 \rightarrow f$
 Status Affected: None
 Encoding:

01	01bb	bfff	ffff
----	------	------	------

 Description: Bit "b" in register "f" is set to 1.
 Words: 1
 Cycles: 1
 Example: BSF FLAG_REG, 7
 Before Instruction
 FLAG_REG = 0x0A
 After Instruction
 FLAG_REG = 0x8A

BTFSC Bit Test, skip if Clear

Syntax: [*label*] BTFSC f,b
 Operands: $0 \leq f \leq 127$
 $0 \leq b \leq 7$
 Operation: skip if (f) = 0
 Status Affected: None
 Encoding:

01	10bb	bfff	ffff
----	------	------	------

 Description: If bit 'b' in register 'f' is '0' then the next instruction is skipped.
 If bit 'b' is '0', the next instruction, fetched during the current instruction execution, is discarded and a NOP is executed instead making this a two-cycle instruction.
 Words: 1
 Cycles: 1(2)
 Example: HERE BTFSC FLAG, 1
 FALSE GOTO PROCESS_CODE
 TRUE :
 :
 :
 Before Instruction
 PC = address HERE
 After Instruction
 if FLAG<1> = 0, PC = address TRUE
 if FLAG<1> = 1, PC = address FALSE

BTFSS Bit Test, skip if Set

Syntax: [*label*] BTFSS f,b
 Operands: $0 \leq f \leq 127$
 $0 \leq b \leq 7$
 Operation: skip if (f) = 1
 Status Affected: None
 Encoding:

01	11bb	bfff	ffff
----	------	------	------

 Description: If bit "b" in register "f" is "1" then the next instruction is skipped.
 If bit "b" is "0", the next instruction, fetched during the current instruction execution, is discarded and a NOP is executed instead making this a two-cycle instruction.
 Words: 1
 Cycles: 1 (2)
 Example: HERE BTFSS FLAG, 1
 FALSE GOTO PROCESS_CODE
 TRUE :
 :
 :
 Before Instruction
 PC = address HERE
 After Instruction
 if FLAG<1> = 0, PC = address FALSE
 if FLAG<1> = 1, PC = address TRUE

CALL Subroutine Call

Syntax: [*label*] CALL k
 Operands: $0 \leq k \leq 2048$
 Operation: $(PC) + 1 \rightarrow TOS$,
 $k \rightarrow PC<10:0>$,
 $(PCLATH<4:3>) \rightarrow PC<12:11>$;
 Status Affected: None
 Encoding:

10	0kkk	kkkk	kkkk
----	------	------	------

 Description: Subroutine call. First, return address (PC+1) is pushed onto the stack. The eleven bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH (f03). CALL is a two-cycle instruction.
 Words: 1
 Cycles: 2
 Example: HERE CALL THERE
 Before Instruction
 PC = Address HERE
 After Instruction
 PC = Address THERE
 TOS = Address HERE

CLRW Clear W Register

Syntax: [*label*] CLRW
 Operands: None
 Operation: $00h \rightarrow (W)$
 $1 \rightarrow Z$
 Status Affected: Z
 Encoding:

00	0001	0XXX	XXXX
----	------	------	------

 Description: W register is cleared. Zero bit (Z) is set.
 Words: 1
 Cycles: 1
 Example: CLRW
 Before Instruction
 W = 0x5A
 After Instruction
 W = 0x00
 Z = 1

CLRF Clear f

Syntax: [*label*] CLRF f
 Operands: $0 \leq f \leq 127$
 Operation: $00h \rightarrow f$
 $1 \rightarrow Z$
 Status Affected: Z
 Encoding:

00	0001	1fff	ffff
----	------	------	------

 Description: The contents of register "f" are cleared and the Z bit is set.
 Words: 1
 Cycles: 1
 Example: CLRF FLAG_REG
 Before Instruction
 FLAG_REG = 0x5A
 After Instruction
 FLAG_REG = 0x00
 Z = 1

CLRWDT Clear Watchdog Timer

Syntax: [*label*] CLRWDT
 Operands: None
 Operation: $00h \rightarrow WDT$,
 $0 \rightarrow WDT$ prescaler,
 $1 \rightarrow \overline{TO}$
 $1 \rightarrow \overline{PD}$
 Status Affected: \overline{TO} , \overline{PD}
 Encoding:

00	0000	0110	0100
----	------	------	------

 Description: CLRWDT instruction resets the watchdog timer. It also resets the prescaler of the WDT. Status bits \overline{TO} and \overline{PD} are set.
 Words: 1
 Cycles: 1
 Example: CLRWDT
 Before Instruction
 WDT counter = ?
 After Instruction
 WDT counter = 0x00
 WDT prescale = 0
 $\overline{TO} = 0$
 $\overline{PD} = 0$

PIC16C64

COMF **Complement f**

Syntax: [*label*] COMF *f*,*d*
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $\overline{(f)} \rightarrow (\text{dest})$
 Status Affected: Z
 Encoding:

00	1001	dfff	ffff
----	------	------	------

 Description: The contents of register "f" are complemented. If "d" is 0 the result is stored in W. If "d" is 1 the result is stored back in register "f".
 Words: 1
 Cycles: 1
 Example: COMF REG1, 0
 Before Instruction
 REG1 = 0x13
 After Instruction
 REG1 = 0x13
 W = 0xEC

DECF **Decrement f**

Syntax: [*label*] DECF *f*,*d*
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(f)-1 \rightarrow (\text{dest})$
 Status Affected: Z
 Encoding:

00	0011	dfff	ffff
----	------	------	------

 Description: Decrement register "f". If "d" is 0 the result is stored in the W register. If "d" is 1 the result is stored back in register "f".
 Words: 1
 Cycles: 1
 Example: DECF CNT, 1
 Before Instruction
 CNT = 0x01
 Z = 0
 After Instruction
 CNT = 0x00
 Z = 1

DECFSZ **Decrement f, skip if 0**

Syntax: [*label*] DECFSZ *f*,*d*
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(f) - 1 \rightarrow d$; skip if result = 0
 Status Affected: None
 Encoding:

00	1011	dfff	ffff
----	------	------	------

 Description: The contents of register "f" are decremented. If "d" is 0 the result is placed in the W register. If "d" is 1 the result is placed back in register "f".
 If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.
 Words: 1
 Cycles: 1 (2)
 Example: HERE DECFSZ CNT, 1
 GOTO LOOP
 CONTINUE *
 *
 *
 Before Instruction
 PC = address HERE
 After Instruction
 CNT = CNT - 1
 if CNT = 0, PC = address CONTINUE
 if CNT \neq 0, PC = address HERE + 1

GOTO **Unconditional Branch**

Syntax: [*label*] GOTO *k*
 Operands: $0 \leq k \leq 2048$
 Operation: $k \rightarrow PC<10:0>$,
 $(PCLATH<4:3>) \rightarrow PC<12:11>$
 Status Affected: None
 Encoding:

10	1kkk	kkkk	kkkk
----	------	------	------

 Description: GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH <4:3>. GOTO is a two-cycle instruction.
 Words: 1
 Cycles: 2
 Example: GOTO THERE
 After Instruction
 PC = Address of THERE

INCF Increment f

Syntax: [*label*] INCF f,d
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(f) + 1 \rightarrow (\text{dest})$
 Status Affected: Z
 Encoding:

00	1010	dfff	ffff
----	------	------	------

 Description: The contents of register "f" are incremented. If "d" is 0 the result is placed in the W register. If "d" is 1 the result is placed back in register "f".
 Words: 1
 Cycles: 1
 Example: INCF CNT, 1
 Before Instruction
 CNT = 0xFF
 Z = 0
 After Instruction
 CNT = 0x00
 Z = 1

IORLW Inclusive OR Literal with W

Syntax: [*label*] IORLW k
 Operands: $0 \leq k \leq 255$
 Operation: $(W) .OR. (k) \rightarrow (W)$
 Status Affected: Z
 Encoding:

11	1000	kkkk	kkkk
----	------	------	------

 Description: The contents of the W register are OR'ed with the eight bit literal "k". The result is placed in the W register.
 Words: 1
 Cycles: 1
 Example: IORLW 0x35
 Before Instruction
 W = 0x9A
 After Instruction
 W = 0xBF

INCFSZ Increment f, skip if 0

Syntax: [*label*] INCFSZ f,d
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(f) + 1 \rightarrow (\text{dest})$, skip if result = 0
 Status Affected: None
 Encoding:

00	1111	dfff	ffff
----	------	------	------

 Description: The contents of register "f" are incremented. If "d" is 0 the result is placed in the W register. If "d" is 1 the result is placed back in register "f".
 If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two cycle instruction.
 Words: 1
 Cycles: 1 (2)
 Example: HERE INCFSZ CNT, 1
 GOTO LOOP
 CONTINUE .
 .
 .
 Before Instruction
 PC = address HERE
 After Instruction
 CNT = CNT + 1
 if CNT = 0, PC = address CONTINUE
 if CNT \neq 0, PC = address HERE + 1

IORWF Inclusive OR W with f

Syntax: [*label*] IORWF f,d
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $(W) .OR. (f) \rightarrow (\text{dest})$
 Status Affected: Z
 Encoding:

00	0100	dfff	ffff
----	------	------	------

 Description: Inclusive OR the W register with register "f". If "d" is 0 the result is stored in the W register. If "d" is 1 the result is stored back in register "f".
 Words: 1
 Cycles: 1
 Example: IORWF RESULT, 0
 Before Instruction
 RESULT = 0x13
 W = 0x91
 After Instruction
 RESULT = 0x13
 W = 0x93

PIC16C64

MOVLW **Move Literal to W**

Syntax: [*label*] MOVLW *k*
Operands: $0 \leq k \leq 255$
Operation: $k \rightarrow (W)$
Status Affected: None
Encoding:

11	00XX	kkkk	kkkk
----	------	------	------

Description: The 8-bit literal "k" is loaded into W register.
Words: 1
Cycles: 1
Example: MOVLW 0x5A
 After Instruction
 W = 0x5A

MOVWF **Move W to f**

Syntax: [*label*] MOVWF *f*
Operands: $0 \leq f \leq 127$
Operation: $(W) \rightarrow (f)$
Status Affected: None
Encoding:

00	0000	1fff	ffff
----	------	------	------

Description: Move data from W register to register "f".
Words: 1
Cycles: 1
Example: MOVWF OPTION
 Before Instruction
 OPTION = 0xFF
 W = 0x4F
 After Instruction
 OPTION = 0x4F
 W = 0x4F

MOVF **Move f**

Syntax: [*label*] MOVF *f,d*
Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
Operation: $(f) \rightarrow (\text{dest})$
Status Affected: Z
Encoding:

00	1000	dfff	ffff
----	------	------	------

Description: The contents of register f is moved to destination d. If d=0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.
Words: 1
Cycles: 1
Example: MOVF FSR, 0
 After Instruction
 W = value in FSR register

NOP **No Operation**

Syntax: [*label*] NOP
Operands: None
Operation: No operation
Status Affected: None
Encoding:

00	0000	0xx0	0000
----	------	------	------

Description: No operation
Words: 1
Cycles: 1
Example: NOP

OPTION	Load Option Register				
Syntax:	[label] OPTION				
Operands:	None				
Operation:	W → OPTION				
Status Affected:	None				
Encoding:	<table border="1"> <tr> <td>00</td> <td>0000</td> <td>0110</td> <td>0010</td> </tr> </table>	00	0000	0110	0010
00	0000	0110	0010		
Description:	The contents of the W register is loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.				
Words:	1				
Cycles:	1				
Example:					
To maintain upward compatibility with future PIC16CXX products, do not use this instruction.					

RETLW Return Literal to W

Syntax:	[label] RETLW k				
Operands:	0 ≤ k ≤ 255				
Operation:	k → W; TOS → PC;				
Status Affected:	None				
Encoding:	<table border="1"> <tr> <td>11</td> <td>01XX</td> <td>kkkk</td> <td>kkkk</td> </tr> </table>	11	01XX	kkkk	kkkk
11	01XX	kkkk	kkkk		
Description:	The W register is loaded with the eight bit literal "k". The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.				
Words:	1				
Cycles:	2				
Example:					

```

CALL TABLE ; W contains table offset
                ; value
                ; W now has table value
.
.
.
TABLE ADDWF PC ; W = offset
      RETLW k1 ; Begin table
      RETLW k2 ;
      .
      .
      RETLW kn ; End of table

Before Instruction
W = 0x07

After Instruction
W = value of k7
    
```



RETFIE Return from Interrupt

Syntax:	[label] RETFIE				
Operands:	None				
Operation:	TOS → PC, 1 → GIE;				
Status Affected:	None				
Encoding:	<table border="1"> <tr> <td>00</td> <td>0000</td> <td>0000</td> <td>1001</td> </tr> </table>	00	0000	0000	1001
00	0000	0000	1001		
Description:	Return from Interrupt. Stack is popped and Top of the Stack (TOS) is loaded in PC. Interrupts are enabled by setting the GIE bit. GIE is the global interrupt enable bit (INTCON<7>). This is a two-cycle instruction.				
Words:	1				
Cycles:	2				
Example:	RETFIE After Interrupt PC = TOS GIE = 1				

RETURN Return from Subroutine

Syntax:	[label] RETURN				
Operands:	None				
Operation:	TOS → PC;				
Status Affected:	None				
Encoding:	<table border="1"> <tr> <td>00</td> <td>0000</td> <td>0000</td> <td>1000</td> </tr> </table>	00	0000	0000	1000
00	0000	0000	1000		
Description:	Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.				
Words:	1				
Cycles:	2				
Example:	RETURN After Interrupt PC = TOS				

RLF Rotate Left f through Carry

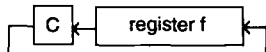
Syntax: [label] RLF f,d
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $f\langle n \rangle \rightarrow d\langle n+1 \rangle$, $f\langle 7 \rangle \rightarrow C$, $C \rightarrow d\langle 0 \rangle$;

Status Affected: C

Encoding:

00	1101	dfff	ffff
----	------	------	------

Description: The contents of register "f" are rotated 1-bit to the left through the Carry Flag. If "d" is 0 the result is placed in the W register. If "d" is 1 the result is stored back in register "f".



Words: 1
 Cycles: 1
 Example: RLF REG1,0

Before Instruction
 REG1 = 11100110
 C = 0

After Instruction
 REG1 = 11100110
 W = 11001100
 C = 1

RRF Rotate Right f through Carry

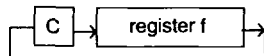
Syntax: [label] RRF f,d
 Operands: $0 \leq f \leq 127$
 $d \in [0,1]$
 Operation: $f\langle n \rangle \rightarrow d\langle n-1 \rangle$,
 $f\langle 0 \rangle \rightarrow C$,
 $C \rightarrow d\langle 7 \rangle$;

Status Affected: C

Encoding:

00	1100	dfff	ffff
----	------	------	------

Description: The contents of register "f" are rotated one bit to the right through the Carry Flag. If "d" is 0 the result is placed in the W register. If "d" is 1 the result is placed back in register "f".



Words: 1
 Cycles: 1
 Example: RRF REG1,0

Before Instruction
 REG1 = 11100110
 C = 0

After Instruction
 REG1 = 11100110
 W = 01110011
 C = 1

SLEEP

Syntax: [label] SLEEP
 Operands: None
 Operation: 00h \rightarrow WDT,
 0 \rightarrow WDT prescaler
 1 \rightarrow TO,
 0 \rightarrow PD

Status Affected: TO, PD

Encoding:

00	0000	0110	0011
----	------	------	------

Description: The Power Down status bit (PD) is cleared. Time-out status bit (TO) is set. Watchdog Timer and its prescaler are cleared.

The processor is put into SLEEP mode with the oscillator stopped. See section on SLEEP mode for more details.

Words: 1
 Cycles: 1
 Example: SLEEP

SUBLW Subtract W from Literal

Syntax: [label] SUBLW k
 Operands: $0 \leq k \leq 255$
 Operation: $k - (W) \rightarrow (W)$
 Status Affected: C, DC, Z

Encoding:

11	110X	kkkk	kkkk
----	------	------	------

Description: The W register is subtracted (2's complement method) from the 8-bit literal "k". The result is placed in the W register.

Words: 1
 Cycles: 1
 Example 1: SUBLW 0x02

Before Instruction
 W = 1
 C = ?
 After Instruction
 W = 1
 C = 1 ; result is positive

Example 2: Before Instruction
 W = 3
 C = ?
 After Instruction
 W = FF
 C = 0 ; result is negative

SUBWF Subtract W from f

Syntax: [label] SUBWF f,d
 Operands: $0 \leq f \leq 127$
 $d \in \{0,1\}$
 Operation: $(f)-W \rightarrow (\text{dest})$
 Status Affected: C, DC, Z
 Encoding:

00	0010	dfff	ffff
----	------	------	------

 Description: Subtract (2's complement method) the W register from register "f". If "d" is 0 the result is stored in the W register. If "d" is 1 the result is stored back in register "f".
 Words: 1
 Cycles: 1
 Example 1: SUBWF REG1,1
 Before Instruction
 REG1 = 0
 W = 1
 C = ?
 After Instruction
 REG1 = FF
 W = 1
 C = 0 ; result is negative
 Example 2: Before Instruction
 REG1 = FF
 W = 0
 C = ?
 After Instruction
 REG1 = FF
 W = 0
 C = 1 ; result is positive

SWAPF Swap f

Syntax: [label] SWAPF f,d
 Operands: $0 \leq f \leq 127$
 $d \in \{0,1\}$
 Operation: $f\langle 0:3 \rangle \rightarrow d\langle 4:7 \rangle$,
 $f\langle 4:7 \rangle \rightarrow d\langle 0:3 \rangle$;
 Status Affected: None
 Encoding:

00	1110	dfff	ffff
----	------	------	------

 Description: The upper and lower nibbles of register "f" are exchanged. If "d" is 0 the result is placed in W register. If "d" is 1 the result is placed in register "f".
 Words: 1
 Cycles: 1
 Example: SWAPF REG, 0
 Before Instruction
 REG = 0xA5
 After Instruction
 REG = 0xA5
 W = 0x5A

TRIS Load TRIS Register

Syntax: [label] TRIS f
 Operands: $5 \leq f \leq 7$
 Operation: $W \rightarrow \text{TRIS register } f$
 Status Affected: None
 Encoding:

00	0006	0110	0fff
----	------	------	------

 Description: This instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.
 Words: 1
 Cycles: 1
 Example:

To maintain upward compatibility with future PIC16CXX products, do not use this instruction.



XORLW Exclusive OR literal with W

Syntax: [label] XORLW k
 Operands: $0 \leq k \leq 255$
 Operation: $(W) .XOR. k \rightarrow (W)$
 Status Affected: Z
 Encoding:

11	1010	kkkk	kkkk
----	------	------	------

 Description: The contents of the W register are XOR'ed with the 8-bit literal "k". The result is placed in the W register.
 Words: 1
 Cycles: 1
 Example: XORLW 0xAF
 Before Instruction
 W = 0xB5
 After Instruction
 W = 0x1A

PIC16C64

XORWF **Exclusive OR W with f**

Syntax: [*label*] XORWF f,d

Operands: 0 ≤ f ≤ 128
 d ∈ [0,1]

Operation: (W) .XOR. (f) → (dest)

Status Affected Z

Encoding:

00	0110	dfff	ffff
----	------	------	------

Description: Exclusive OR the contents of the W register with register "f". If "d" is 0 the result is stored in the W register. If "d" is 1 the result is stored back in register "f".

Words: 1

Cycles: 1

Example: XORWF REG, 1

Before Instruction

REG = 0xAF

W = 0xB5

After Instruction

REG = 0x1A

W = 0xB5

14.0 DEVELOPMENT SUPPORT

14.1 Development Tools

The PIC16C5X and PIC16CXX microcontrollers are supported with a full range of hardware and software development tools:

- PICMASTER™ Real-Time In-Circuit Emulator
- PRO MATE™ Universal Programmer
- PICSTART™ Low-Cost Prototype Programmer
- Assembler
- Software Simulator

14.2 PICMASTER™: High Performance Universal In-Circuit Emulator

The PICMASTER Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for all microcontrollers in the PIC16C5X, PIC16CXX and PIC17CXX families.

Interchangeable target probes allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the PICMASTER allows expansion to support all new PIC16C5X, PIC16CXX and PIC17CXX microcontrollers.

The Emulator System is designed to operate on PC compatible machines ranging from 80286-AT® class ISA-bus systems through the new 80486 EISA-bus machines. The development software runs in the Microsoft Windows® 3.1 environment, allowing the operator access to a wide range of supporting software and accessories.

The PICMASTER has been designed as a real-time emulation system with advanced features generally found on more expensive development tools. The AT platform and Windows 3.1 environment was chosen to best make these features available to you, the end user.

The PICMASTER Emulator Universal System consists primarily of four major components:

- Host-Interface Card
- Emulator Control Pod
- Target-Specific Emulator Probe
- PC Host Emulation Control Software

The Windows 3.1 System is a multitasking operating system which will allow the developer to take full advantage of the many powerful features and functions of the PICMASTER system.

PICMASTER emulation can operate in one window, while a text editor is running in a second window.

Dynamic Data Exchange (DDE), a feature of Windows 3.1, will be available in this and future versions of the software. DDE allows data to be dynamically transferred between two or more Windows programs. With this feature, data collected with PICMASTER can be automatically transferred to a spreadsheet or database program for further analysis.

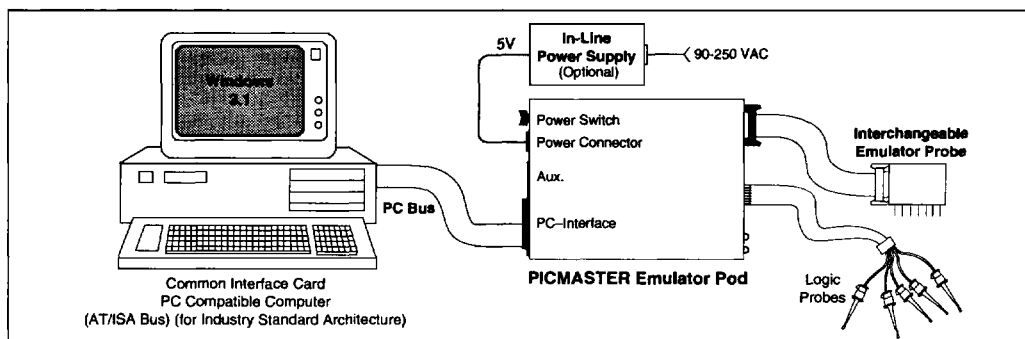
Under Windows 3.1, two or more PICMASTER emulators can run simultaneously on the same PC making development of multi-microcontroller systems possible (e.g., a system containing a PIC16Cxx processor and a PIC17Cxx processor).

14.3 PRO MATE™: Universal Programmer

The PRO MATE Universal Programmer is a production quality programmer capable of operating in stand alone mode as well as PC-hosted mode.

The PRO MATE has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for displaying error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In stand-alone mode the PRO MATE can read, verify or program PIC16C5X, PIC16CXX and PIC17CXX devices. It can also set fuse configuration and code-protect in this mode. Its EEPROM memory holds data and parametric information even when powered down. It is ideal for low to moderate volume production.

FIGURE 14-1: PICMASTER SYSTEM CONFIGURATION



In PC-hosted mode, the PRO MATE connects to the PC via one of the COM (RS232) ports. A PC based user-interface software makes using the programmer simple and efficient. The user interface is full-screen and menu-based. Full screen display and editing of data, easy selection of fuse configuration and part type, easy selection of VDD min, VDD max and VPP levels, load and store to and from disk files (intel hex format) are some of the features of the software. Essential commands such as read, verify, program, blank check can be issued from the screen. Additionally, serial programming support is possible where each part is programmed with a different serial number, sequential or random.

The PRO MATE has a modular "programming socket module". Different socket modules are required for different processor types and/or package types. PRO MATE supports all PIC16C5X, PIC16CXX and PIC17CXX processors.

14.4 PICSTART™ Programmer

The PICSTART™ programmer is an easy to use, very low-cost prototype programmer. It connects to the PC via one of the COM (RS232) ports. A PC based user interface software makes using the programmer simple and efficient. The user interface is full-screen and menu-based.

14.5 Assembler (MPASM)

Cross Assembler is a PC hosted symbolic assembler. It supports all microcontroller series including the PIC16C5X CMOS, PIC16CXX, and PIC17CXX families.

MPASM offers fully featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

MPASM allows full symbolic debugging from the Microchip Universal Emulator System (PICMASTER).

MPASM has the following features to assist in developing software for specific use applications.

- Provides translation of Assembler source code to object code for all Microchip microcontrollers.
- Macro Assembly Capability
- Provides Object, Listing, Symbol and special files required for debugging with one of the Microchip Emulator systems.
- Supports Hex (default), Decimal and Octal source and listing formats.

MPASM provides a full feature directive language represented by four basic classes of directives:

- **Data Directives** are those that control the allocation of memory and provide a way to refer to data items symbolically, by meaningful names.
- **Listing Directives** control the MPASM listing display. They allow the specification of titles and subtitles, page ejects and other listing control.

- **Control Directives** permit sections of conditionally assembled code.
- **Macro Directives** control the execution and data allocation within macro body definitions.

14.6 Software Simulator (MPSIM)

The Software Simulator allows code development in a PC host environment. It allows the user to simulate the PIC16C5X and PIC16CXX series microcontrollers on an instruction level. On any given instruction, the user may examine or modify any of the data areas or provide external stimulus to any of the pins. The input/output radix can be set by the user and the execution can be performed in single step, execute until break or in a trace mode. Two forms of symbolic debugging are available: an internal symbol table for disassembling opcodes and the displaying of source code from a listing file. The Software Simulator offers the low cost flexibility to develop and debug code outside of the laboratory environment making it an excellent multi-project software development tool.

14.7 Development Systems

For convenience, the development tools are packaged into comprehensive systems as listed in Table 14-1:

TABLE 14-1: DEVELOPMENT SYSTEM PACKAGES

Item	Name	System Description
1.	PICMASTER™ System	PICMASTER In-Circuit Emulator with your choice of Target Probe, PRO MATE Programmer, Assembler, Software Simulator and Samples.
2.	PICSTART™ System	PICSTART™ Low-Cost Prototype Programmer, Assembler, Software Simulator and Samples

14.8 Probe Specifications

The PICMASTER probes currently meet the following specifications:

PICMASTER PROBE	Devices Supported	PROBE	
		Maximum Frequency	Operating Voltage
PROBE - 16E	PIC16C64	10 MHZ	4.5V - 5.5V

16.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Ambient temperature under bias	-55 to+ 125°C
Storage Temperature	- 65°C to +150°C
Voltage on any pin with respect to Vss (except VDD and $\overline{\text{MCLR}}$)	-0.6V to VDD +0.6V
Voltage on VDD with respect toVss	0 to +7.5 V
Voltage on $\overline{\text{MCLR}}$ with respect to Vss (Note 2)	0 to +14 V
Total power Dissipation (Note 1)	1.0 W
Maximum Current out of Vss pin	300mA
Maximum Current into VDD pin	250mA
Input clamp current, I _{ik} (V _i <0 or V _i > VDD)	±20mA
Output clamp current, I _{ok} (V _O <0 or V _O >VDD)	±20mA
Maximum Output Current sunk by any I/O pin	25mA
Maximum Output Current sourced by any I/O pin	25mA
Maximum Current sunk by PORTA, PORTB, and PORTE (combined)	200mA
Maximum Current sourced by PORTA, PORTB, and PORTE (combined)	200mA
Maximum Current sunk by PORTC and PORTD (combined)	200mA
Maximum Current sourced by PORTC and PORTD (combined)	200mA



- Notes: 1. Power dissipation is calculated as follows: $P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{oh}\} + \sum \{(V_{DD}-V_{oh}) \times I_{oh}\} + \sum (V_{ol} \times I_{ol})$
2. Voltage spikes below Vss at the $\overline{\text{MCLR}}$ pin, inducing currents greater than 80mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the $\overline{\text{MCLR}}$ pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIC16C64

16.1 DC CHARACTERISTICS: PIC16C64-04 (COMMERCIAL, INDUSTRIAL, AUTOMOTIVE) PIC16C64-20 (COMMERCIAL, INDUSTRIAL, AUTOMOTIVE)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated)				
		Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for automotive, $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial				
		Operating voltage $V_{DD} = 4.0\text{V}$ to 6.0V				
Characteristic	Sym	Min	Typ †	Max	Units	Conditions
Supply Voltage	VDD	4.0		6.0	V	XT, RC and LP osc configuration HS osc configuration
		4.5		5.5	V	
RAM Data Retention Voltage (Note 1)	VDR		1.5		V	Device in SLEEP mode
VDD start voltage to guarantee power on reset	VPOR		VSS		V	See section on power on reset for details
VDD rise rate to guarantee power on reset	SVDD	0.05*			V/ms	See section on power on reset for details
Supply Current (Note 2, 5)	IDD		2.7	5	mA	Fosc = 4 MHz, VDD = 5.5V (Note 4)
			52.5	105	µA	LP osc configuration Fosc = 32 KHz, VDD = 4.0V, WDT disabled
			13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V (PIC16C64-20)
Power Down Current (Note 3, 5)	IPD		10.5	42	µA	VDD = 4.0V, WDT enabled, -40°C to $+85^{\circ}\text{C}$
			1.5	21	µA	VDD = 4.0V, WDT disabled, 0°C to $+70^{\circ}\text{C}$
			1.5	24	µA	VDD = 4.0V, WDT disabled, -40°C to $+85^{\circ}\text{C}$
			1.5	TBD	µA	VDD = 4.0V, WDT disabled, -40°C to $+125^{\circ}\text{C}$

* These parameters are characterized but not tested.

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Notes:
- This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
 - The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
The test conditions for all IDD measurements in active operation mode are:
OSC1=external square wave, from rail to rail; all I/O pins tristated, pulled to VDD, RT = VDD, MCLR = VDD; WDT enabled/disabled as specified.
 - The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.
 - For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{ext}$ (mA) with Rext in kOhm.
 - Timer1 oscillator (when enabled) adds approximately xmA to the specification. This value is from characterization and is for design guidance only. This is not tested.

16.2 DC CHARACTERISTICS: PIC16LC64-04 (COMMERCIAL, INDUSTRIAL, AUTOMOTIVE)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated)				
		Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for automotive, $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial				
		Operating voltage $V_{DD} = 2.5\text{V to }6.0\text{V}$				
Characteristic	Sym	Min	Typ †	Max	Units	Conditions
Supply Voltage	V _{DD}	2.5		6.0	V	XT, RC and LP osc configuration HS osc configuration
		4.5		5.5	V	
RAM Data Retention Voltage (Note 1)	V _{DR}		1.5		V	Device in SLEEP mode
V _{DD} start voltage to guarantee power on reset	V _{POR}		V _{SS}		V	See section on power on reset for details
V _{DD} rise rate to guarantee power on reset	SV _{DD}	0.05*			V/ms	See section on power on reset for details
Supply Current (Note 2, 5)	I _{DD}		2.7	5	mA	F _{osc} = 4 MHz, V _{DD} = 5.5V (Note 4) F _{osc} = 32 KHz, V _{DD} = 3.0V, WDT disabled
			22.5	46	μA	
Power Down Current (Note 3, 5)	I _{PD}		7.5	36	μA	V _{DD} = 3.0V, WDT enabled, -40°C to $+85^{\circ}\text{C}$
			0.9	13.5	μA	V _{DD} = 3.0V, WDT disabled, 0°C to $+70^{\circ}\text{C}$
			0.9	18	μA	V _{DD} = 3.0V, WDT disabled, -40°C to $+85^{\circ}\text{C}$
			0.9	24	μA	V _{DD} = 3.0V, WDT disabled, -40°C to $+125^{\circ}\text{C}$

* These parameters are characterized but not tested.

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Notes:
- This is the limit to which V_{DD} can be lowered in SLEEP mode without losing RAM data.
 - The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
The test conditions for all I_{DD} measurements in active operation mode are:
OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to V_{DD}, RT = V_{DD}, MCLR = V_{DD}; WDT enabled/disabled as specified.
 - The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V_{DD} and V_{SS}.
 - For RC osc configuration, current through R_{ext} is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{ext}$ (mA) with R_{ext} in kOhm.
 - Timer1 oscillator (when enabled) adds approximately xmA to the specification. This value is from characterization and is for design guidance only. This is not tested.

PIC16C64

16.3 DC CHARACTERISTICS: PIC16C64-04 (COMMERCIAL, INDUSTRIAL, AUTOMOTIVE) PIC16C64-20 (COMMERCIAL, INDUSTRIAL, AUTOMOTIVE) PIC16C64-04 (COMMERCIAL, INDUSTRIAL, AUTOMOTIVE)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated)				
		Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for automotive, $-40 \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial				
		Operating voltage V_{DD} range as described in DC spec tables 14.1/14.2				
Characteristic	Sym	Min	Typ †	Max	Units	Conditions
Input Low Voltage I/O ports - with TTL buffer - with Schmitt Trigger buffer MCLR, RA4/T0CKI, OSC1 (in RC mode) OSC1 (in XT, HS and LP)	V_{IL}	V_{SS} V_{SS} V_{SS}		0.8 V 0.2 V_{DD} 0.2 V_{DD}	V V V	Note 1
Input High Voltage I/O ports - with TTL buffer - with Schmitt Trigger buffer MCLR, RA4/T0CKI OSC1 (in RC mode)	V_{IH}	2.0 0.8 V_{DD} 0.8 V_{DD} 0.7 V_{DD}		V_{DD} V_{DD} V_{DD} V_{DD}	V V V V	Note 1
PORTB weak pull-up current	I_{PURB}	50	100	150	μA	$V_{DD} = 5\text{V}$, $V_{PIN} = V_{SS}$
Input Leakage Current (Notes 2, 3) I/O ports MCLR, RA4/T0CKI OSC1	I_{IL}			± 1 ± 5 ± 5	μA μA μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$, Pin at hi-impedance $V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$, XT, HS and LP osc configuration
Output Low Voltage I/O Ports OSC2/CLKOUT (RC osc configuration)	V_{OL}			0.6 0.6 0.6 0.6	V V V V	$I_{OL} = 8.5\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$ $I_{OL} = 7.0\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$ $I_{OL} = 1.6\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$ $I_{OL} = 1.2\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$
Output High Voltage I/O Ports (Note 3) OSC2/CLKOUT (RC osc configuration)	V_{OH}	$V_{DD}-0.7$ $V_{DD}-0.7$ $V_{DD}-0.7$ $V_{DD}-0.7$			V V V V	$I_{OH} = -3.0\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$ $I_{OH} = -2.5\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$ $I_{OH} = -1.3\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$ $I_{OH} = -1.0\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$
Capacitive Loading Specs on Output Pins OSC2 pin All I/O pins and OSC2 (in RC mode) SCL, SDA in I ² C mode	C_{OSC2} C_{IO} C_b			15 50 400	pF pF pF	In XT, HS and LP modes when external clock is used to drive OSC1.

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Notes:
- In RC oscillator configuration, the OSC1 pin is a Schmitt trigger input. It is not recommended that the PIC16C64 be driven with external clock in RC mode.
 - The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - Negative current is defined as coming out of the pin.
 - The user may use better of the two specs.

16.4 Timing Parameter Symbology

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS
2. TppS
3. Tcc:st (I²C specifications only)
4. Ts (I²C specifications only)

T			
F	Frequency	T	Time

Lowercase subscripts (pp) and their meanings:

PP			
cc	CCP1	os	OSC1
ck	CLKOUT	rd	\overline{RD}
cs	\overline{CS}	nw	\overline{RD} or \overline{WR}
di	SDI	sc	SCK
do	SDO	ss	\overline{SS}
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	\overline{MCLR}	wr	\overline{WR}

2

Upper case letters and their meanings:

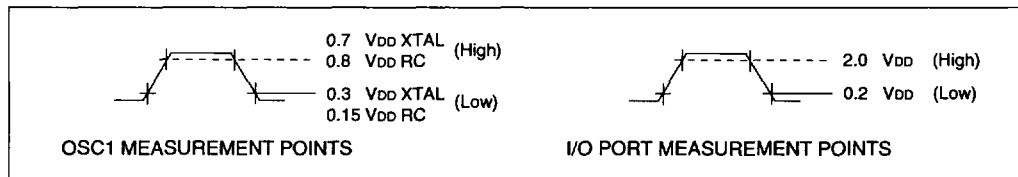
S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (Hi-impedence)	V	Valid
L	Low	Z	High Impedence
I²C only		High	High
AA	output access	Low	Low
BUF	Bus free		

Tcc:st (I²C specifications only)

CC			
HD	Hold	SU	Setup
ST		STO	STOP condition
DAT	DATA input hold		
STA	START condition		

PARAMETER MEASUREMENT INFORMATION

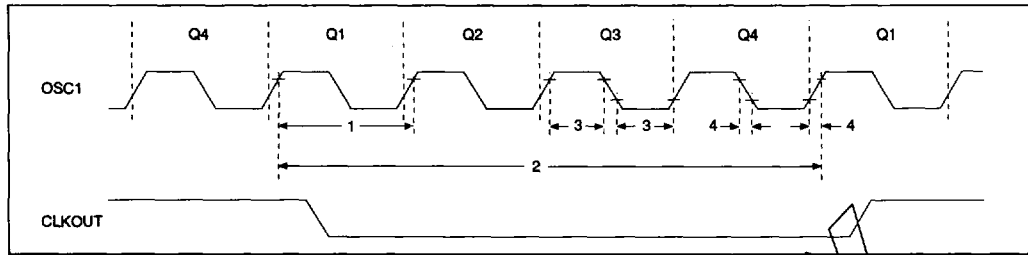
All timings are measured between high and low measurement points as indicated in the figures below.



PIC16C64

16.5 Timing Diagrams and Specifications

External Clock Timing

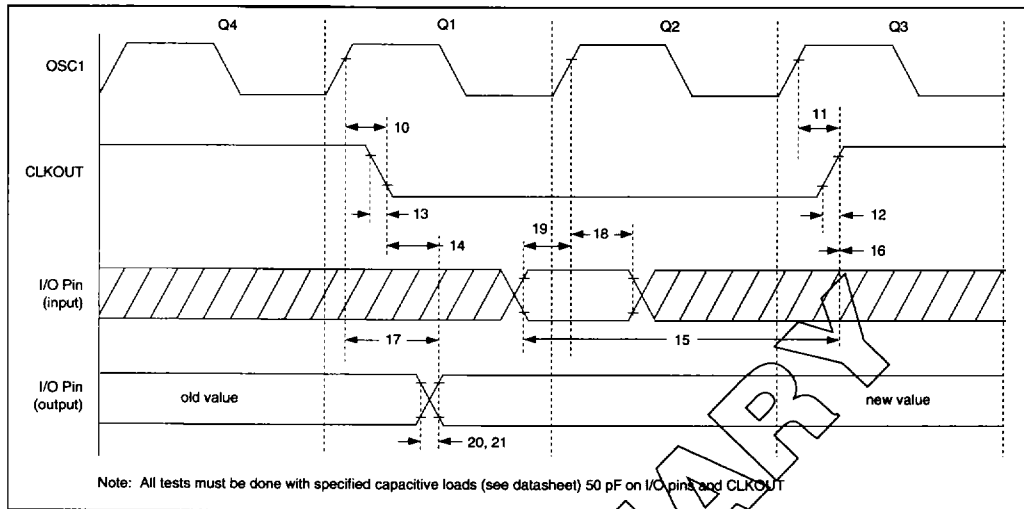


External Clock Timing Requirements

Parameter No.	Sym	Characteristic	Min	Typ †	Max	Units	Conditions
	Fos	External CLKIN Frequency (Note 1)	DC		4	MHz	XT and RC osc mode
			DC		4	MHz	HS osc mode (PIC16C64-04, PIC16LC64-04)
			DC		20	MHz	HS osc mode (PIC16C64-20)
			DC		200	KHz	LP osc mode
	Oscillator Frequency (Note 1)	DC		4	MHz	RC osc mode	
		0.1		4	MHz	XT osc mode	
		1		4	MHz	HS osc mode (PIC16C64-04, PIC16LC64-04)	
		1		20	MHz	HS osc mode (PIC16C64-20)	
1	Tos	External CLKIN Period (Note 1)	250		-	ns	XT and RC osc mode
			250		-	ns	HS osc mode (PIC16C64-04, PIC16LC64-04)
			50		-	ns	HS osc mode (PIC16C64-20)
			50		-	µs	LP osc mode
	Oscillator Period (Note 1)	250		-	ns	RC osc mode	
		250		10,000	ns	XT osc mode	
		250		1,000	ns	HS osc mode (PIC16C64-04, PIC16LC64-04)	
		50		1,000	ns	HS osc mode (PIC16C64-20)	
		5		-	µs	LP osc mode	
2	Tcy	Instruction Cycle Time (Note 1)	1.0	4/F _{os}	DC	µs	
3	TosL, TosH	Clock in (OSC1) High or Low Time	50	-	-	ns	XT oscillator
			2	-	-	µs	LP oscillator
			20	-	-	ns	HS oscillator
4	TosR, TosF	Clock in (OSC1) Rise or Fall Time	25	-	-	ns	XT oscillator
			50	-	-	ns	LP oscillator
			25	-	-	ns	HS oscillator

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
 Note 1: Instruction cycle period (Tcy) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1 pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

CLKOUT and I/O Timing



2

CLKOUT and I/O Timing Requirements

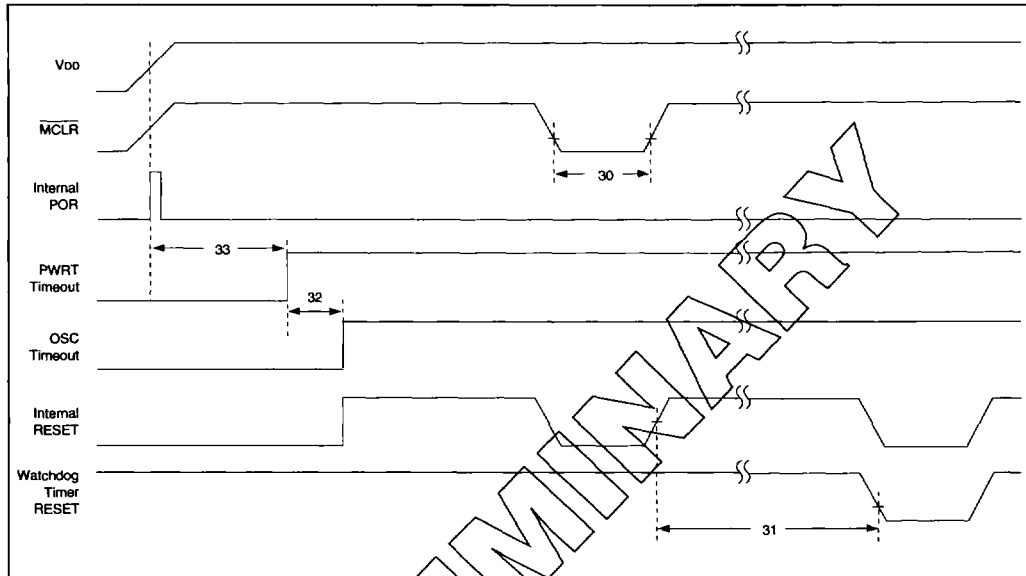
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
10	TosH2ckL	OSC1↑ to CLKOUT↓ (RC mode)	-	15	30	ns	
11	TosH2ckH	OSC1↑ to CLKOUT↑ (RC mode)	-	15	30	ns	
12	TckR	CLKOUT rise time (RC mode)	-	5	15	ns	
13	TckF	CLKOUT fall time (RC mode)	-	5	15	ns	
14	TckL2ioV	CLKOUT↓ to Port out valid	-	-	0.5Tcy+20	ns	
15	TioV2ckH	Port in valid before CLKOUT↑ (RC mode)	0.25 Tcy+25	-	-	ns	
16	TckH2ioL	Port in hold after CLKOUT↑ (RC mode)	0	-	-	ns	
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid	-	-	TBD	ns	
18	TosH2ioL	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	-	-	ns	
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	-	-	ns	
20	TioR	Port output rise time	-	10	25	ns	
21	TioF	Port output fall time	-	10	25	ns	

* These parameters are characterized but not tested.

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C64

Reset, Watchdog Timer, Oscillator Start-Up Timer and Power-Up Timer Timing



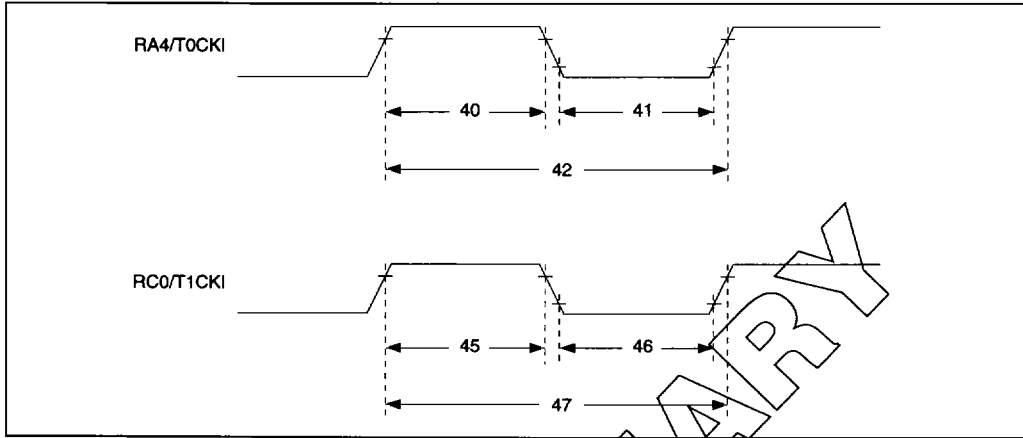
Reset, Watchdog Timer, Oscillator Start-Up Timer and Power-Up Timer Requirements

Parameter No.	Sym	Characteristic	Min	Typ †	Max	Units	Conditions
30	Tmcl	MCLR Pulse Width (low)	100	-	-	ns	
31	Twdt	Watchdog Timer Timeout Period (No Prescaler)	7*	18	33*	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period		1024 tosc		ms	tosc = OSC1 period
33	Tpwrt	Power-up Timer Period	28*	72	132*	ms	VDD = 5V, -40°C to +125°C

* These parameters are characterized but not tested.

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Timer0 and Timer1 Clock Timings



2

Timer0 and Timer1 Clock Requirements

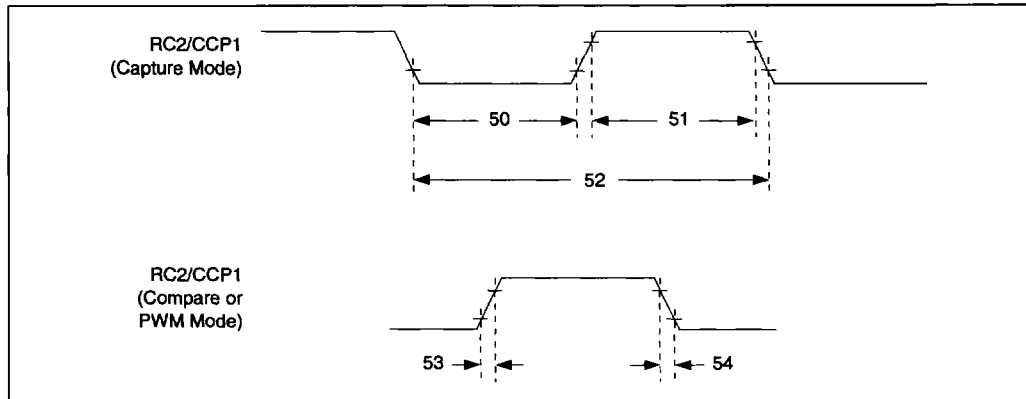
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
40	T _{toH}	TOCKI High Pulse Width	No Prescaler 0.5 TCY + 20*	-	-	ns	
		With Prescaler	10*	-	-	ns	
41	T _{toL}	TOCKI Low Pulse Width	No Prescaler 0.5 TCY + 20*	-	-	ns	
		With Prescaler	10*	-	-	ns	
42	T _{toP}	TOCKI Period	$\frac{T_{cy} + 40^*}{N}$	-	-	ns	Where N = prescale value (2, 4, ..., 256)
45	T _{1tH}	T1CKI High Time	Synchronous, No Prescaler 0.5Tcy + 20	-	-	ns	
		Synchronous, With Prescaler	10*	-	-	ns	
		Asynchronous	2 Tcy	-	-	ns	
46	T _{1tL}	T1CKI Low Time	Synchronous, No Prescaler 0.5Tcy + 20*	-	-	ns	
		Synchronous, With Prescaler	10*	-	-	ns	
		Asynchronous	2 Tcy	-	-	ns	
47	T _{1tP}	T1CKI input period	Synchronous $\frac{T_{cy} + 40^*}{N}$	-	-	ns	N=prescale value (1, 2, 4, 8)
		Asynchronous	4 Tcy	-	-	ns	
	F _{t1}	Timer1 oscillator input frequency range (oscillator enabled by setting the T1OSCEN bit)	DC	-	200	KHz	

* These parameters are characterized but not tested.

†: Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C64

Capture/Compare/PWM Timings



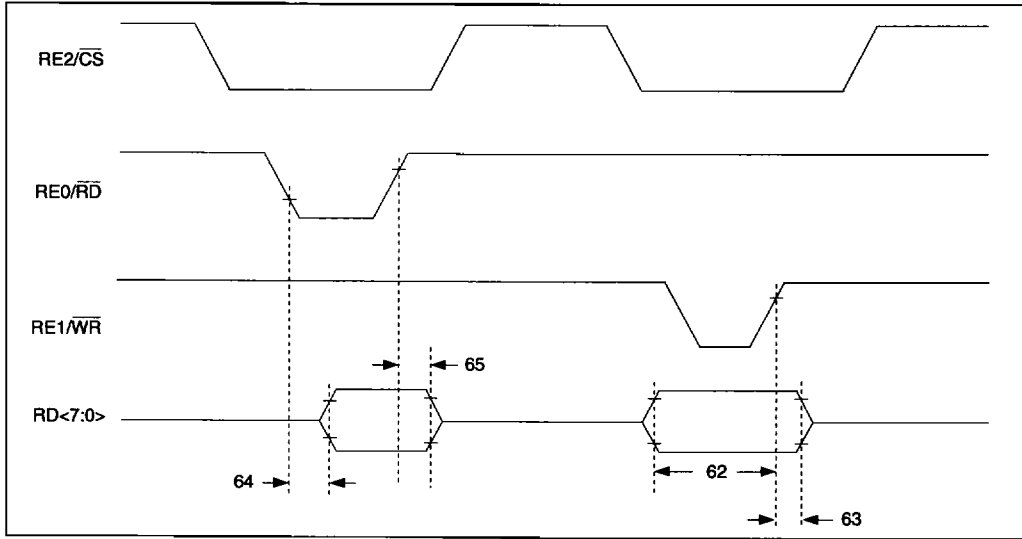
Capture/Compare/PWM Requirements

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions	
50	TccL	CCP1 input low time	No Prescaler	$0.5 T_{cy} + 20$	-	-	ns	
		With Prescaler	10	-	-	ns		
51	TccH	CCP1 input high time	No Prescaler	$0.5 T_{cy} + 20$	-	-	ns	
		With Prescaler	10	-	-	ns		
52	TccP	CCP1 input period	$\frac{T_{cy} + 40}{N}$	-	-	ns	N = prescale value (4 or 16)	
53	TccR	CCP1 output rise time	-	10	25	ns		
54	TccF	CCP1 output fall time	-	10	25	ns		

* These parameters are characterized but not tested.

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Parallel Slave Port Timing



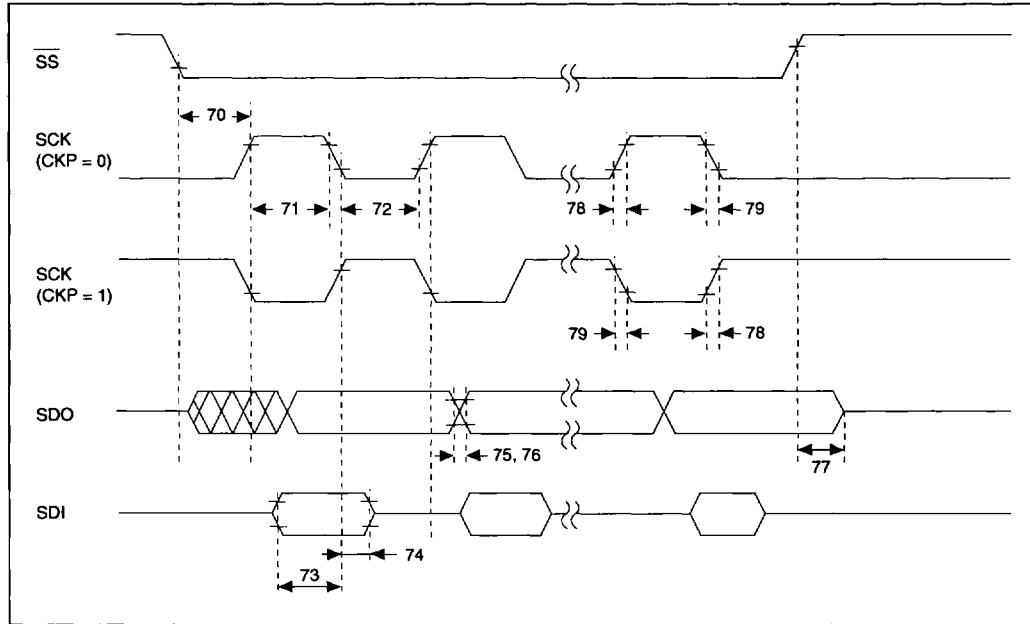
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Parallel Slave Port Requirements

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before WR↑ or CS↑ (setup time)	20	-	-	ns	
63	TwrH2dtI	WR↑ or CS↑ to data-in invalid (hold time)	20	-	-	ns	
64	TrdL2dtV	RD↓ and CS↓ to data-out valid	-	-	40	ns	
65	TrdH2dtI	RD↑ or CS↓ to data-out invalid	10	-	30	ns	

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

SPI Mode Timing

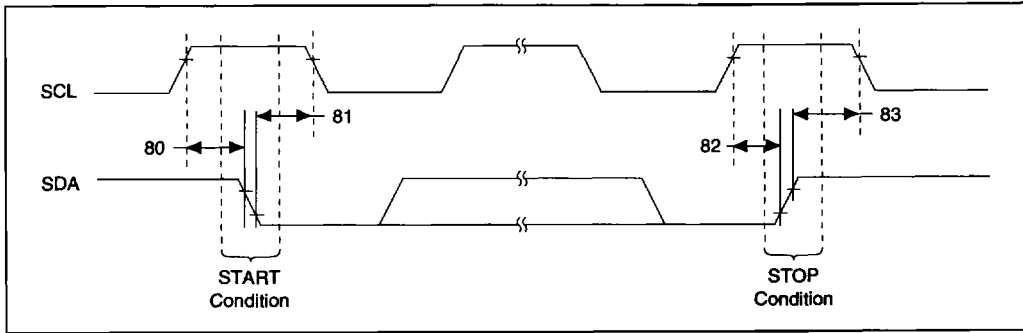


SPI Mode Requirements

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70	Tssl2scH, Tssl2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	-	-	ns	
71	Tsch	SCK input high time (slave mode)	Tcy + 20	-	-	ns	
72	TscL	SCK input low time (slave mode)	Tcy + 20	-	-	ns	
73	TdiV2scH, TdiV2scL	SDI data input valid before SCK edge	Tcy	-	-	ns	
74	Tsch2dil, TscL2dil	SDI data input invalid after SCK edge	0.5Tcy	-	-	ns	
75	TdoR	SDO data output rise time	-	10	25	ns	
76	TdoF	SDO data output fall time	-	10	25	ns	
77	TssH2doZ	SS↓ to SDO output hi-impedance	10	-	50	ns	
78	TscR	SCK output rise time (master mode)	-	10	25	ns	
79	TscF	SCK output fall time (master mode)	-	10	25	ns	

† : Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

I²C Bus Start/Stop Bits Timing



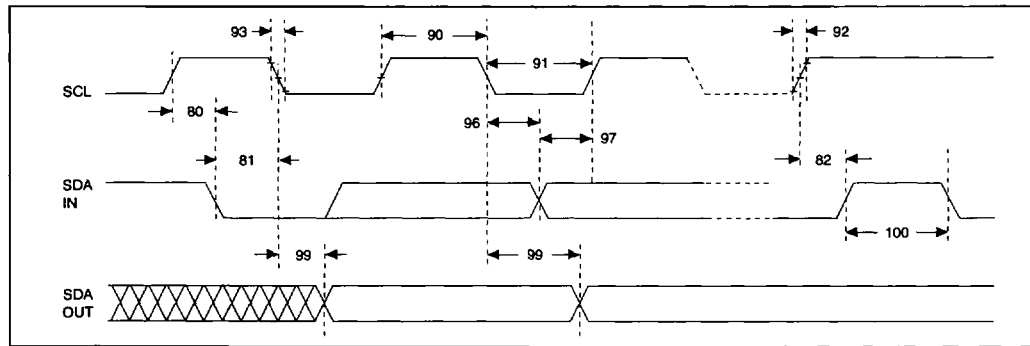
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I²C Bus Start/Stop Bits Requirements

Parameter No.	Sym	Characteristic	Min	Typ	Max	Units	Conditions	
80	TSU:STA	START condition Setup time	100 KHZ mode	4700	-	-	ns	Only relevant for repeated START condition
		400 KHz mode	600	-	-			
81	THD:STA	START condition Hold time	100 KHz mode	4000	-	-	ns	After this period the first clock pulse is generated
		400 KHz mode	600	-	-			
82	TSU:STO	STOP condition Setup time	100 KHZ mode	4700	-	-	ns	
		400 KHz mode	600	-	-			
83	THD:STO	STOP condition Hold time	100 KHz mode	4000	-	-	ns	
		400 KHz mode	600	-	-			

PIC16C64

I²C Bus Data Timing



I²C Bus Data Requirements

Parameter No.	Sym	Characteristic	Min	Max	Units	Conditions	
90	THIGH	Clock high time	100 KHz mode	4.0	-	μs	PIC16C64 must operate at a minimum of 1.5 MHz
			400 KHz mode	0.6	-	μs	PIC16C64 must operate at a minimum of 10 MHz
			SSP Module	1.5 Tcy	-	-	-
91	TLOW	Clock low time	100 KHz mode	4.7	-	μs	PIC16C64 must operate at a minimum of 1.5 MHz
			400 KHz mode	1.3	-	μs	PIC16C64 must operate at a minimum of 10 MHz
			SSP Module	1.5 Tcy	-	-	-
92	TR	SDA and SCL rise time	100 KHz mode	-	1000	ns	
			400 KHz mode	20+0.1 C _b	300	ns	C _b is specified to be from 10-400 pF
93	TF	SDA and SCL fall time	100 KHz mode	-	300	ns	
			400 KHz mode	20+0.1 C _b	300	ns	C _b is specified to be from 10-400 pF
80	TSU:STA	START condition setup time	100 KHz mode	4.7	-	μs	Only relevant for repeated START condition
			400 KHz mode	0.6	-	μs	
81	THD:STA	START condition hold time	100 KHz mode	4.0	-	μs	After this period the first clock pulse is generated
			400 KHz mode	0.6	-	μs	
96	THD:DAT	Data input hold time	100 KHz mode	0	-	ns	
			400 KHz mode	0	0.9	μs	
97	TSU:DAT	Data input setup time	100 KHz mode	250	-	ns	Note 2
			400 KHz mode	100	-	ns	
82	TSU:STO	STOP condition setup time	100 KHz mode	4.7	-	μs	
			400 KHz mode	0.6	-	μs	
99	TAA	Output valid from clock	100 KHz mode	300	3500	ns	Note 1
			400 KHz mode	-	-	-	
100	TBUF	Bus free time	100 KHz mode	4.7	-	μs	Time the bus must be free before a new transmission can start
			400 KHz mode	1.3	-	μs	
	C _b	Bus capacitive loading	-	400	pF		

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

Note 2: A fast-mode I²C-bus device can be used in a standard-mode I²C-bus system, but the requirement tsu:DAT≥250ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t_{r,max}+tsu:DAT=1000+250=1250ns (according to the standard-mode I²C bus specification) before the SCL line is released.

17.0 DC AND AC CHARACTERISTICS (GRAPHS/TABLES)

NOT AVAILABLE AT THIS TIME

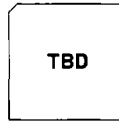
2

20.0 PACKAGING INFORMATION

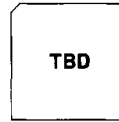
See Section 11 of the Data Book.

20.1 Package Marking Information

44L PLCC



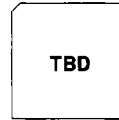
Example



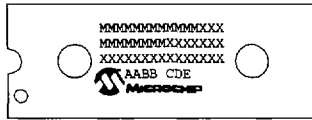
44L PQFP



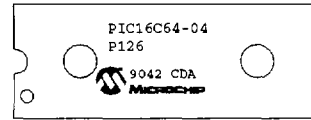
Example



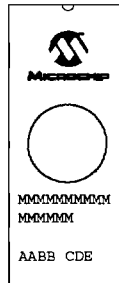
40L PDIP (.600 mil)



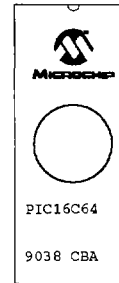
Example



40L Cerdip



Example



Legend:	MM...M	Microchip part number information
	XX...X	Customer specific information*
	AA	Year code (last 2 digits of calendar year)
	BB	Week code (week of January 1 is week '01')
	C	Facility code of the plant at which wafer is manufactured C = Chandler, Arizona, U.S.A.
	D	Mask revision number
	E	Assembly code of the plant or country or origin in which part was assembled
Note: In the event the full Microchip part number can not be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.		

* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev #, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

APPENDIX A

The following are the list of modifications over the PIC16C5X microcontroller family:

1. Instruction word length is increased to 14-bit. This allows larger page sizes both in program memory (2K now as opposed to 512 before) and register file (128 bytes now versus 32-bytes before).
2. A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from status register.
3. Data memory paging is redefined slightly. Status register is modified.
4. Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.
Two instructions TRIS and OPTION are being phased out although they are kept for compatibility with PIC16C5X.
5. OPTION and TRIS registers are made addressible.
6. Interrupt capability is added. Interrupt vector is at 0004h.
7. Stack size is increased to eight deep.
8. Reset vector is changed to 0000h.
9. Reset of all registers is revisited. Five different reset (and wake-up) types are recognized. Registers are reset differently.
10. Wake up from SLEEP through interrupt is added.
11. Two separate timers oscillator start-up timer (OST) and power-up timer (PWRT) are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
12. PORTB has weak pull-ups and interrupt on change feature.
13. RTCC pin is also a port pin (RA4) now.
14. FSR is made a full eight bit register.
15. "In system programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, VSS, MCLR/VPP, RB6 (clock) and RB7 (data in/out).
16. PCON status register is added with a Power-On Reset (POR) status bit.
17. Code protection scheme is enhanced such that portions of the program memory can be protected, while the remainder is unprotected.

APPENDIX B

To convert code written for PIC16C5X to PIC16CXX, the user should take the following steps:

1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
5. Change reset vector to 0000h.

Index

Architectural overview	4	PICMASTER™ Universal In-Circuit Emulator	83
Assembler	84	PICSTART™	84
Asynchronous TMR1 counter mode	36	PIE1 register	10, 14
Bidirectional I/O ports	27	Pinout description	6, 7
Buffer Full (BF) bit	43, 45, 53-55	PIR1 register	10, 15
Bulletin Board Service — connection to	105	PORTA	19, 20
Capture mode	29, 39	PORTB	21, 22
Carry/Borrow (C) bit	11	PORTC	23
CCP1 module	37	PORTD	24
CCP1CON register	39	PORTE	25, 26
CCP1IE bit	15	PORTE as parallel slave port	25, 26, 28
CCP1IF bit	16	Power down mode (SLEEP)	68, 69
CCP1M3-0 bits	37	Power-On Reset (POR)	61
CCP1X:CCP1Y bit	38, 39	Power-Up Timer (PWRT)	61
CKP bit	44	PR2 register	10, 38
CLKOUT	8	Program counter (PC)	17
Clocking scheme	8	Program memory	9
Code protection	70	Program memory map and stack	9
Compare mode	29, 40	Programming information	84
Compatibility	2, 104	PRO MATE™ Universal Programmer	83
Configuration fuses	58	PSPIE bit	10, 14
Development support	83	PSPIF bit	10, 15
Device programming	83, 84	PSPMODE bit	10, 25
Digit Carry/Borrow (DC) bit	11	PWM block diagram (simplified)	41
Direct addressing	17	PWM frequency vs resolution at 20 MHz	41
Electrical characteristics	85	PWM mode	41
Family of devices	3	Quick-Turnaround-Production (QTP)	4
FSR register	17	Reset	61
General Purpose Register File	9	Register file	9
I ² C block diagram mode	49	Register file map	9, 10
I ² C mode	48, 49	RP1-0 bits	11
I ² C timing	97, 98	R/W bit	10, 43, 54, 55
IBF bit	25	Serialized Quick-Turnaround-Production (SQTP)	4
IBOV bit	25	Simulator	84
In-circuit serial programming	70	SLEEP mode	68, 69
INDF register	17	Special features	58
Indirect addressing	18	Special function registers	10
Instruction cycle	8	SPI mode	43, 44
Instruction flow	8	SPI timing	96
Instruction pipeline	8	SSPADD register	52, 53
Instruction set	71-82	SSP module	45
Interrupt control (INTCON) register	13	SPI block diagram mode	45
Interrupt vector	9	SSPBUF register	10, 52, 53
Interrupts	13-15, 66, 67	SSPCON register	10, 44, 52
I/O Ports	19	SSPEN bit	10, 44
I/O programming considerations	27	SSPIE bit	10, 14
IRP bit	11	SSPIF bit	10, 15
Master Clear (MCLR)	61-65	SSPM3-0 bits	10, 44
OBF bit	25	SSPOV bit	10, 44
One-Time-Programmable (OTP)	4	SSPSTAT register	10, 43, 45
OPTION register	12	Stack	9
Oscillator configurations	59	START (S) bit	10, 43
Oscillator start-up timer (OST)	62	STATUS register	11
Package types	1, 3	STOP (P)	10, 43
Packaging information	100	Successive operations on I/O ports	27
Parameter measurement information	89	Synchronous serial port (SSP) module	43
PCL register	17	T1CKPS1-0 bits	10, 34
PCLATH register	17	T1CON register	10, 34
PCON register	16	T1INSYNC bit	10, 34
PD bit	11, 61, 68	T1OSCEN bit	10, 34, 36
		T2CKPS1-0 bits	10, 38
		T2CON register	10, 38

Timer1 mode selection 34
 Timer1 oscillator 36
 Timer1 (TMR1) 34-36
 Timer2 (TMR2) 37
 Timer modules overview 29
 TMR0 overview 29
 Timer 1 (TMR1) overview 29
 Timer 2 (TMR2) overview 29
 CCP1 overview 29
 Timing diagrams/specifications 90-98
 Timing parameter symbology 89
 TMR0 interrupt 30, 31, 66
 TMR0 module 29, 30
 TMR0 prescaler 30-32
 TMR1 interrupt 14, 15, 34
 TMR1 register 10
 TMR1CS bit 10, 34
 TMR1IE bit 10, 14
 TMR1ON bit 10, 34
 TMR2 interrupt 14, 15, 38
 TMR2IE bit 10, 14
 TMR2IF bit 10, 15
 TMR2 register 10, 38
 TMR2IF bit 10, 15
 TMR2ON bit 10, 38
 TO bit 11, 61, 62, 68
 TOUTPS3-0 bits 10, 38
 TRIS registers 10, 19-26
 TRISE register 26
 UA bit 10, 43, 53
 Wake-up (from SLEEP) 68, 69
 Watchdog timer 68
 WCOL bit 10, 44
 Zero (Z) bit 10, 11

Table of Examples

Example 3-1: Instruction Pipeline Flow 8
 Example 5-1: Initializing PORTA 19
 Example 5-2: Initializing PORTC 23
 Example 7-1: Changing Prescaler (TMR0→WDT) 33
 Example 7-2: Changing Prescaler (WDT→TMR0) 33
 Example 10-1: Changing Between Capture Prescalers 40
 Example 11-1: Loading the SSPBUF
 (SSPSR Register) 45
 Example 12-1: Saving W Register and Status in RAM 67

Table of Tables

Table 1-1: PIC16CXX Family of Devices 3
 Table 3-1: PIC16C64 Pinout Description 6, 7
 Table 4-1: Special Registers for the PIC16C64 10
 Table 5-1: PORTA Functions 20
 Table 5-2: Summary of PORTA Registers 20
 Table 5-3: PORTB Functions 22
 Table 5-4: Summary of PORTB Registers 22
 Table 5-5: PORTC Functions 23
 Table 5-6: Summary of PORTC Registers 23
 Table 5-7: PORTD Functions 24
 Table 5-8: Summary of PORTD Registers 24
 Table 5-9: PORTE Functions 26
 Table 5-10: Summary of PORTE Registers 26
 Table 5-11: Summary of Parallel Slave Port Registers 28
 Table 7-1: Summary of TMR0 Registers 33
 Table 7-2: Registers Associated with TMR0 33
 Table 8-1: Capacitor Selection for the Timer1
 Oscillator 36
 Table 8-2: Registers Associated with Timer1 as a
 Timer/Counter 37
 Table 9-1: Registers Associated with Timer2 as a
 Timer/Counter 38
 Table 10-1: PWM Frequency vs Resolution at
 20 MHz 41
 Table 10-2: Example PWM Frequencies and Resolutions
 at 20 MHz 41
 Table 10-3: Registers Associated with Timer1 and
 Capture 42
 Table 10-4: Registers Associated with Timer1 and
 Compare 42
 Table 10-5: Registers Associated with Timer2 and
 PWM 42
 Table 11-1: Registers Associated with SPI Operation 47
 Table 11-2: I²C-BUS Terminology 48
 Table 11-3: Data Transfer Received Byte Actions 53
 Table 11-4: Registers Associated with I²C Operation .. 56
 Table 12-1: Capacitor Selection for Ceramic
 Resonators 59
 Table 12-2: Capacitor Selection for Crystal Oscillator . 59
 Table 12-3: Time Out in Various Situations 62
 Table 12-4: Status Bits and Their Significance 62
 Table 12-5: Reset Condition for Special Registers 62
 Table 12-6: Reset Condition for Registers 63
 Table 13-1: Opcode Field Descriptions 71
 Table 13-2: Instruction Set 72
 Table 14-1: Development System Packages 84



Table of Figures

Figure 3-1:	PIC16C64 Block Diagram	5	Figure 12-2:	Crystal Operation (or Ceramic Resonator) (HS, XT or LP Osc Configuration)	59
Figure 3-2:	Clock Instruction Cycle	8	Figure 12-3:	External Clock Input Operation (HS, XT, or LP Osc Configuration)	59
Figure 4-1:	Program Memory Map and Stack	9	Figure 12-4:	Parallel Resonant Crystal Oscillator Circuit	60
Figure 4-2:	Register File Map	9	Figure 12-5:	Series Resonant Crystal Oscillator Circuit	60
Figure 4-3:	STATUS Register	11	Figure 12-6:	RC Oscillator Mode	60
Figure 4-4:	OPTION Register	12	Figure 12-7:	Simplified Block Diagram of On-Chip Reset Circuit	61
Figure 4-5:	INTCON Register	13	Figure 12-8:	Time-out Sequence on Power-up (MCLR not Tied to V _{DD}): Case 1	64
Figure 4-6:	PIE1 Register	14	Figure 12-9:	Time-out Sequence on Power-up (MCLR not Tied to V _{DD}): Case 2	64
Figure 4-7:	PIR1 Register	15	Figure 12-10:	Time-out Sequence on Power-up (MCLR Tied to V _{DD})	64
Figure 4-8:	PCON Register	16	Figure 12-11:	External Power on Reset Circuit (For Slow V _{DD} Power Up)	65
Figure 4-9:	Loading of PC in Different Situations	17	Figure 12-12:	Brown-Out Protection Circuit 1	65
Figure 4-10:	Direct/Indirect Addressing	18	Figure 12-13:	Brown-Out Protection Circuit 2	65
Figure 5-1:	Block Diagram of Port Pins RA<3:0> and RA<5>	19	Figure 12-14:	Interrupt Logic	66
Figure 5-2:	Block Diagram of RA4 Pin	19	Figure 12-15:	INT Pin Interrupt Timing	67
Figure 5-3:	Block Diagram of Port Pins RB<7:4>	21	Figure 12-16:	Watchdog Timer Block Diagram	68
Figure 5-4:	Block Diagram of Port Pins RB<3:0>	21	Figure 12-17:	Summary of Watchdog Timer Registers ..	68
Figure 5-5:	PORTC Block Diagram	23	Figure 12-18:	Wake-up from SLEEP Through Interrupt ..	69
Figure 5-6:	PORTD Block Diagram (In I/O Port Mode) ..	24	Figure 12-19:	Protected Memory Read Format	70
Figure 5-7:	PORTE Block Diagram (In I/O Port Mode) ..	25	Figure 12-20:	Typical In-System Serial Programming Connection	70
Figure 5-8:	TRISE Register	25	Figure 13-1:	General Format for Instructions	71
Figure 5-9:	Successive I/O Operation	27	Figure 14-1:	PICMASTER System Configuration	83
Figure 5-10:	PORTD and PORTE as a Parallel Slave Port	28			
Figure 7-1:	Timer0 Block Diagram	30			
Figure 7-2:	Timer0 Timing: INT Clock/No Prescale ...	30			
Figure 7-3:	Timer0 Timing: INT Clock/Prescale 1:2 ...	30			
Figure 7-4:	Timer0 Interrupt Timing	31			
Figure 7-5:	Timer0 Timing with External Clock	32			
Figure 7-6:	Block Diagram of the TMR0/WDT Prescaler	32			
Figure 8-1:	T1CON: Timer1 Control Register	34			
Figure 8-2:	TMR1 Block Diagram	35			
Figure 9-1:	Timer2 Block Diagram	38			
Figure 9-2:	T2CON: Timer2 Control Register	38			
Figure 10-1:	CCP1CON Register	39			
Figure 10-2:	Capture Mode Operation	40			
Figure 10-3:	Compare Mode Operation	40			
Figure 10-4:	Simplified PWM Block Diagram	41			
Figure 11-1:	SSPSTAT: Sync Serial Port Status Register	43			
Figure 11-2:	SSPCON: Sync Serial Port Control Register	44			
Figure 11-3:	SSP Block Diagram (SPI Mode)	45			
Figure 11-4:	SPI Master/Slave Connection	46			
Figure 11-5:	SPI Mode Timing (Master Mode or Slave w/o SS Control)	47			
Figure 11-6:	SPI Mode Timing (Slave Mode with SS Control)	47			
Figure 11-7:	Start and Stop Conditions	48			
Figure 11-8:	7-Bit Address Format	49			
Figure 11-9:	I ² C 10-Bit Address Format	49			
Figure 11-10:	Slave-Receiver Acknowledge	49			
Figure 11-11:	A Data Transfer	49			
Figure 11-12:	Master-Transmitter Sequence	50			
Figure 11-13:	Master-Receiver Sequence	50			
Figure 11-14:	Combined Format	50			
Figure 11-15:	Multi-Master Arbitration	51			
Figure 11-16:	Clock Synchronization	51			
Figure 11-17:	SSP Block Diagram (I ² C Mode)	52			
Figure 11-18:	I ² C Waveforms for Reception (7-Bit Address)	54			
Figure 11-19:	I ² C Waveforms for Transmission (7-Bit Address)	55			
Figure 11-20:	Operation of the I ² C Module in Idle_Mode, RCV_Mode or XMIT_Mode	57			
Figure 12-1:	Configuration Word	58			

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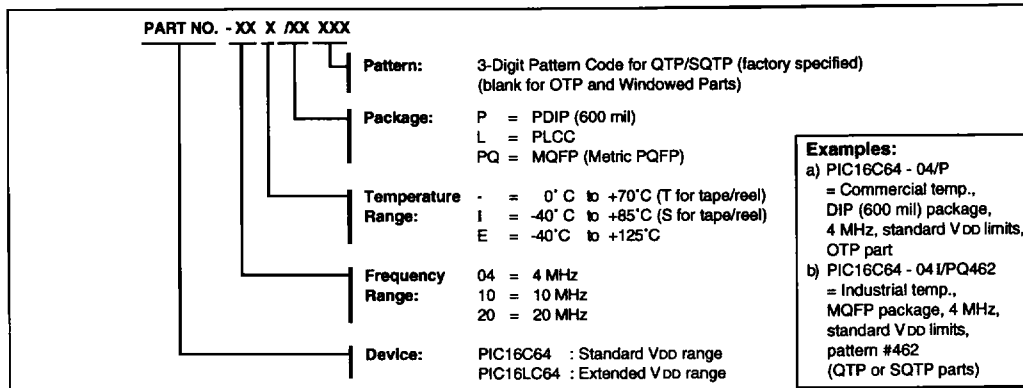
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